US009345449B2

(12) **United States Patent**
Stein et al.

(10) **Patent No.: US 9,345,449 B2**
(45) **Date of Patent: *May 24, 2016**

(54) **PROSTHETIC COMPONENT FOR MONITORING JOINT HEALTH**

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(73) Assignee: **ORTHOSENSOR INC**, Dania Beach, FL (US)

(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 143 days.

This patent is subject to a terminal disclaimer.

(21) Appl. No.: **14/205,255**

(22) Filed: **Mar. 11, 2014**

(65) **Prior Publication Data**

US 2014/0206952 A1 Jul. 24, 2014

Related U.S. Application Data

(63) Continuation of application No. 13/406,519, filed on Feb. 27, 2012, now Pat. No. 8,720,270, which is a continuation-in-part of application No. 12/825,852, filed on Jun. 29, 2010, now Pat. No. 8,146,422, and a

(Continued)

(51) **Int. Cl.**
A61B 5/00 (2006.01)
A61B 8/08 (2006.01)
(Continued)

(52) **U.S. Cl.**
CPC ***A61B 8/0875*** (2013.01); ***A61B 5/0082*** (2013.01); ***A61B 5/01*** (2013.01);
(Continued)

(58) **Field of Classification Search**
CPC A61B 5/22; A61B 5/00
USPC 73/379.01; 600/301
See application file for complete search history.

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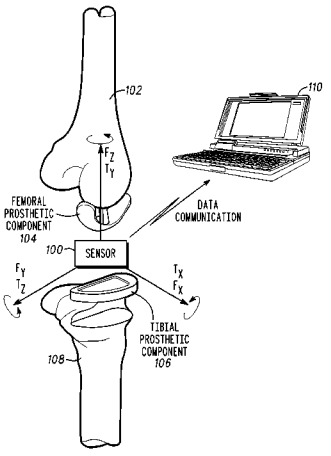
Primary Examiner — Jewel V Thompson

(57) **ABSTRACT**

A prosthetic component suitable for long-term implantation is provided. The prosthetic component includes electronic circuitry and sensors to measure a parameter of the muscular-skeletal system. The prosthetic component comprises a first structure having at least one support surface, a second structure having at least one feature configured to couple to bone, and at least one sensor. The electronic circuitry and sensors are hermetically sealed within the prosthetic component. The prosthetic component includes at least on transmissive region. The transmissive region can be located in a region that has exposure to a region outside the joint. The transmissive region can comprise glass. One or more sensors can be used to monitor synovial fluid in proximity to the joint to determine joint health. The transmissive region can be used to support communication between the electronic circuitry and remote system.

20 Claims, 26 Drawing Sheets



Related U.S. Application Data

continuation-in-part of application No. 12/826,349, filed on Jun. 29, 2010, now Pat. No. 8,245,583, and a continuation-in-part of application No. 13/242,277, filed on Sep. 23, 2011, and a continuation-in-part of application No. 13/242,662, filed on Sep. 23, 2011.

(60) Provisional application No. 61/221,767, filed on Jun. 30, 2009, provisional application No. 61/221,779, filed on Jun. 30, 2009, provisional application No. 61/221,788, filed on Jun. 30, 2009, provisional application No. 61/221,793, filed on Jun. 30, 2009, provisional application No. 61/221,801, filed on Jun. 30, 2009, provisional application No. 61/221,808, filed on Jun. 30, 2009, provisional application No. 61/221,817, filed on Jun. 30, 2009, provisional application No. 61/221,867, filed on Jun. 30, 2009, provisional application No. 61/221,874, filed on Jun. 30, 2009, provisional application No. 61/221,879, filed on Jun. 30, 2009, provisional application No. 61/221,881, filed on Jun. 30, 2009, provisional application No. 61/221,886, filed on Jun. 30, 2009, provisional application No. 61/221,889, filed on Jun. 30, 2009, provisional application No. 61/221,894, filed on Jun. 30, 2009, provisional application No. 61/221,901, filed on Jun. 30, 2009, provisional application No. 61/221,909, filed on Jun. 30, 2009, provisional application No. 61/221,916, filed on Jun. 30, 2009, provisional application No. 61/221,923, filed on Jun. 30, 2009, provisional application No. 61/221,929, filed on Jun. 30, 2009, provisional application No. 61/221,761, filed on Jun. 30, 2009.

(51) **Int. Cl.**

A61B 5/01	(2006.01)
A61B 5/103	(2006.01)
A61B 5/145	(2006.01)
A61B 8/00	(2006.01)

(52) **U.S. Cl.**

CPC ***A61B 5/1032*** (2013.01); ***A61B 5/14539*** (2013.01); ***A61B 5/4528*** (2013.01); ***A61B 5/4851*** (2013.01); ***A61B 5/6846*** (2013.01); *A61B 5/4509* (2013.01); *A61B 8/58* (2013.01)

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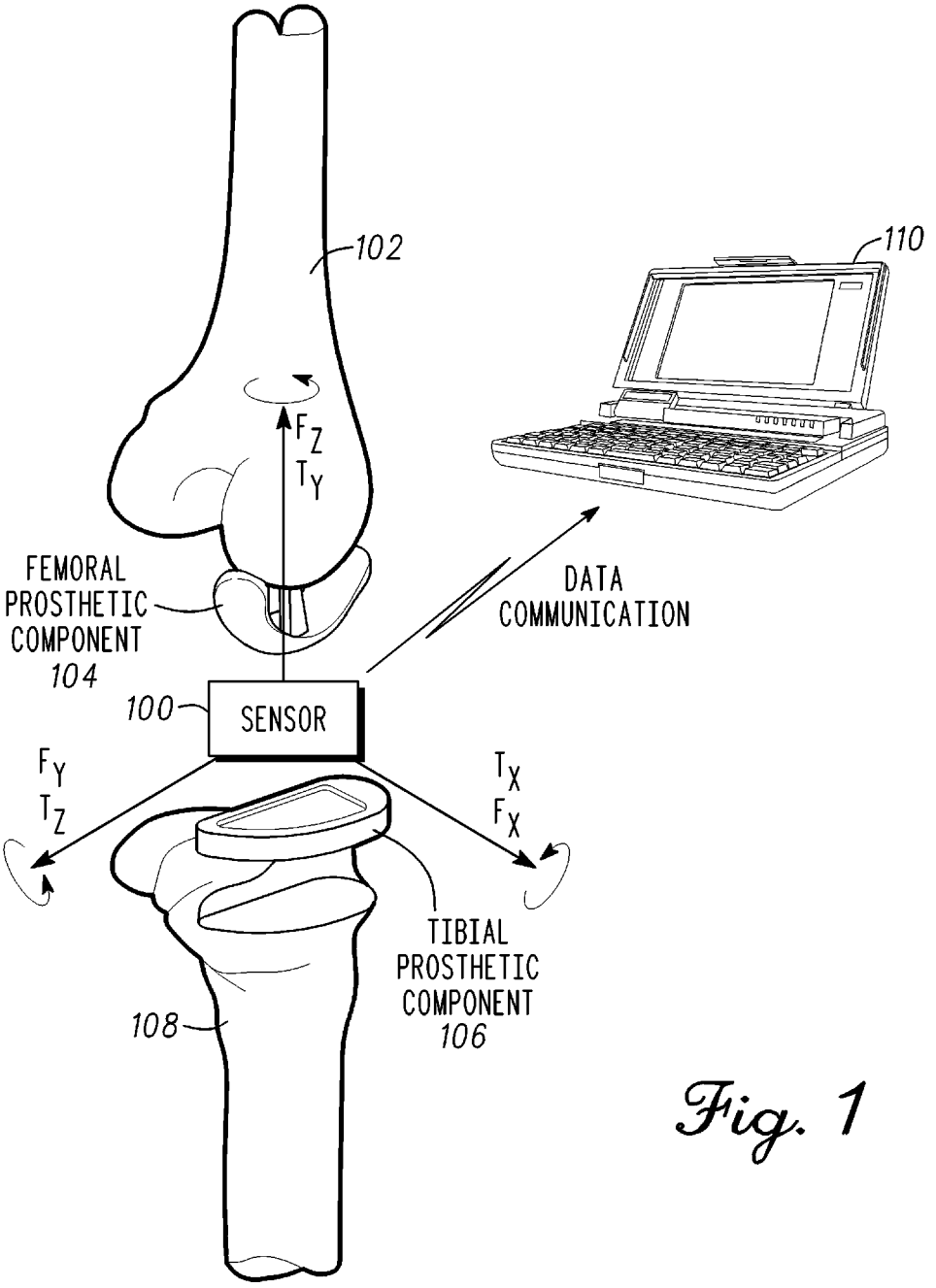
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Fig. 1

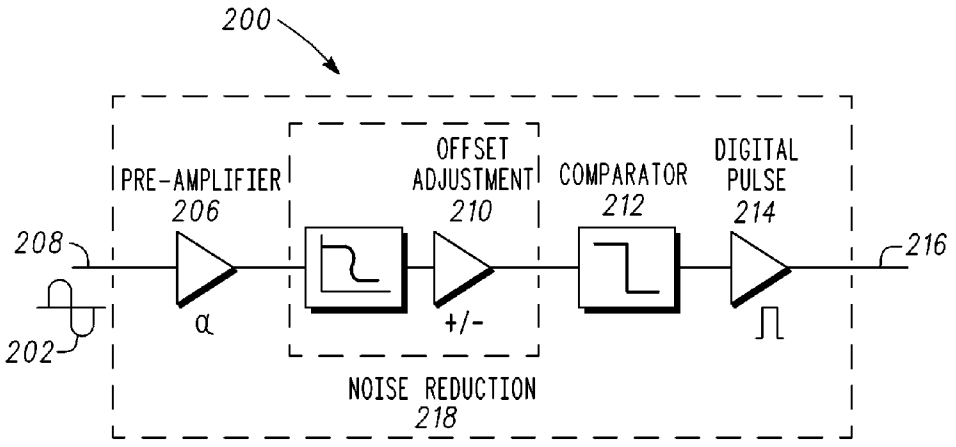
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Fig. 2

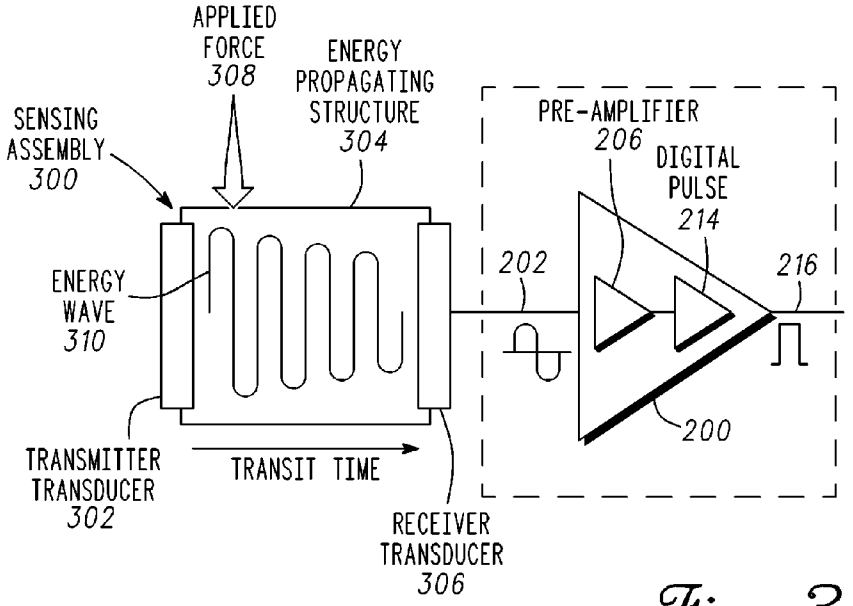
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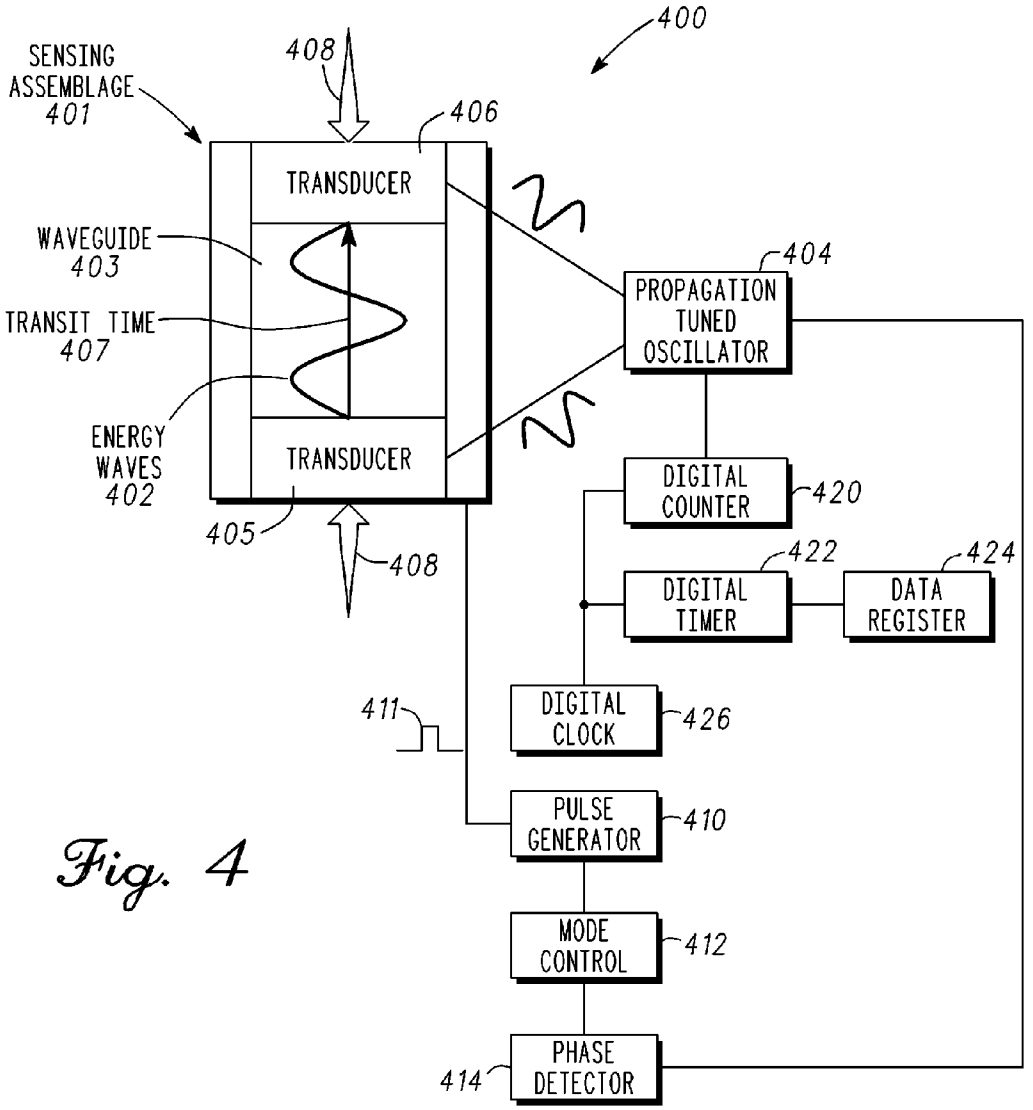
Fig. 3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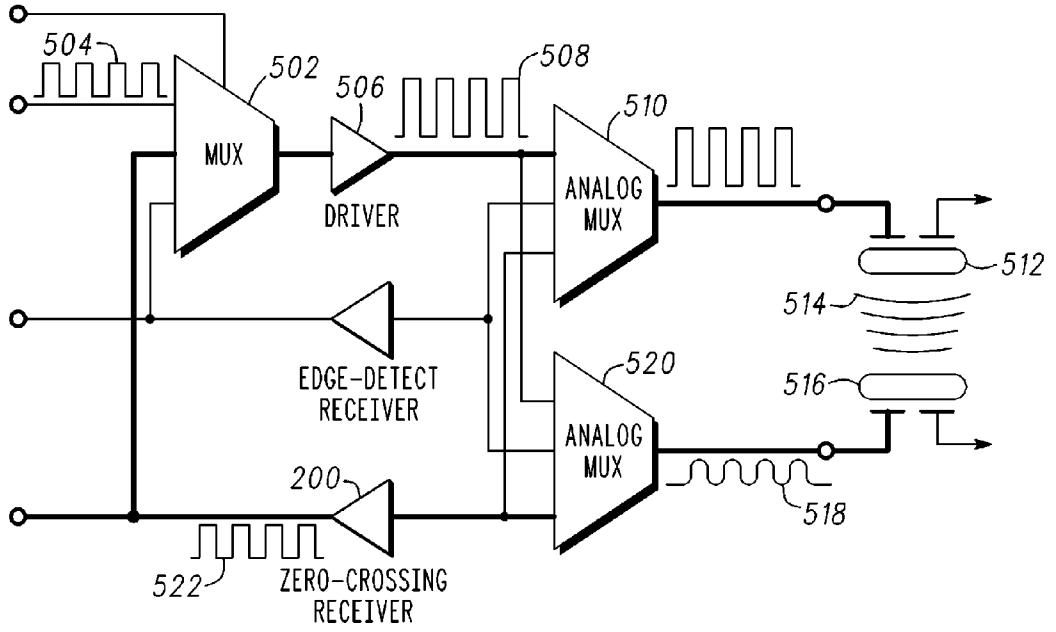
DIGITAL COUNTER
420
422
DIGITAL TIMER
424
DATA REGISTER
411
DIGITAL CLOCK
426
PULSE GENERATOR
410
MODE CONTROL
412
PHASE DETECTOR
414

Fig. 4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510
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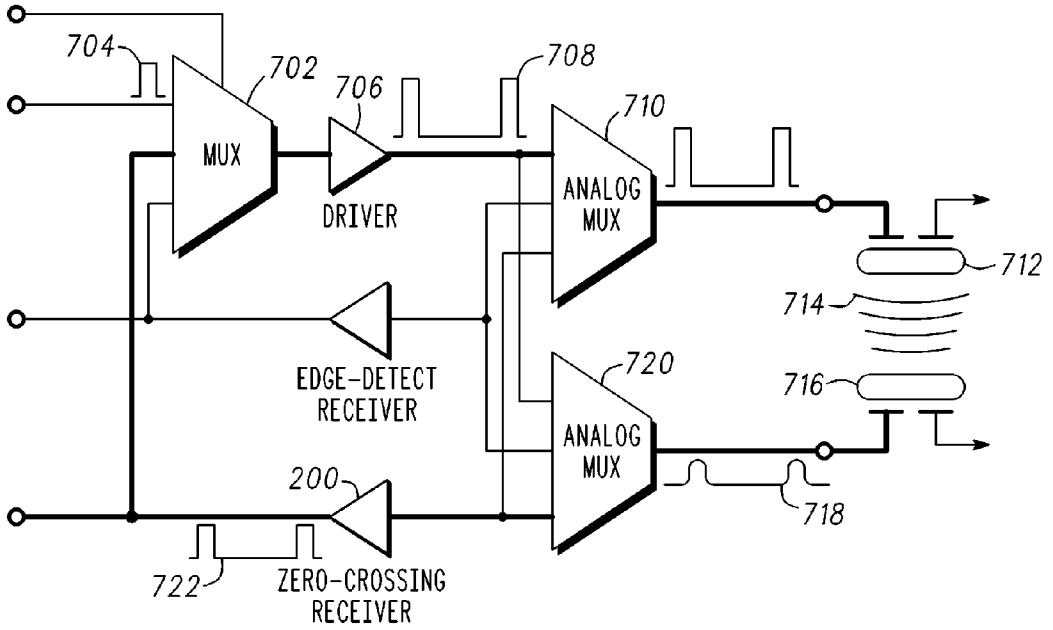
522
ZERO-CROSSING RECEIVER

Fig. 5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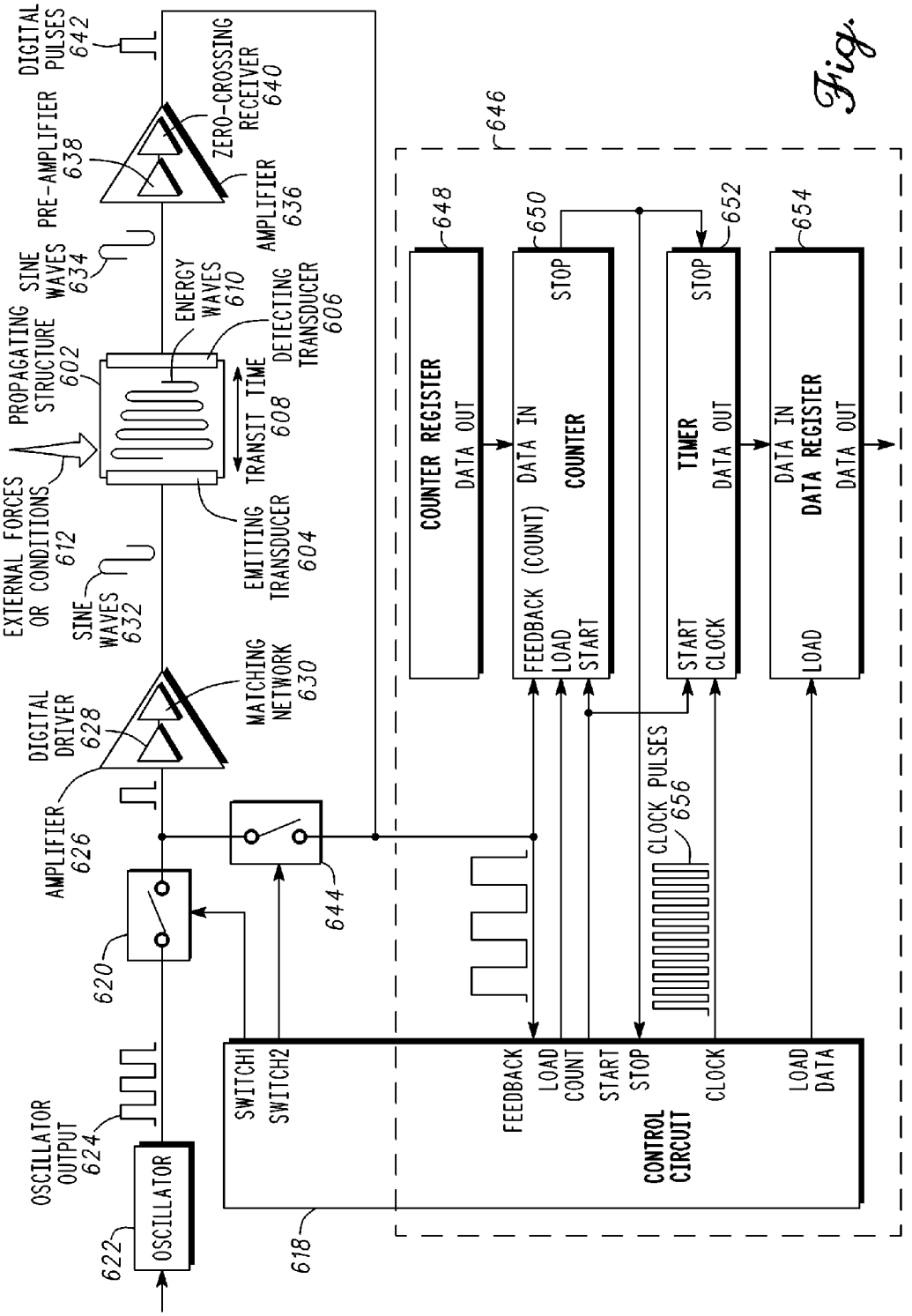
ZERO-CROSSING RECEIVER

Fig. 7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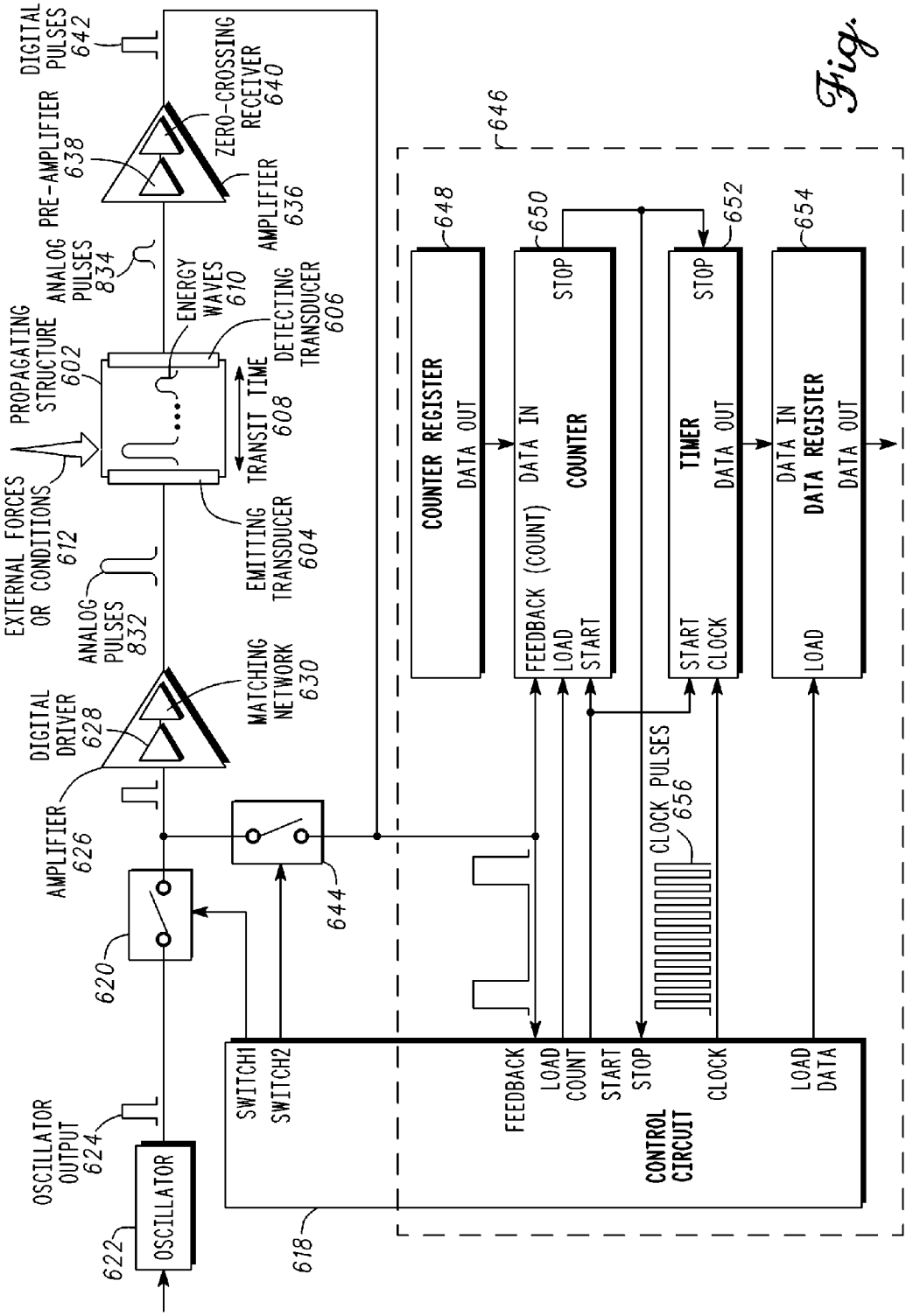
SINE WAVES 632
EXTERNAL FORCES OR CONDITIONS 612
EMITTING TRANSDUCER 604
PROPAGATING STRUCTURE 602
TRANSIT TIME 608
ENERGY WAVES 610
DETECTING TRANSDUCER 606
SINE WAVES 634
PRE-AMPLIFIER 638
AMPLIFIER 636
ZERO-CROSSING RECEIVER 640
DIGITAL PULSES 642
646
COUNTER REGISTER
DATA OUT
648
FEEDBACK (COUNT)
DATA IN
LOAD
START
COUNTER
STOP
650
START
CLOCK
TIMER
STOP
652
LOAD
DATA IN
DATA REGISTER
DATA OUT
654
CLOCK PULSES 656
FEEDBACK
LOAD COUNT
START
STOP
CLOCK
LOAD DATA
CONTROL CIRCUIT

Fig. 6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TRANSIT TIME 608
EXTERNAL FORCES OR CONDITIONS 612
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STOP
DATA OUT
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DATA OUT
CLOCK PULSES 656
CONTROL CIRCUIT
FEEDBACK
LOAD COUNT
START
STOP
CLOCK
LOAD DATA

Fig. 8

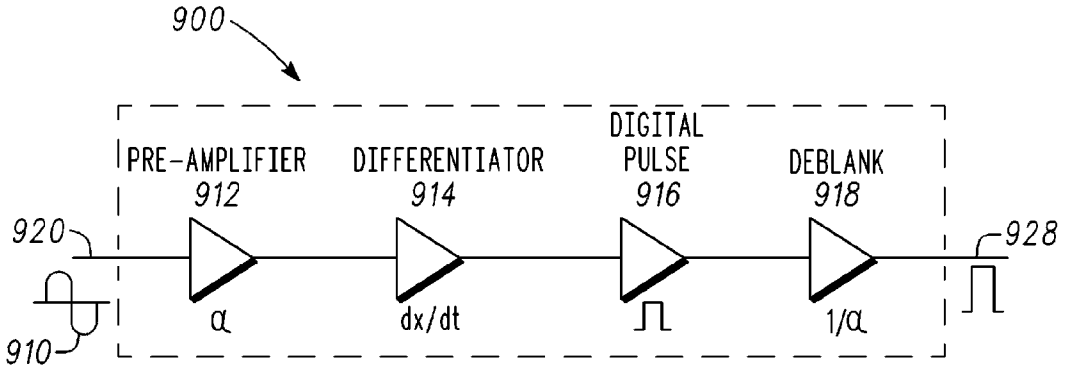

900
PRE-AMPLIFIER
912
DIFFERENTIATOR
914
DIGITAL
PULSE
916
DEBLANK
918
920
928
910
α
dx/dt
1/α

Fig. 9

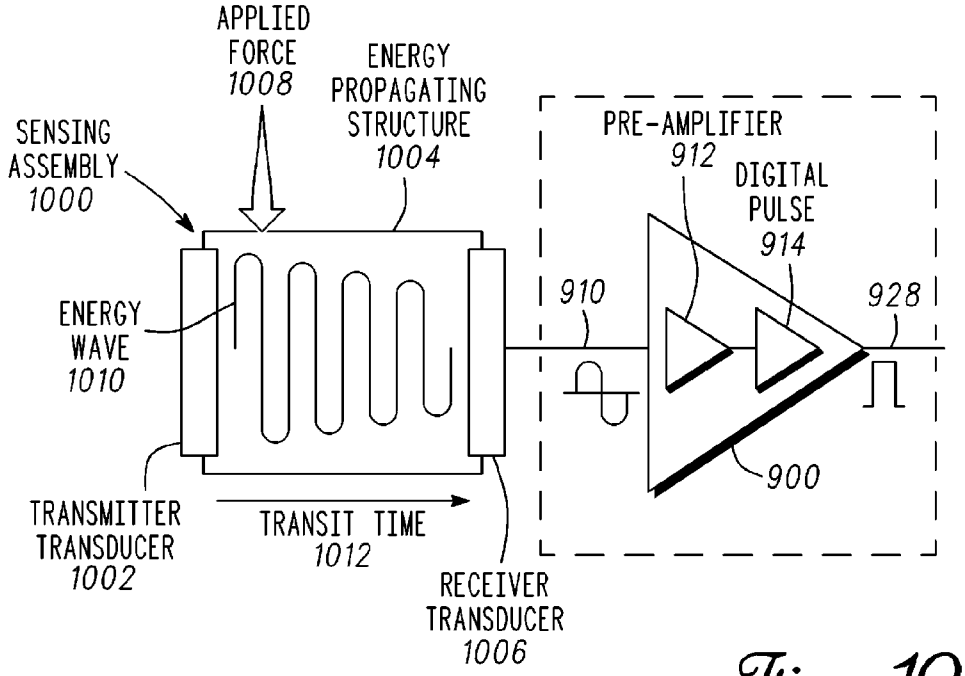
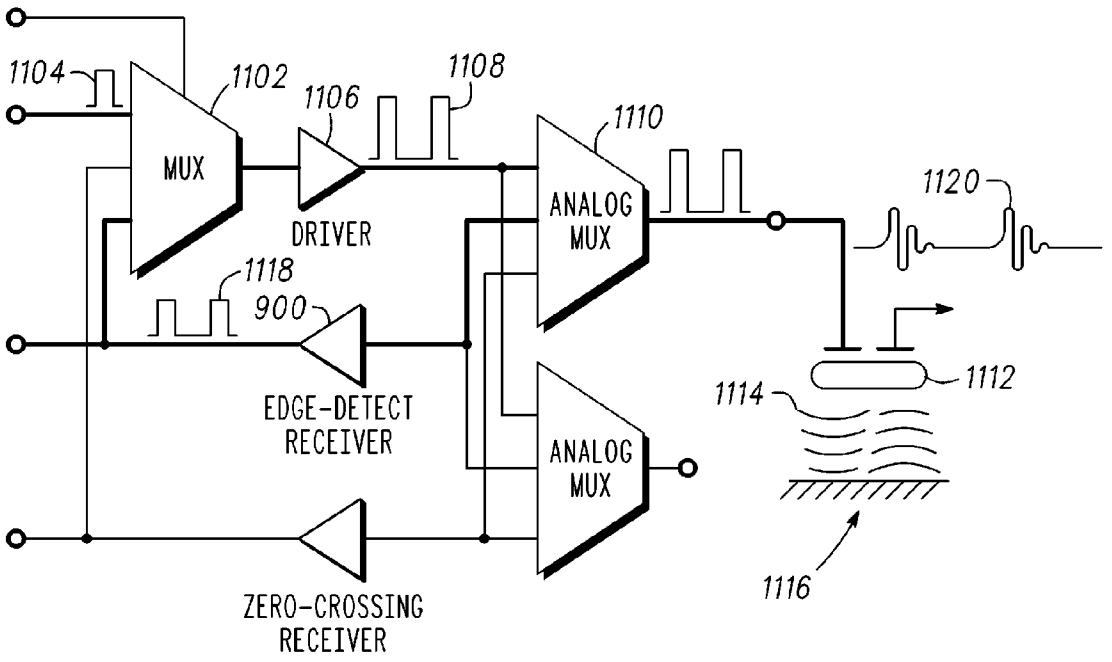

APPLIED
FORCE
1008
ENERGY
PROPAGATING
STRUCTURE
1004
SENSING
ASSEMBLY
1000
PRE-AMPLIFIER
912
DIGITAL
PULSE
914
910
928
ENERGY
WAVE
1010
900
TRANSMITTER
TRANSDUCER
1002
TRANSIT TIME
1012
RECEIVER
TRANSDUCER
1006

Fig. 10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1106
1108
1110
1120
MUX
DRIVER
ANALOG MUX
1118
900
EDGE-DETECT RECEIVER
1114
1112
ANALOG MUX
ZERO-CROSSING RECEIVER
1116

1100

Fig. 11

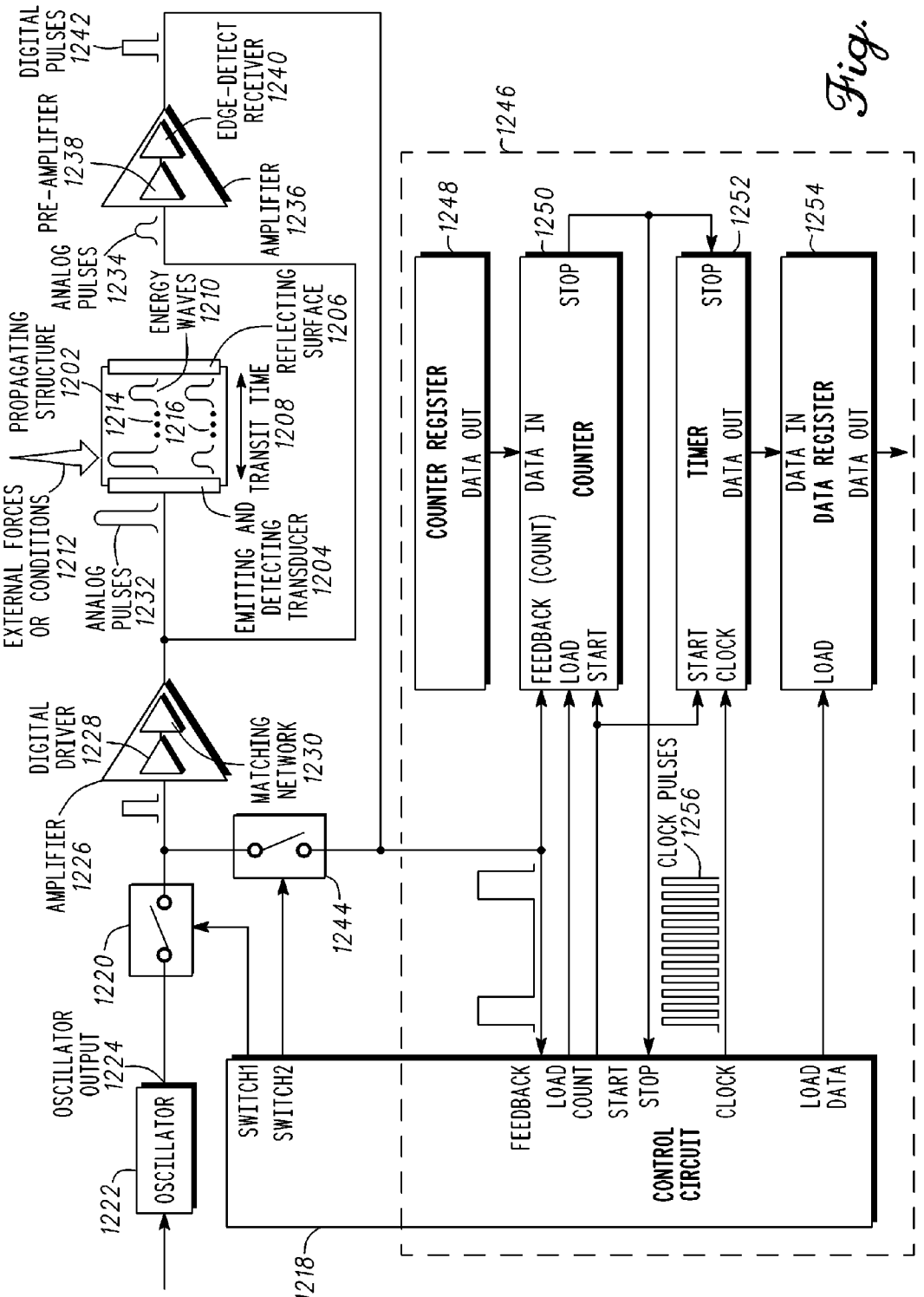

DIGITAL PULSES 1242
EDGE-DETECT RECEIVER 1240
PRE-AMPLIFIER 1238
AMPLIFIER 1236
ANALOG PULSES 1234
ENERGY WAVES 1210
REFLECTING SURFACE 1206
PROPAGATING STRUCTURE 1202
1214
1216
TRANSIT TIME 1208
EXTERNAL FORCES OR CONDITIONS 1212
ANALOG PULSES 1232
EMITTING AND DETECTING TRANSDUCER 1204
DIGITAL DRIVER 1228
MATCHING NETWORK 1230
AMPLIFIER 1226
1220
1244
OSCILLATOR OUTPUT 1224
OSCILLATOR
1222
1218
1246
COUNTER REGISTER
DATA OUT
1248
FEEDBACK (COUNT)
DATA IN
LOAD
START
COUNTER
STOP
1250
TIMER
START
CLOCK
STOP
DATA OUT
1252
DATA IN
DATA REGISTER
LOAD
DATA OUT
1254
CLOCK PULSES 1256
SWITCH1
SWITCH2
FEEDBACK
LOAD COUNT
START
STOP
CLOCK
LOAD DATA
CONTROL CIRCUIT

Fig. 12

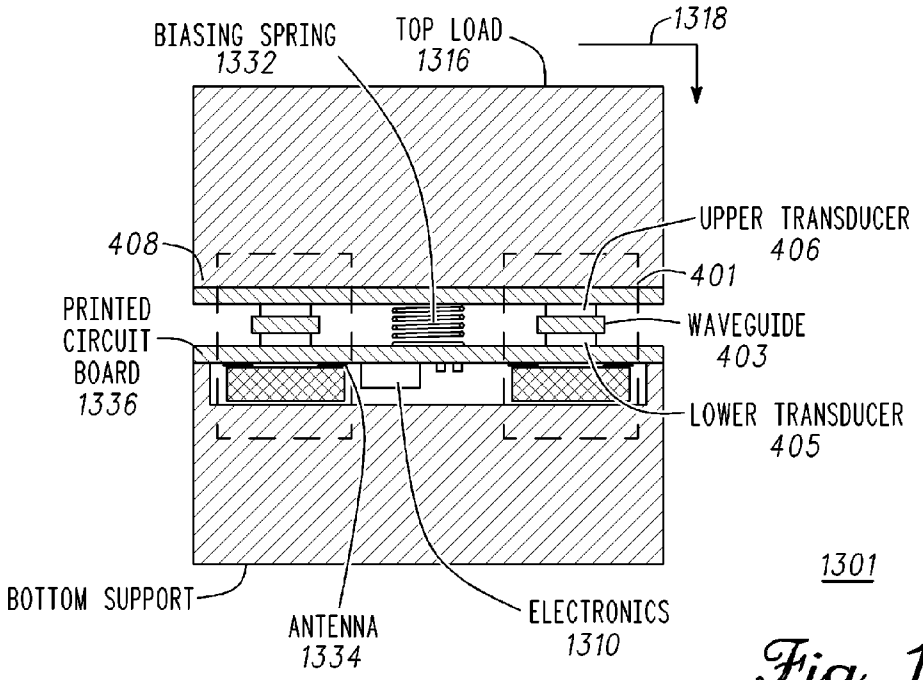
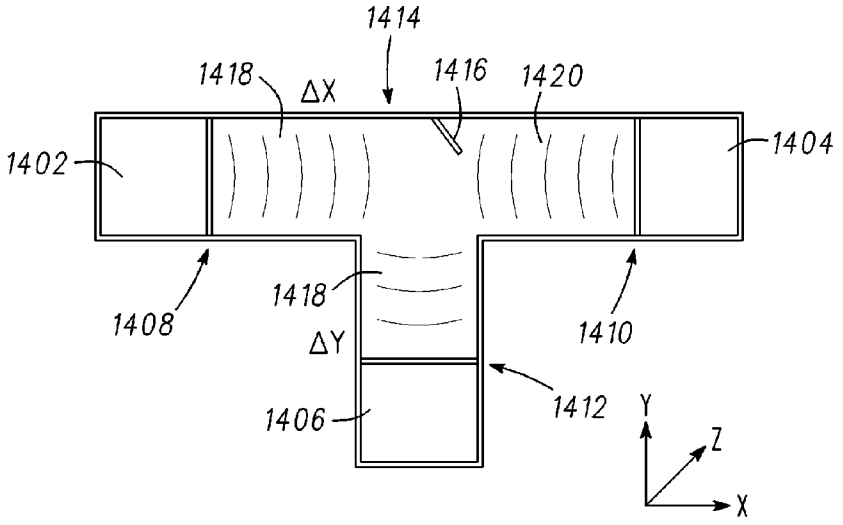

BIASING SPRING
1332
TOP LOAD
1316
1318
UPPER TRANSDUCER
406
408
401
PRINTED
CIRCUIT
BOARD
1336
WAVEGUIDE
403
LOWER TRANSDUCER
405
1301
BOTTOM SUPPORT
ANTENNA
1334
ELECTRONICS
1310

Fig. 13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1418
ΔX
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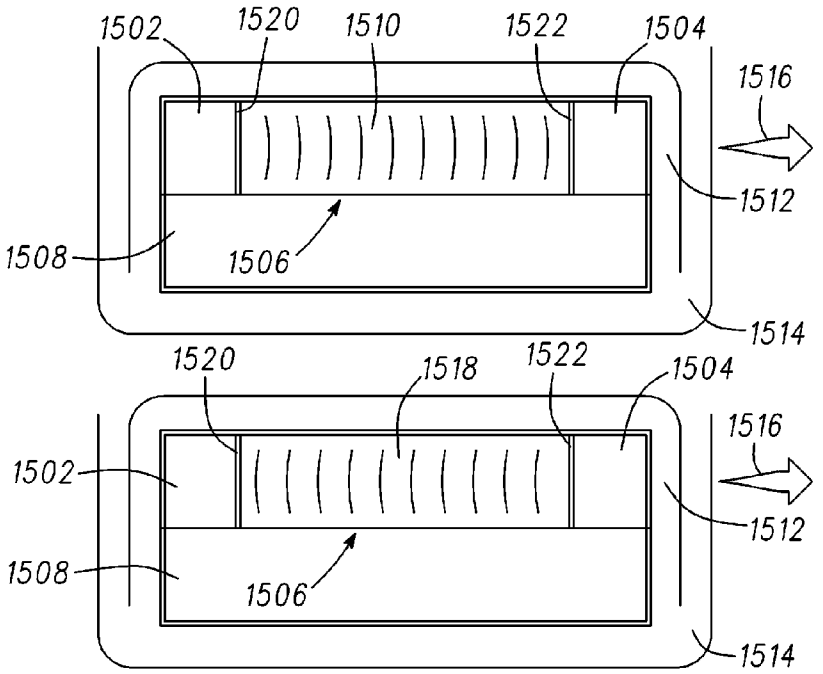
1404
1408
1418
ΔY
1410
1412
1406
Y
Z
X
1400

Fig. 14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1502
1512
1508
1506
1514
1500

Fig. 15

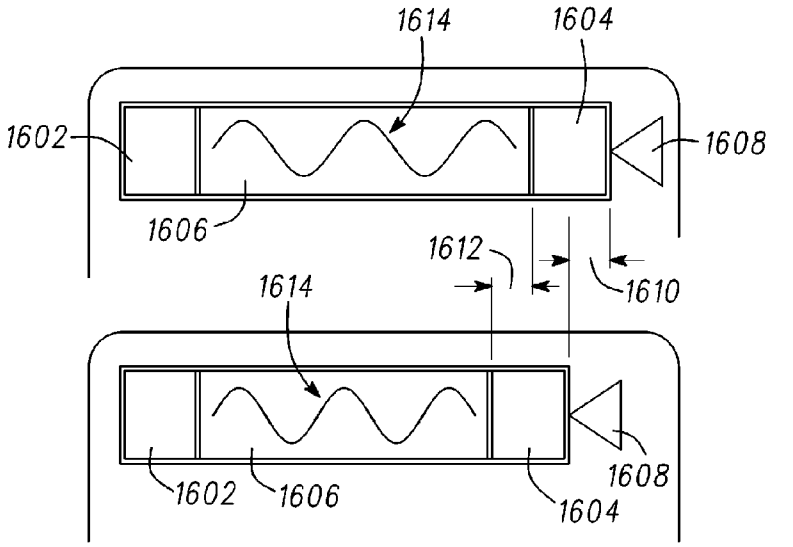

1614
1604
1602
1608
1606
1612
1610
1614
1608
1602
1606
1604
1600

Fig. 16

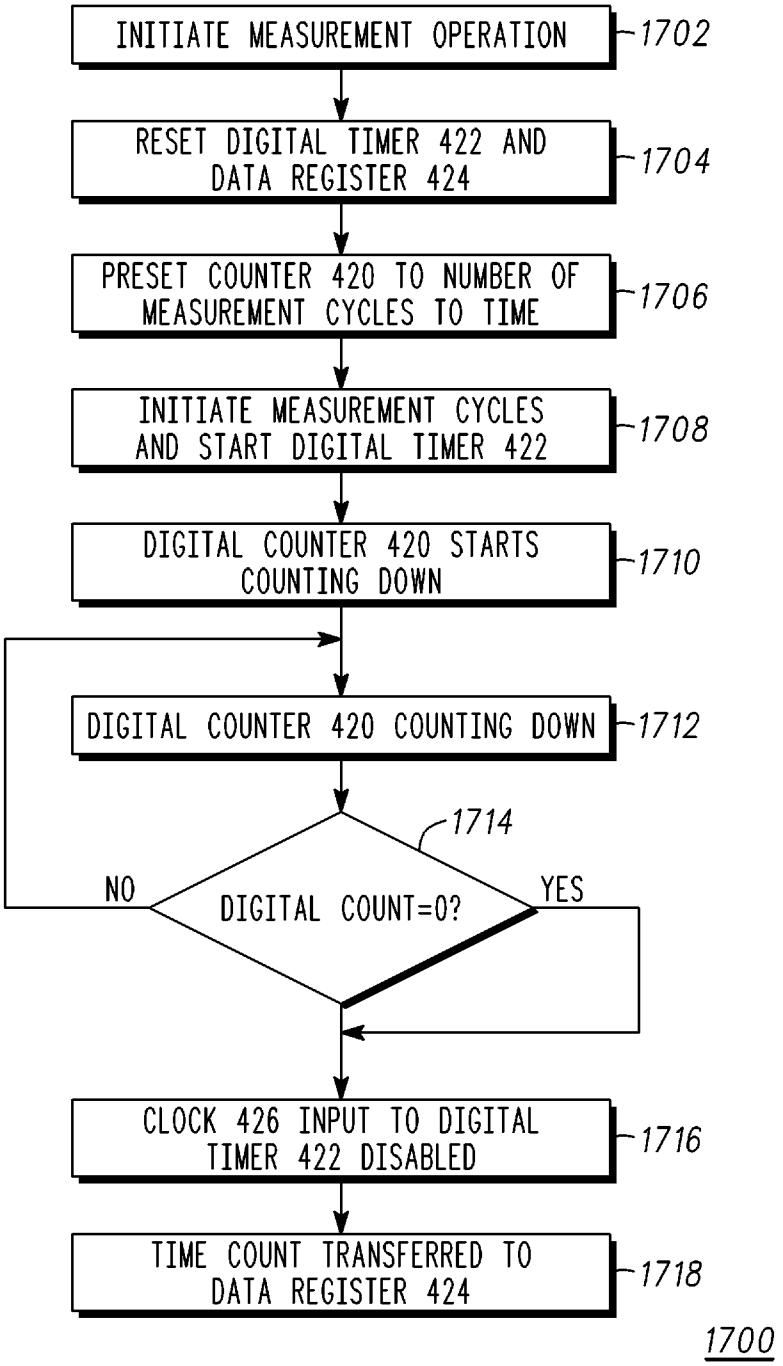

INITIATE MEASUREMENT OPERATION
1702
RESET DIGITAL TIMER 422 AND DATA REGISTER 424
1704
PRESET COUNTER 420 TO NUMBER OF MEASUREMENT CYCLES TO TIME
1706
INITIATE MEASUREMENT CYCLES AND START DIGITAL TIMER 422
1708
DIGITAL COUNTER 420 STARTS COUNTING DOWN
1710
DIGITAL COUNTER 420 COUNTING DOWN
1712
1714
DIGITAL COUNT=0?
NO
YES
CLOCK 426 INPUT TO DIGITAL TIMER 422 DISABLED
1716
TIME COUNT TRANSFERRED TO DATA REGISTER 424
1718
1700

Fig. 17

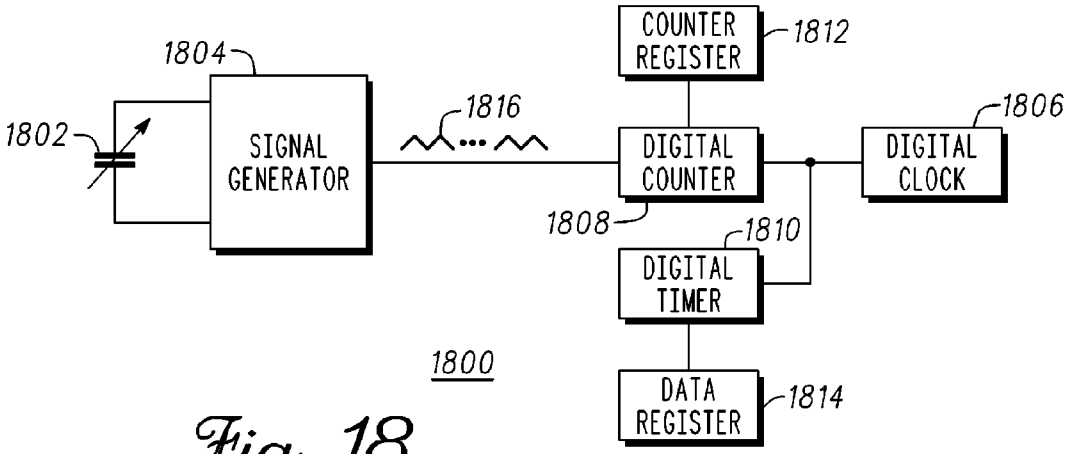

COUNTER REGISTER
1812
1804
1816
1806
1802
SIGNAL GENERATOR
DIGITAL COUNTER
DIGITAL CLOCK
1808
1810
DIGITAL TIMER
1800
DATA REGISTER
1814

Fig. 18

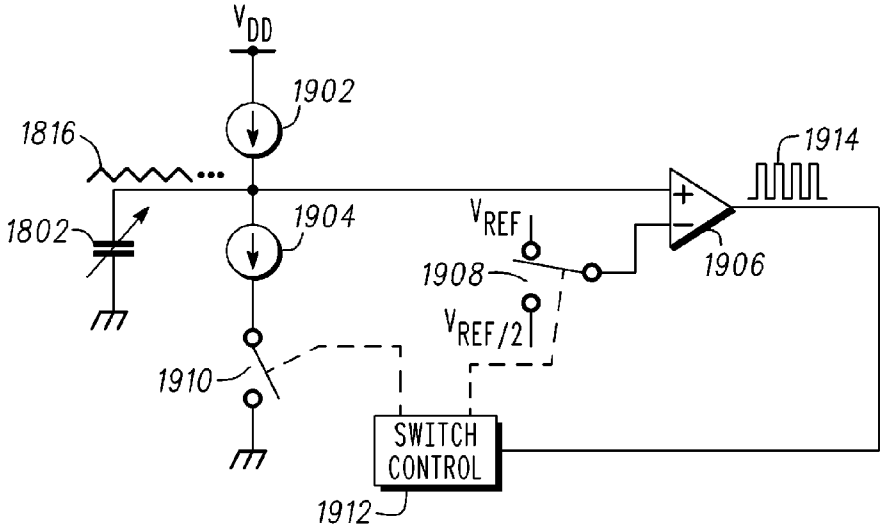

V_{DD}
1902
1816
1914
1802
1904
V_{REF}
1908
1906
$V_{REF/2}$
1910
SWITCH CONTROL
1912
1900

Fig. 19

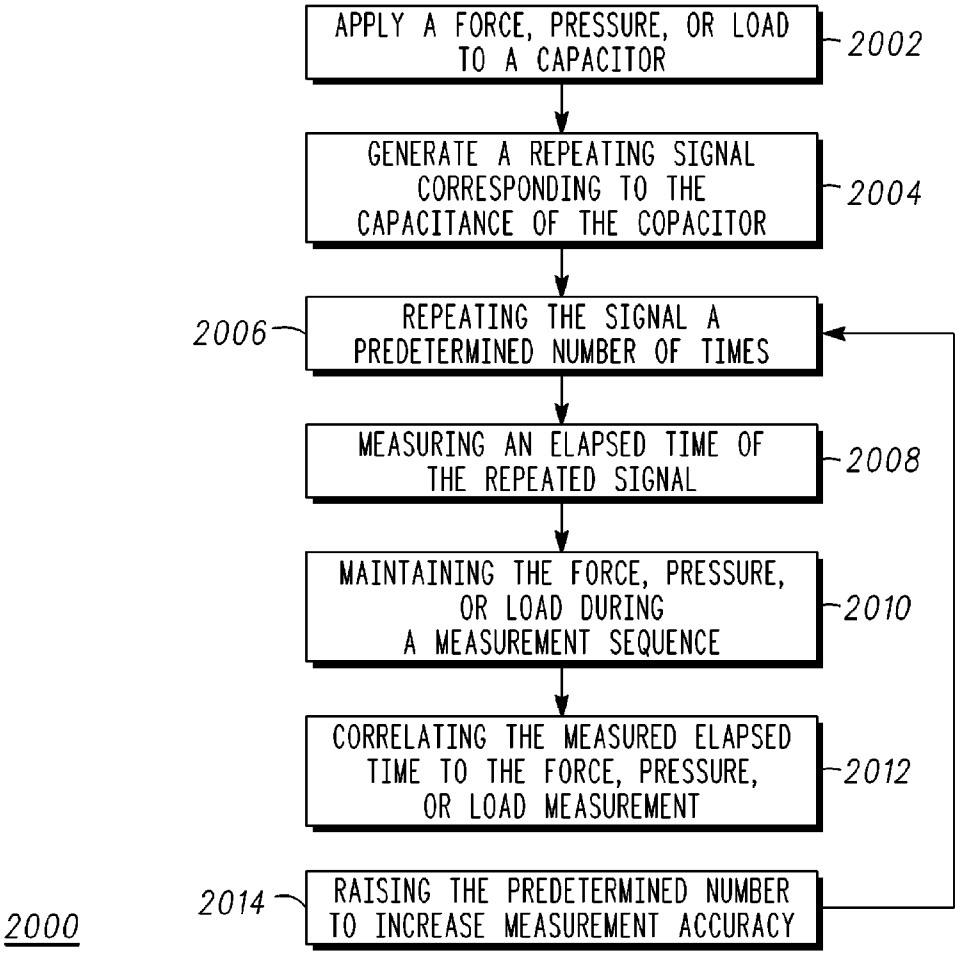
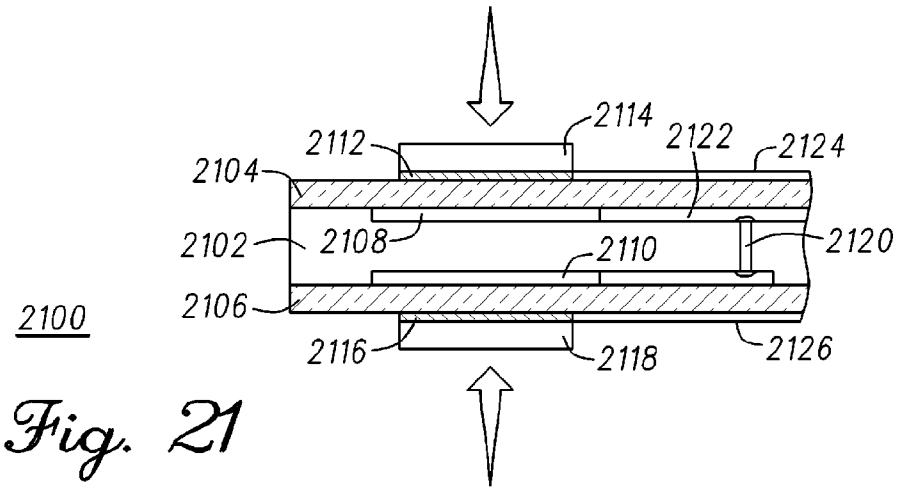

APPLY A FORCE, PRESSURE, OR LOAD TO A CAPACITOR
2002
GENERATE A REPEATING SIGNAL CORRESPONDING TO THE CAPACITANCE OF THE COPACITOR
2004
2006
REPEATING THE SIGNAL A PREDETERMINED NUMBER OF TIMES
MEASURING AN ELAPSED TIME OF THE REPEATED SIGNAL
2008
MAINTAINING THE FORCE, PRESSURE, OR LOAD DURING A MEASUREMENT SEQUENCE
2010
CORRELATING THE MEASURED ELAPSED TIME TO THE FORCE, PRESSURE, OR LOAD MEASUREMENT
2012
2014
RAISING THE PREDETERMINED NUMBER TO INCREASE MEASUREMENT ACCURACY
2000

Fig. 20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2102
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2118
2126
2100

Fig. 21

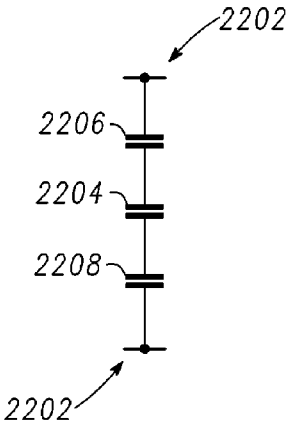


Fig. 22

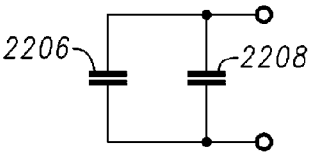


Fig. 23

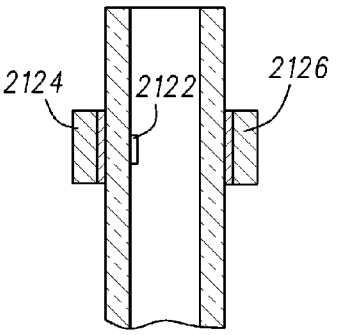


Fig. 25

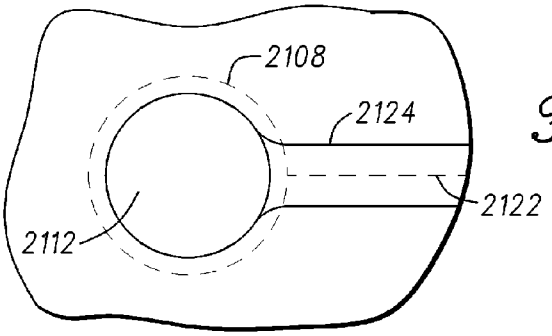
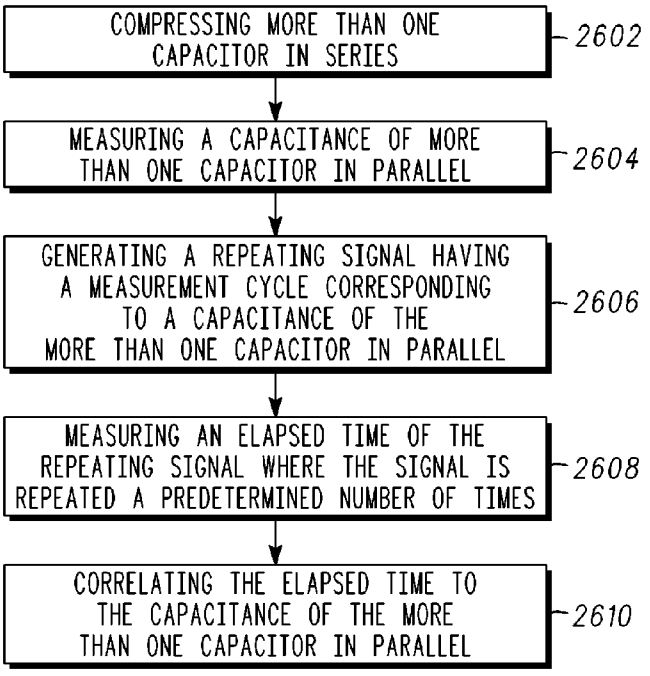


Fig. 24



2600

Fig. 26

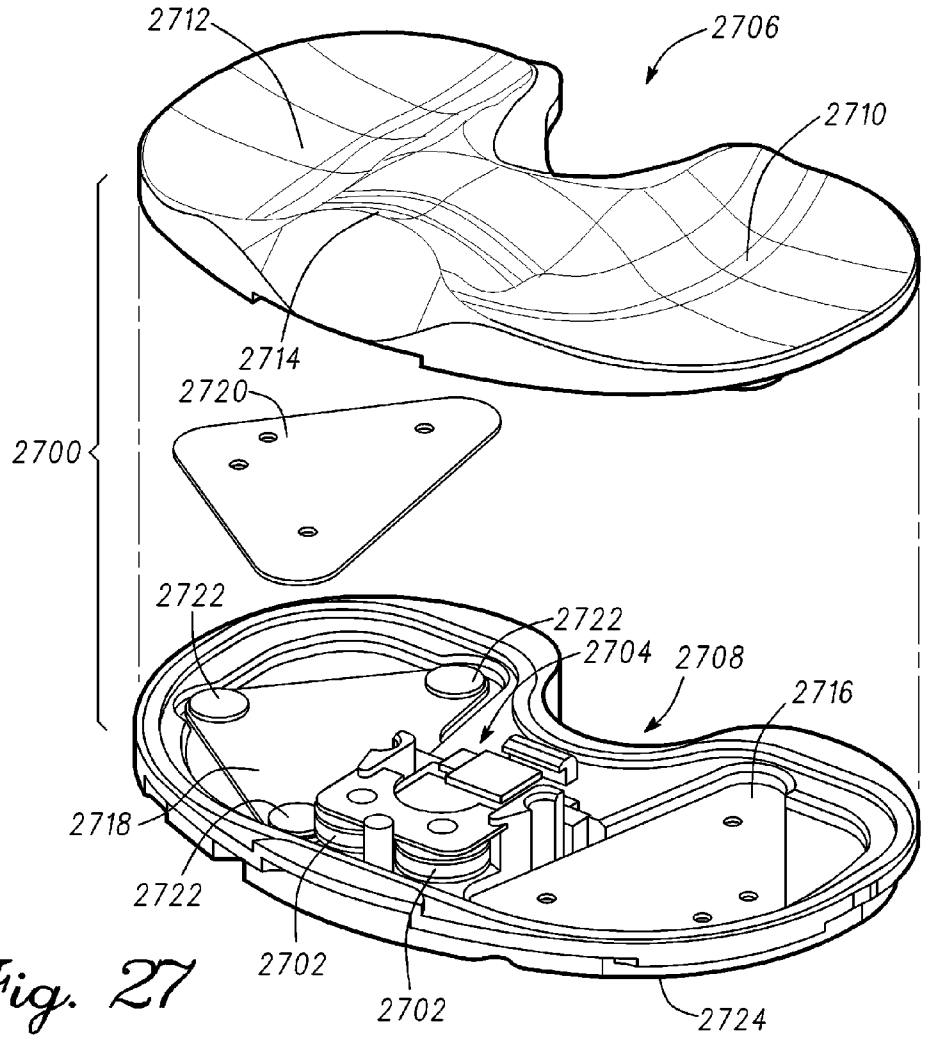


Fig. 27

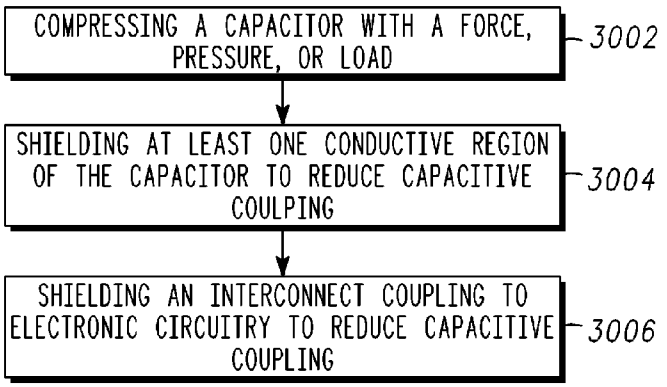
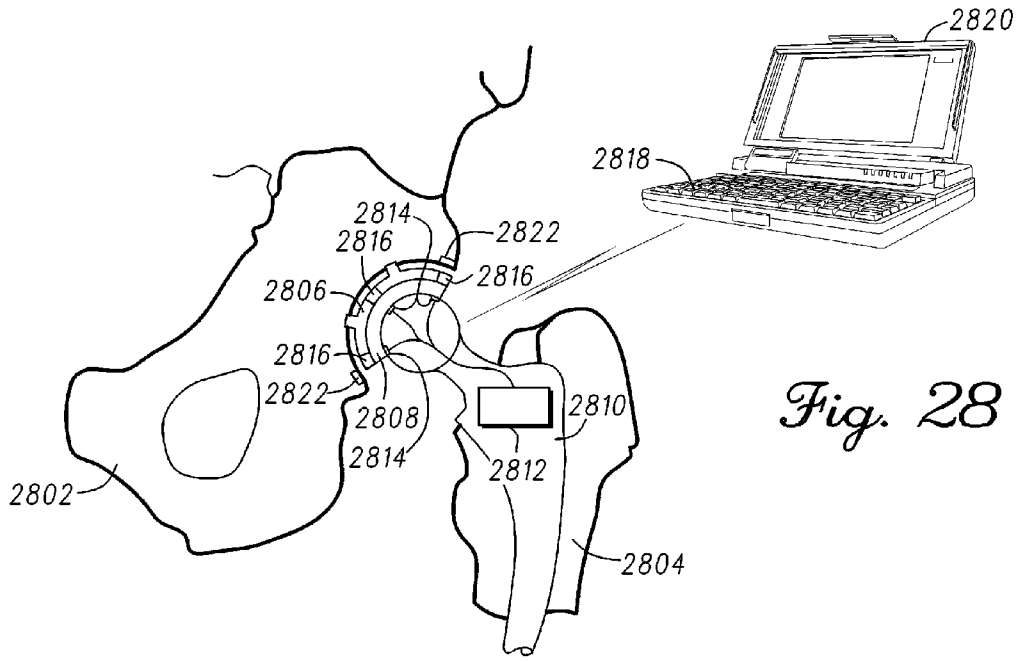


Fig. 30

3000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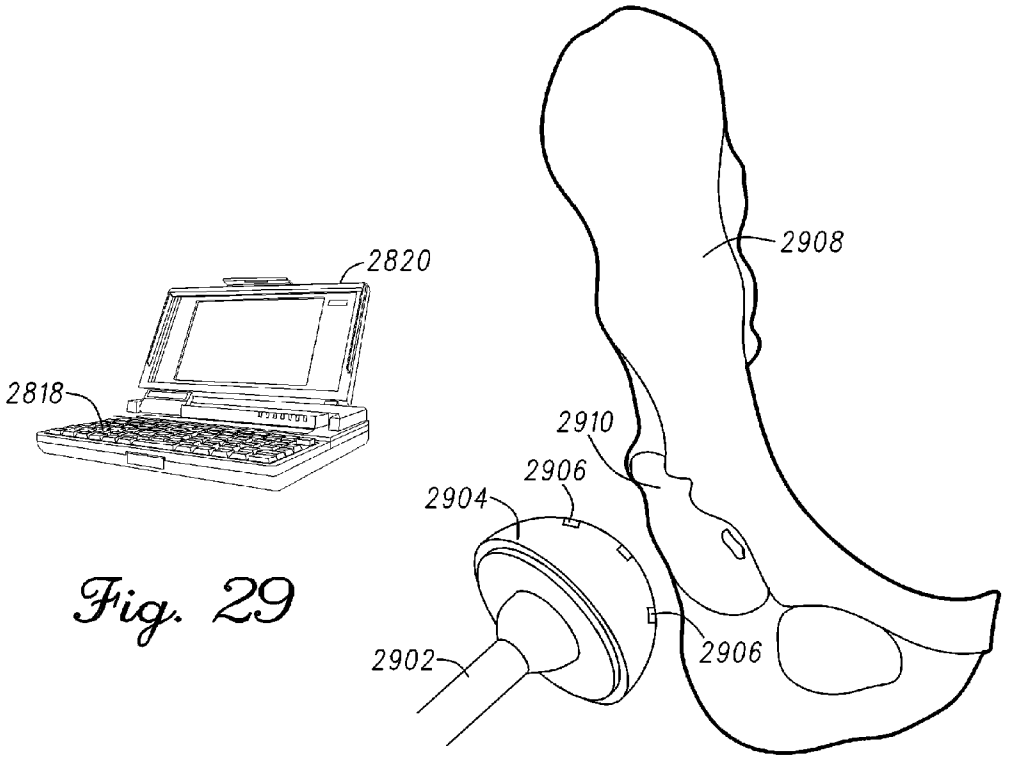
2802
2804

Fig. 28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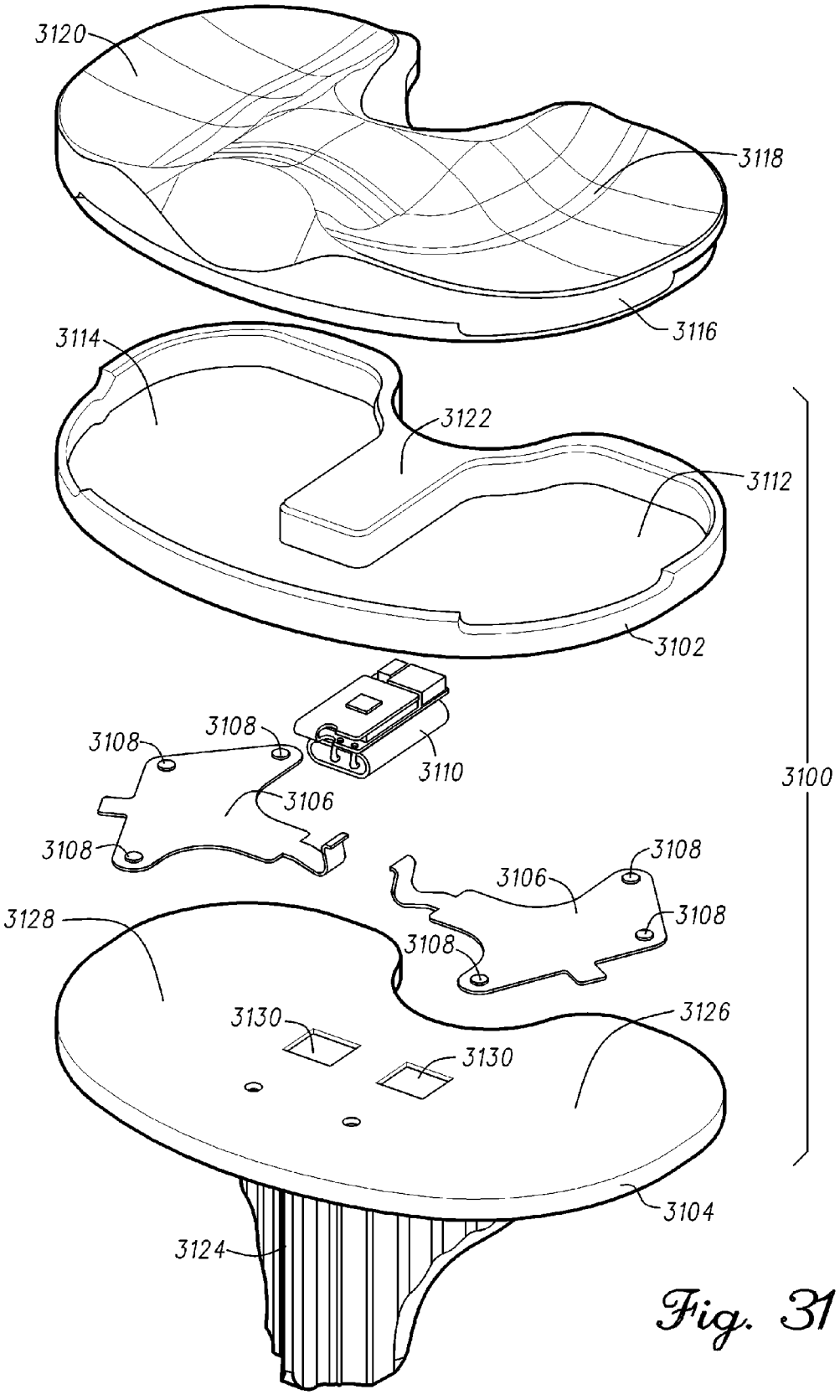
2902
2906

Fig. 29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3104
3124

Fig. 31

Fig. 32

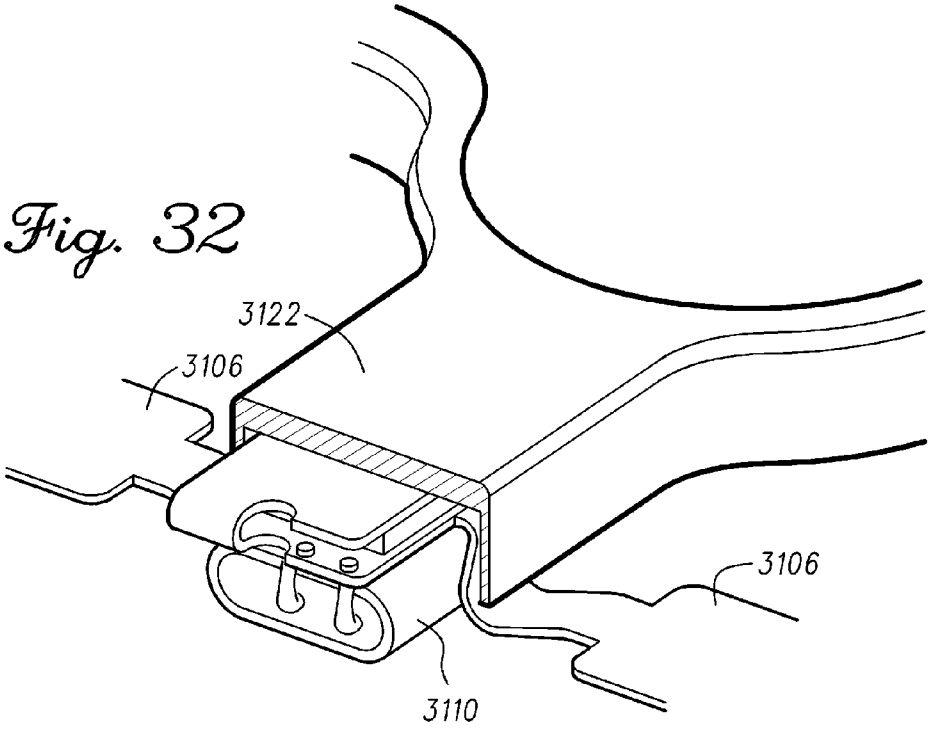
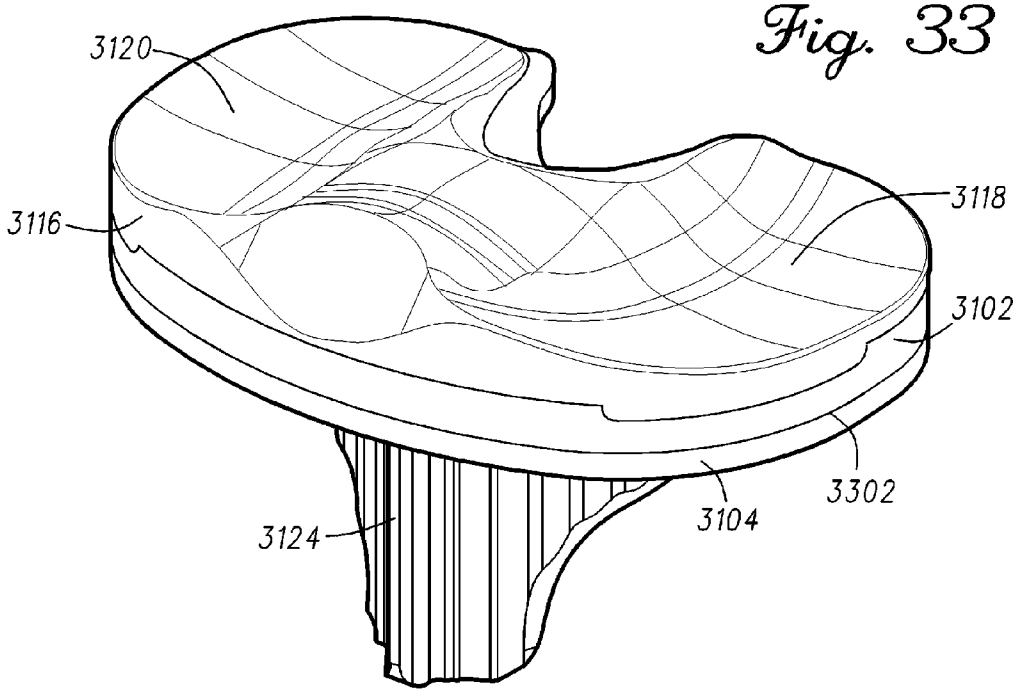


Fig. 33



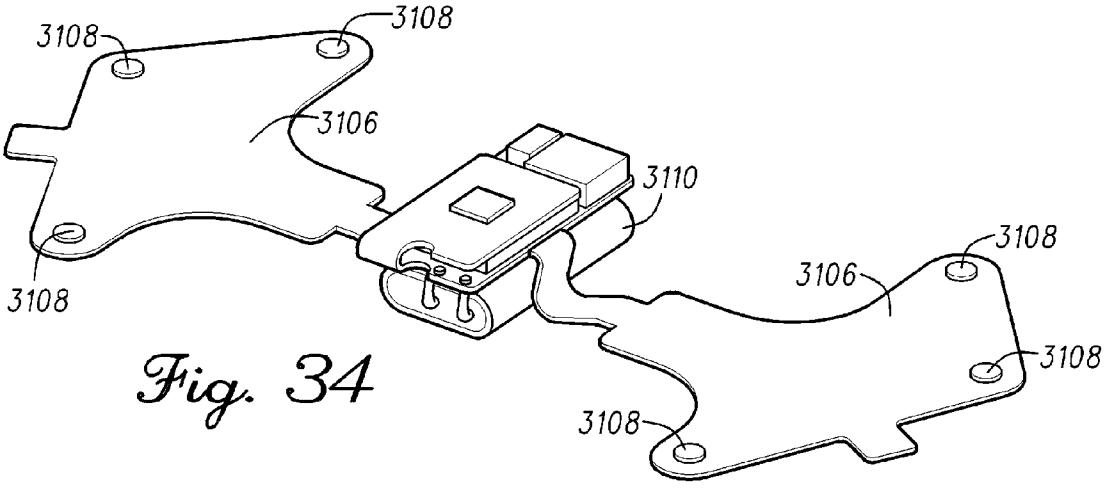

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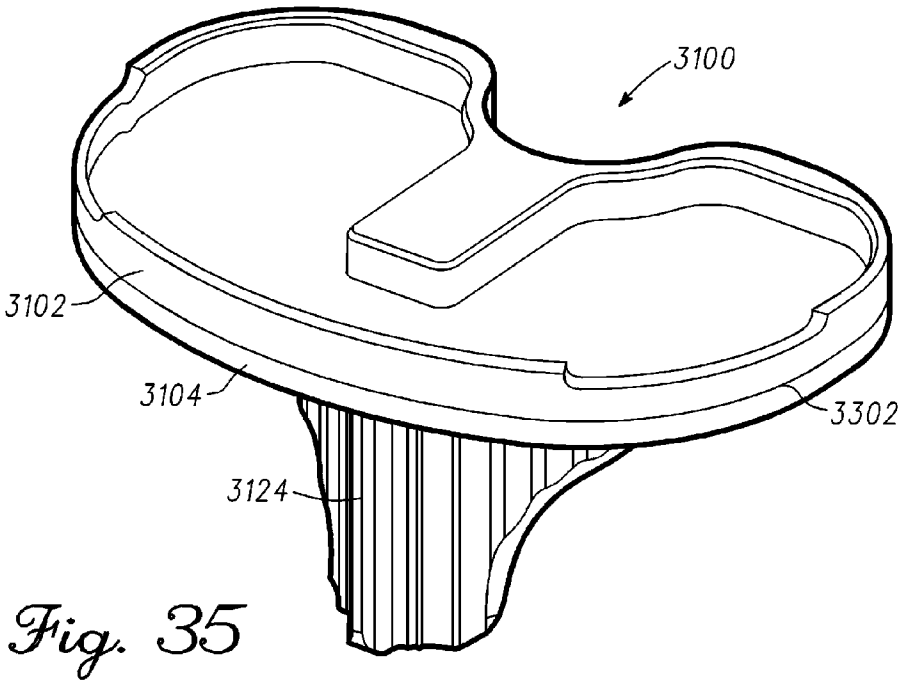
Fig. 34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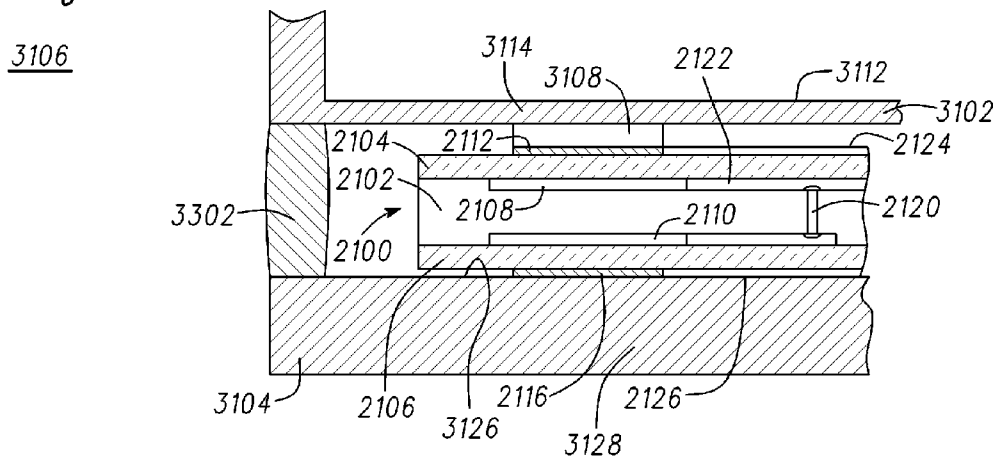
3104
3302
3124

Fig. 35

Fig. 36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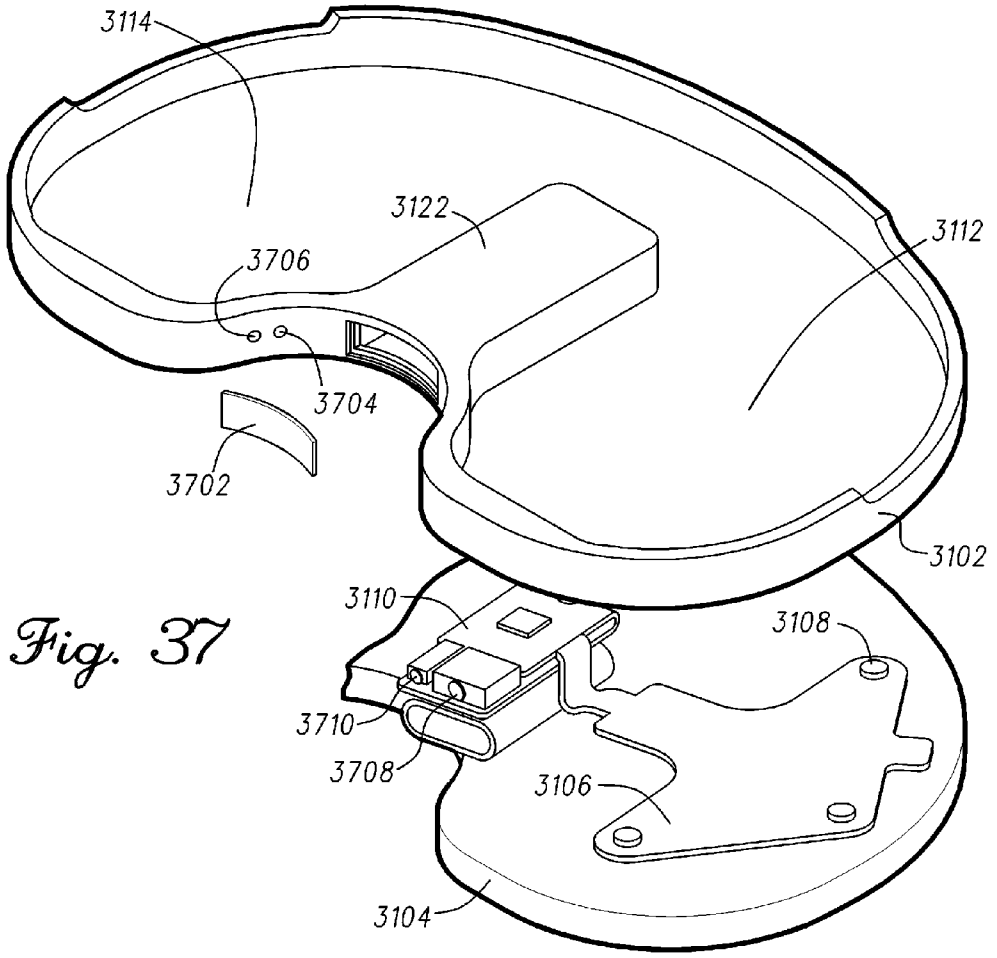
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3106
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Fig. 37

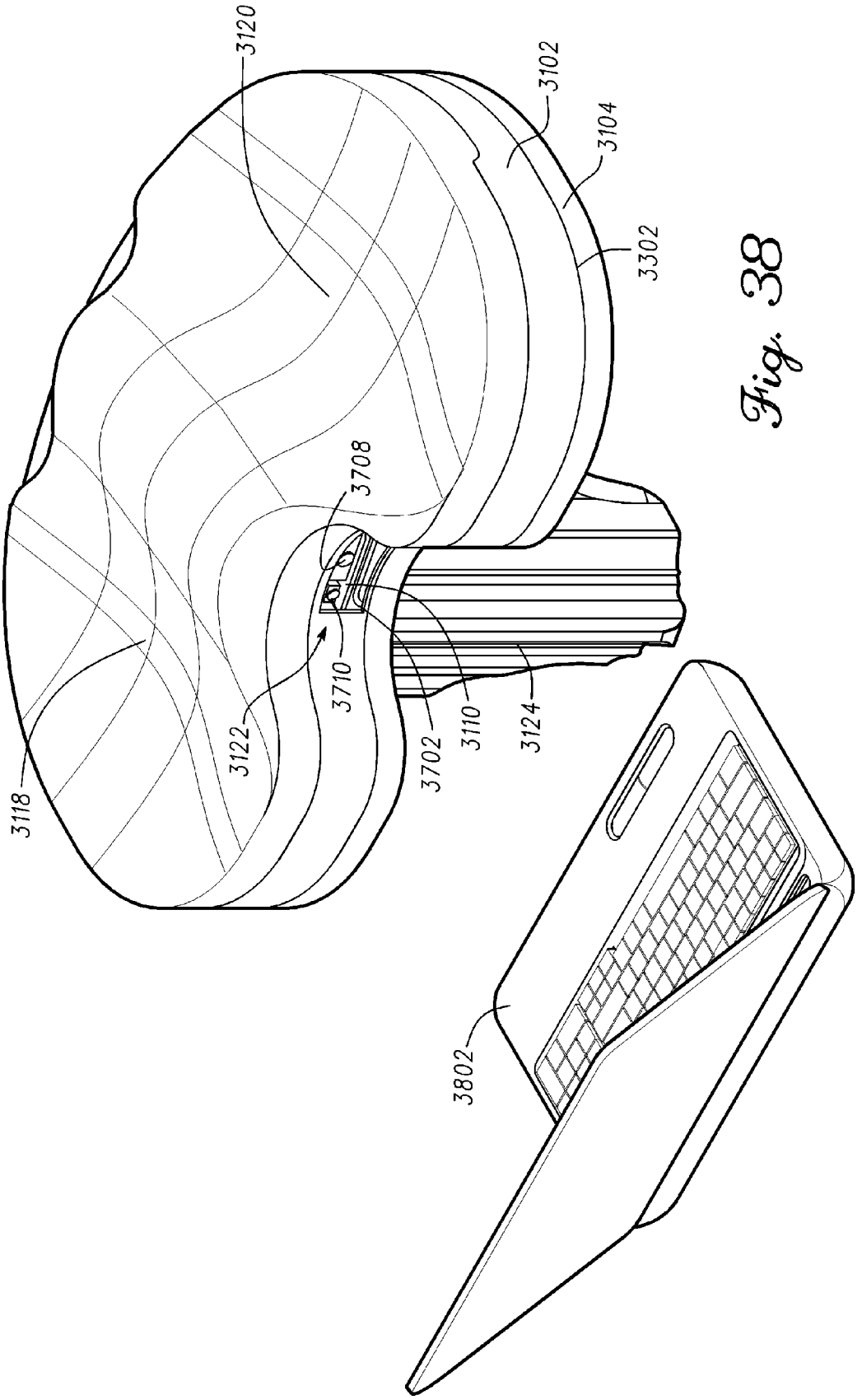


Fig. 38

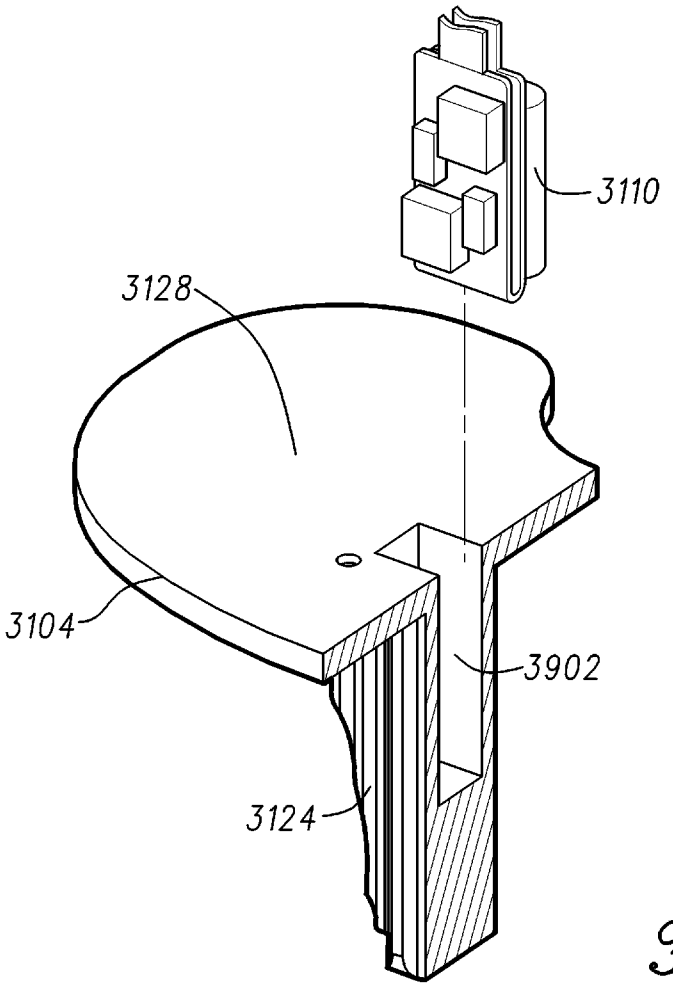
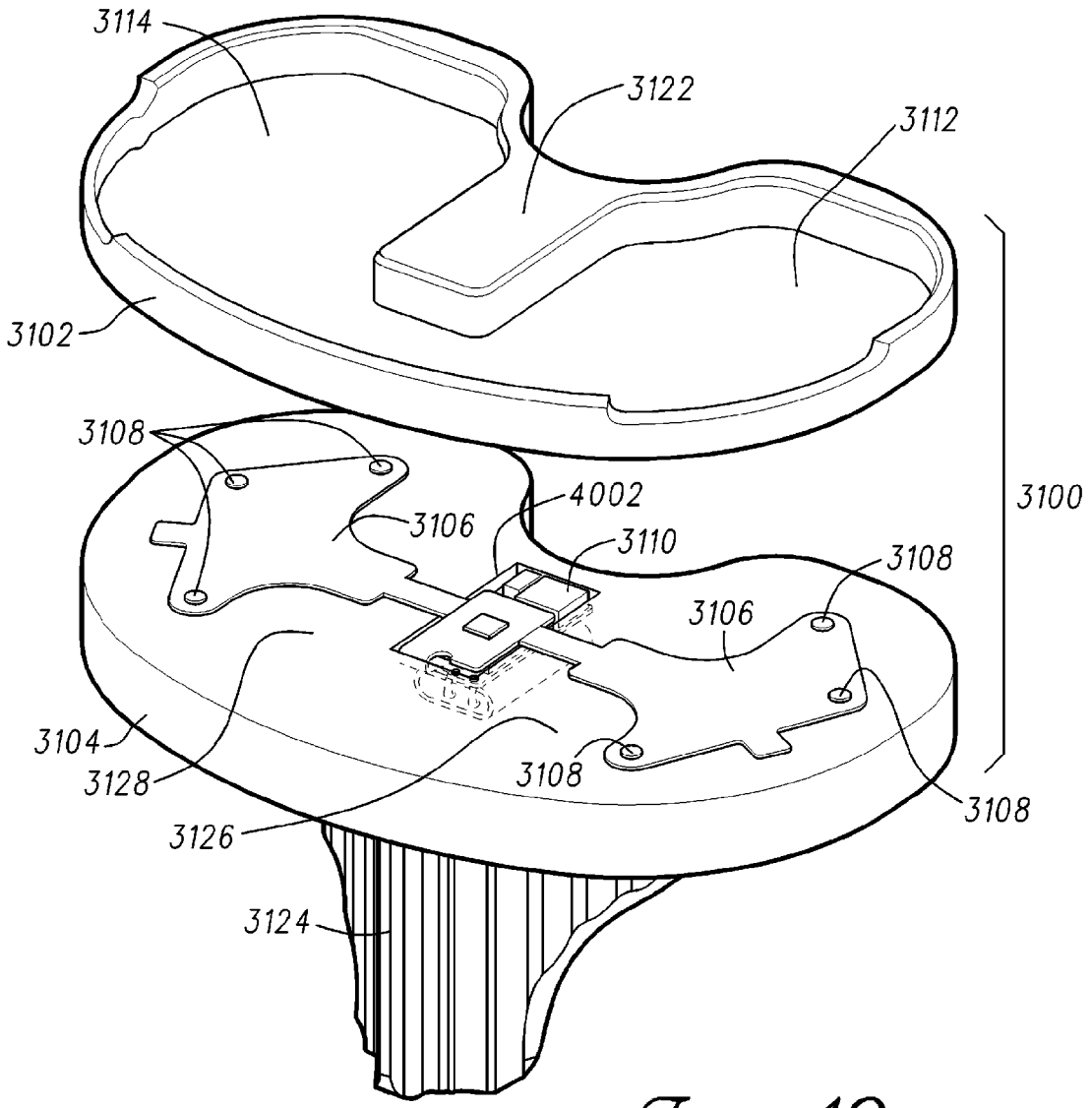


Fig. 39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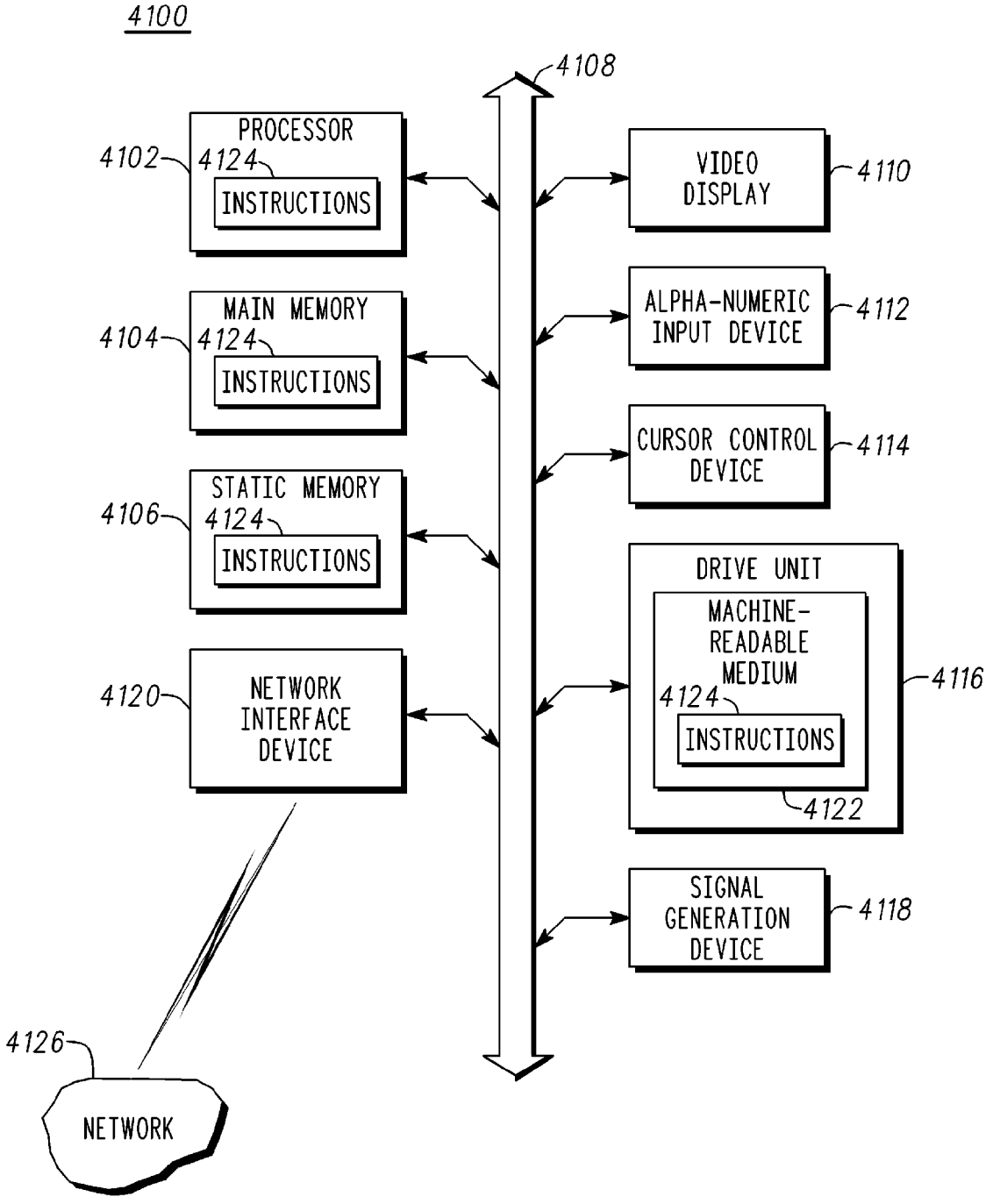
3126
3124

Fig. 40

Fig. 41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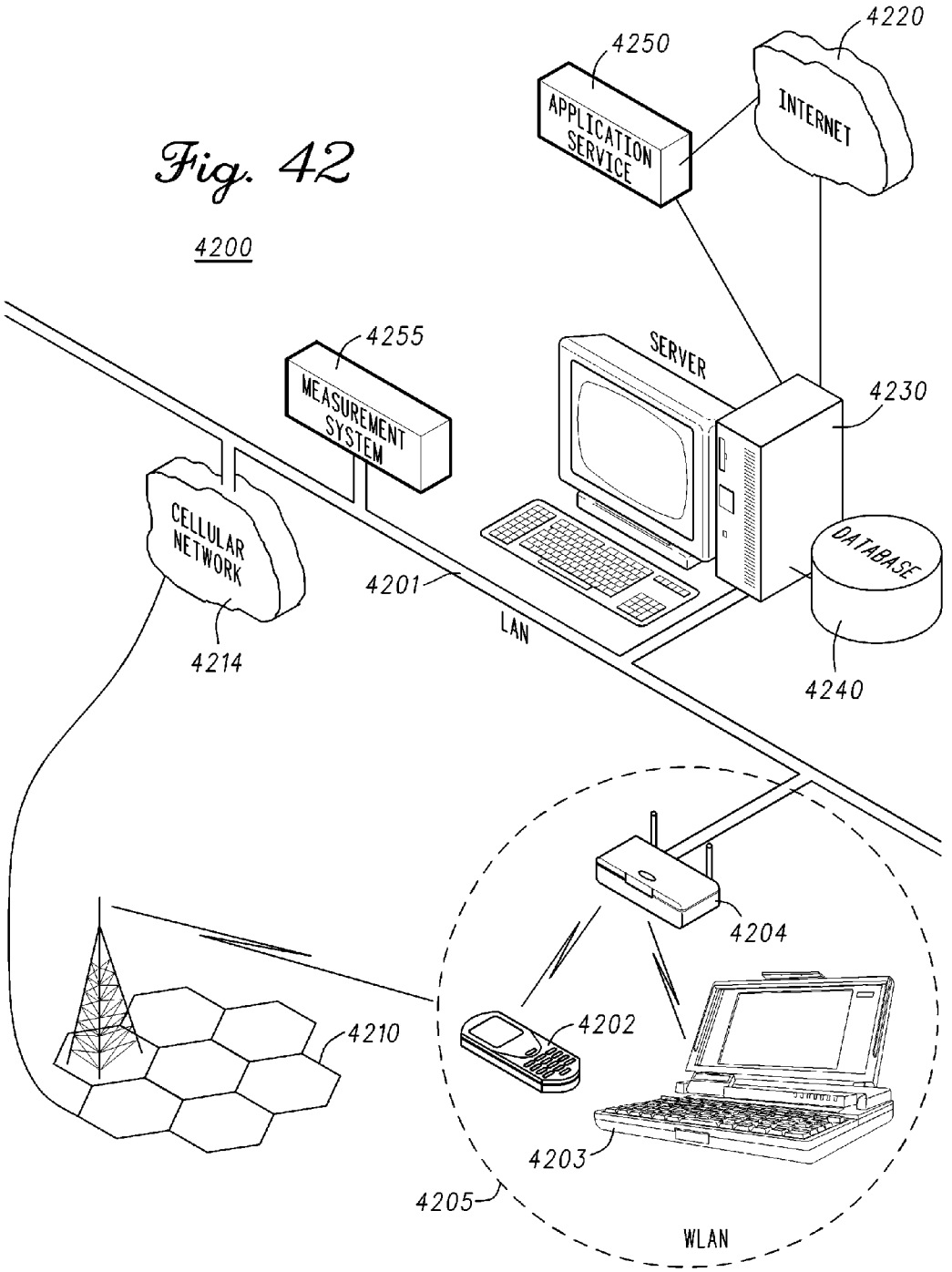
4108
PROCESSOR
4102
4124
INSTRUCTIONS
MAIN MEMORY
4104
4124
INSTRUCTIONS
STATIC MEMORY
4106
4124
INSTRUCTIONS
4120
NETWORK INTERFACE DEVICE
4126
NETWORK
VIDEO DISPLAY
4110
ALPHA-NUMERIC INPUT DEVICE
4112
CURSOR CONTROL DEVICE
4114
DRIVE UNIT
MACHINE-READABLE MEDIUM
4124
INSTRUCTIONS
4122
4116
SIGNAL GENERATION DEVICE
4118

Fig. 42


4200
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APPLICATION SERVICE
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INTERNET
4255
MEASUREMENT SYSTEM
SERVER
4230
CELLULAR NETWORK
4214
4201
LAN
DATABASE
4240
4204
4202
4210
4203
4205
WLAN

PROSTHETIC COMPONENT FOR MONITORING JOINT HEALTH

CROSS-REFERENCE TO RELATED APPLICATIONS

This application is a Continuation of application Ser. No. 13/406,519 filed on Feb. 27, 2012 that is a Continuation-In-Part and claims priority benefit of U.S. application Ser. No. 12/825,852 filed on Jun. 29, 2010 and further claims priority benefit of U.S. Provisional Patent Application No. 61/221,881 filed on Jun. 30, 2009, the entire contents of each application are hereby incorporated by reference. This application further claims the priority benefit of non-provisional application Ser. No. 12/826,349 filed on Jun. 29, 2010 and non-provisional application Ser. Nos. 13/242,277, and 13/242,662 filed on Sep. 23, 2011, the entire contents of each application are hereby incorporated by reference. This application further claims the priority benefit of U.S. provisional patent application Nos. 61/221,761, 61/221,767, 61/221,779, 61/221,788, 61/221,793, 61/221,801, 61/221,808, 61/221,817, 61/221,867, 61/221,874, 61/221,879, 61/221,881, 61/221,886, 61/221,889, 61/221,894, 61/221,901, 61/221,909, 61/221,916, 61/221,923, and 61/221,929 all filed 30 Jun. 2009 which are hereby incorporated by reference.

FIELD

The present invention pertains generally to measurement of physical parameters, and particularly to, but not exclusively, medical electronic devices for high precision sensing.

BACKGROUND

The skeletal system of a mammal is subject to variations among species. Further changes can occur due to environmental factors, degradation through use, and aging. An orthopedic joint of the skeletal system typically comprises two or more bones that move in relation to one another. Movement is enabled by muscle tissue and tendons attached to the skeletal system of the joint. Ligaments hold and stabilize the one or more joint bones positionally. Cartilage is a wear surface that prevents bone-to-bone contact, distributes load, and lowers friction.

There has been substantial growth in the repair of the human skeletal system. In general, orthopedic joints have evolved using information from simulations, mechanical prototypes, and patient data that is collected and used to initiate improved designs. Similarly, the tools being used for orthopedic surgery have been refined over the years but have not changed substantially. Thus, the basic procedure for replacement of an orthopedic joint has been standardized to meet the general needs of a wide distribution of the population. Although the tools, procedure, and artificial joint meet a general need, each replacement procedure is subject to significant variation from patient to patient. The correction of these individual variations relies on the skill of the surgeon to adapt and fit the replacement joint using the available tools to the specific circumstance.

BRIEF DESCRIPTION OF THE DRAWINGS

Various features of the system are set forth with particularity in the appended claims. The embodiments herein, can be understood by reference to the following description, taken in conjunction with the accompanying drawings, in which:

FIG. **1** illustrates a sensor placed in contact between a femur and a tibia for measuring a parameter in accordance with an example embodiment;

FIG. **2** illustrates a block diagram of an zero-crossing receiver in accordance with an example embodiment;

FIG. **3** illustrates a block diagram of the integrated zero-crossing receiver coupled to a sensing assembly in accordance with an example embodiment;

FIG. **4** illustrates a propagation tuned oscillator (PTO) incorporating a zero-crossing receiver or an edge detect receiver to maintain positive closed-loop feedback in accordance with an example embodiment;

FIG. **5** illustrates a sensor interface incorporating the zero-crossing receiver in a continuous wave multiplexing arrangement for maintaining positive closed-loop feedback in accordance with an example embodiment;

FIG. **6** illustrates a block diagram of a propagation tuned oscillator (PTO) incorporating the integrated zero-crossing receiver for operation in continuous wave mode;

FIG. **7** illustrates a sensor interface diagram incorporating the integrated zero-crossing receiver in a pulse multiplexing arrangement for maintaining positive closed-loop feedback in accordance with an example embodiment;

FIG. **8** illustrates a block diagram of a propagation tuned oscillator (PTO) incorporating the integrated zero-crossing receiver for operation in pulse mode in accordance with an example embodiment;

FIG. **9** illustrates a block diagram of an edge-detect receiver circuit in accordance with an example embodiment;

FIG. **10** illustrates a block diagram of the edge-detect receiver circuit coupled to a sensing assembly;

FIG. **11** illustrates a sensor interface diagram incorporating the edge-detect receiver circuit in a pulse-echo multiplexing arrangement for maintaining positive closed-loop feedback in accordance with an example embodiment;

FIG. **12** illustrates a block diagram of a propagation tuned oscillator (PTO) incorporating the edge-detect receiver circuit for operation in pulse echo mode;

FIG. **13** illustrates a simplified cross-sectional view of a sensing module in accordance with an example embodiment;

FIG. **14** illustrates an assemblage for illustrating reflectance and unidirectional modes of operation in accordance with an example embodiment;

FIG. **15** illustrates an assemblage that illustrates propagation of ultrasound waves within a waveguide in the bi-directional mode of operation of this assemblage;

FIG. **16** illustrates a cross-sectional view of a sensor element to illustrate changes in the propagation of ultrasound waves with changes in the length of a waveguide;

FIG. **17** illustrates a simplified flow chart of method steps for high precision processing and measurement data in accordance with an example embodiment;

FIG. **18** illustrates a block diagram of a medical sensing system in accordance with an example embodiment;

FIG. **19** illustrates an oscillator configured to generate a measurement cycle corresponding to a capacitor in accordance with an example embodiment;

FIG. **20** illustrates a method of force, pressure, or load sensing in accordance with an example embodiment;

FIG. **21** illustrates a cross-sectional view of a capacitor in accordance with an example embodiment;

FIG. **22** illustrates the capacitor of FIG. **21** comprising more than one capacitor coupled mechanically in series in accordance with an example embodiment;

FIG. **23** illustrates the capacitor of FIG. **21** comprising more than one capacitor coupled electrically in parallel in accordance with an example embodiment;

FIG. **24** illustrates a top view of a conductive region of the capacitor of FIG. **21** and interconnect thereto in accordance with an example embodiment;

FIG. **25** illustrates a cross-sectional view of the interconnect coupled to the capacitor of FIG. **21** in accordance with an example embodiment;

FIG. **26** illustrates a diagram of a method of measuring a force, pressure, or load in accordance with an example embodiment;

FIG. **27** illustrates a medical device having a plurality of sensors in accordance with an example embodiment;

FIG. **28** illustrates one or more prosthetic components having sensors coupled to and conforming with non-planar surfaces in accordance with an example embodiment;

FIG. **29** illustrates a tool having one or more shielded sensors coupled to a non-planar surface in accordance with an example embodiment;

FIG. **30** illustrates a diagram of a method of using a capacitor as a sensor to measure a parameter of the muscular-skeletal system in accordance with an example embodiment;

FIG. **31** illustrates a prosthetic component having a plurality of sensors in accordance with an example embodiment;

FIG. **32** illustrates a cross-sectional view of a structure of the prosthetic component in accordance with an example embodiment;

FIG. **33** illustrates the prosthetic component and an insert in accordance with an example embodiment;

FIG. **34** illustrates electronic circuitry coupled to interconnect in accordance with an example embodiment;

FIG. **35** illustrates an assembled the prosthetic component in accordance with an example embodiment;

FIG. **36** illustrates a partial cross-sectional view of the prosthetic component in accordance with an example embodiment;

FIG. **37** illustrates the structure and electronic circuitry in accordance with an example embodiment;

FIG. **38** illustrates the prosthetic component and a remote system in accordance with an example embodiment;

FIG. **39** is an illustration of the electronic circuitry and the structure in accordance with an example embodiment;

FIG. **40** is an illustration of the electronic circuitry and the structure in accordance with an example embodiment;

FIG. **41** depicts an exemplary diagrammatic representation of a machine in the form of a system within which a set of instructions are executed in accordance with an example embodiment; and

FIG. **42** is an illustration of a communication network for measurement and reporting in accordance with an example embodiment.

DETAILED DESCRIPTION

Embodiments of the invention are broadly directed to measurement of physical parameters, and more particularly, to fast-response circuitry that supports accurate measurement of small sensor changes.

The following description of exemplary embodiment(s) is merely illustrative in nature and is in no way intended to limit the invention, its application, or uses.

Processes, techniques, apparatus, and materials as known by one of ordinary skill in the art may not be discussed in detail but are intended to be part of the enabling description where appropriate. For example specific computer code may not be listed for achieving each of the steps discussed, however one of ordinary skill would be able, without undo experimentation, to write such code given the enabling disclosure herein. Such code is intended to fall within the scope of at least one exemplary embodiment.

In all of the examples illustrated and discussed herein, any specific materials, such as temperatures, times, energies, and material properties for process steps or specific structure implementations should be interpreted to be illustrative only and non-limiting. Processes, techniques, apparatus, and materials as known by one of ordinary skill in the art may not be discussed in detail but are intended to be part of an enabling description where appropriate. It should also be noted that the word "coupled" used herein implies that elements may be directly coupled together or may be coupled through one or more intervening elements.

Additionally, the sizes of structures used in exemplary embodiments are not limited by any discussion herein (e.g., the sizes of structures can be macro (centimeter, meter, and larger sizes), micro (micrometer), and nanometer size and smaller).

Notice that similar reference numerals and letters refer to similar items in the following figures, and thus once an item is defined in one figure, it may not be discussed or further defined in the following figures.

In a first embodiment, an ultrasonic measurement system comprises one or more ultrasonic transducers, an ultrasonic waveguide, and a propagation tuned oscillator (PTO) or Phase Locked Loop (PLL). The ultrasonic measurement system in this embodiment employs a continuous mode (CM) of operation to evaluate propagation characteristics of continuous ultrasonic waves in the waveguide by way of closed-loop feedback to determine levels of applied forces on the waveguide.

In a second embodiment, an ultrasonic measurement system comprises one or more ultrasonic transducers, an ultrasonic waveguide, and a propagation tuned oscillator (PTO) or Phase Locked Loop (PLL). The ultrasonic measurement system in this embodiment employs a pulse mode (PM) of operation to evaluate propagation characteristics of pulsed ultrasonic waves in the waveguide by way of closed-loop feedback to determine levels of applied forces on the waveguide.

In a third embodiment, an ultrasonic measurement system comprises one or more ultrasonic transducers, an ultrasonic waveguide, and a propagation tuned oscillator (PTO) or Phase Locked Loop (PLL). The ultrasonic measurement system in this embodiment employs a pulse echo mode (PE) of operation to evaluate propagation characteristics of ultrasonic echo reflections in the waveguide by way of closed-loop feedback to determine levels of applied forces on the waveguide.

FIG. **1** is an illustration of a sensor **100** placed in contact between a femur **102** and a tibia **108** for measuring a parameter in accordance with an exemplary embodiment. In general, a sensor **100** is placed in contact with or in proximity to the muscular-skeletal system to measure a parameter. In a non-limiting example, sensor **100** is used to measure a parameter of a muscular-skeletal system during a procedure such as an installation of an artificial joint. Embodiments of sensor **100** are broadly directed to measurement of physical parameters, and more particularly, to evaluating changes in the transit time of a pulsed energy wave propagating through a medium. In-situ measurements during orthopedic joint implant surgery would be of substantial benefit to verify an implant is in balance and under appropriate loading or tension. In one embodiment, the instrument is similar to and operates familiarly with other instruments currently used by surgeons. This will increase acceptance and reduce the adoption cycle for a new technology. The measurements will allow the surgeon to ensure that the implanted components are

installed within predetermined ranges that maximize the working life of the joint prosthesis and reduce costly revisions. Providing quantitative measurement and assessment of the procedure using real-time data will produce results that are more consistent. A further issue is that there is little or no implant data generated from the implant surgery, post-operatively, and long term. Sensor **100** can provide implant status data to the orthopedic manufacturers and surgeons. Moreover, data generated by direct measurement of the implanted joint itself would greatly improve the knowledge of implanted joint operation and joint wear thereby leading to improved design and materials.

In at least one exemplary embodiment, an energy pulse is directed within one or more waveguides in sensor **100** by way of pulse mode operations and pulse shaping. The waveguide is a conduit that directs the energy pulse in a predetermined direction. The energy pulse is typically confined within the waveguide. In one embodiment, the waveguide comprises a polymer material. For example, urethane or polyethylene are polymers suitable for forming a waveguide. The polymer waveguide can be compressed and has little or no hysteresis in the system. Alternatively, the energy pulse can be directed through the muscular-skeletal system. In one embodiment, the energy pulse is directed through bone of the muscular-skeletal system to measure bone density. A transit time of an energy pulse is related to the material properties of a medium through which it traverses. This relationship is used to generate accurate measurements of parameters such as distance, weight, strain, pressure, wear, vibration, viscosity, and density to name but a few.

Sensor **100** can be size constrained by form factor requirements of fitting within a region the muscular-skeletal system or a component such as a tool, equipment, or artificial joint. In a non-limiting example, sensor **100** is used to measure load and balance of an installed artificial knee joint. A knee prosthesis comprises a femoral prosthetic component **104**, an insert, and a tibial prosthetic component **106**. A distal end of femur **102** is prepared and receives femoral prosthetic component **104**. Femoral prosthetic component **104** typically has two condyle surfaces that mimic a natural femur. As shown, femoral prosthetic component **104** has single condyle surface being coupled to femur **102**. Femoral prosthetic component **104** is typically made of a metal or metal alloy.

A proximal end of tibia **108** is prepared to receive tibial prosthetic component **106**. Tibial prosthetic component **106** is a support structure that is fastened to the proximal end of the tibia and is usually made of a metal or metal alloy. The tibial prosthetic component **106** also retains the insert in a fixed position with respect to tibia **108**. The insert is fitted between femoral prosthetic component **104** and tibial prosthetic component **106**. The insert has at least one bearing surface that is in contact with at least condyle surface of femoral prosthetic component **104**. The condyle surface can move in relation to the bearing surface of the insert such that the lower leg can rotate under load. The insert is typically made of a high wear plastic material that minimizes friction.

In a knee joint replacement process, the surgeon affixes femoral prosthetic component **104** to the femur **102** and tibial prosthetic component **106** to tibia **108**. The tibial prosthetic component **106** can include a tray or plate affixed to the planarized proximal end of the tibia **108**. Sensor **100** is placed between a condyle surface of femoral prosthetic component **104** and a major surface of tibial prosthetic component **106**. The condyle surface contacts a major surface of sensor **100**. The major surface of sensor **100** approximates a surface of the insert. Tibial prosthetic component **106** can include a cavity or tray on the major surface that receives and retains sensor **100** during a measurement process. Tibial prosthetic component **106** and sensor **100** has a combined thickness that represents a combined thickness of tibial prosthetic component **106** and a final (or chronic) insert of the knee joint.

In one embodiment, two sensors **100** are fitted into two separate cavities, the cavities are within a trial insert (that may also be referred to as the tibial insert, rather than the tibial component itself) that is held in position by tibial component **106**. One or two sensors **100** may be inserted between femoral prosthetic component **104** and tibial prosthetic component **106**. Each sensor is independent and each measures a respective condyle of femur **102**. Separate sensors also accommodate a situation where a single condyle is repaired and only a single sensor is used. Alternatively, the electronics can be shared between two sensors to lower cost and complexity of the system. The shared electronics can multiplex between each sensor module to take measurements when appropriate. Measurements taken by sensor **100** aid the surgeon in modifying the absolute loading on each condyle and the balance between condyles. Although shown for a knee implant, sensor **100** can be used to measure other orthopedic joints such as the spine, hip, shoulder, elbow, ankle, wrist, interphalangeal joint, metatarsophalangeal joint, metacarpophalangeal joints, and others. Alternatively, sensor **100** can also be adapted to orthopedic tools to provide measurements.

The prosthesis incorporating sensor **100** emulates the function of a natural knee joint. Sensor **100** can measure loads or other parameters at various points throughout the range of motion. Data from sensor **100** is transmitted to a receiving station **110** via wired or wireless communications. In a first embodiment, sensor **100** is a disposable system. Sensor **100** can be disposed of after using sensor **100** to optimally fit the joint implant. Sensor **100** is a low cost disposable system that reduces capital costs, operating costs, facilitates rapid adoption of quantitative measurement, and initiates evidentiary based orthopedic medicine. In a second embodiment, a methodology can be put in place to clean and sterilize sensor **100** for reuse. In a third embodiment, sensor **100** can be incorporated in a tool instead of being a component of the replacement joint. The tool can be disposable or be cleaned and sterilized for reuse. In a fourth embodiment, sensor **100** can be a permanent component of the replacement joint. Sensor **100** can be used to provide both short term and long term post-operative data on the implanted joint. In a fifth embodiment, sensor **100** can be coupled to the muscular-skeletal system. In all of the embodiments, receiving station **110** can include data processing, storage, or display, or combination thereof and provide real time graphical representation of the level and distribution of the load. Receiving station **110** can record and provide accounting information of sensor **100** to an appropriate authority.

In an intra-operative example, sensor **100** can measure forces (Fx, Fy, Fz) with corresponding locations and torques (e.g. Tx, Ty, and Tz) on the femoral prosthetic component **104** and the tibial prosthetic component **106**. The measured force and torque data is transmitted to receiving station **110** to provide real-time visualization for assisting the surgeon in identifying any adjustments needed to achieve optimal joint pressure and balancing. The data has substantial value in determining ranges of load and alignment tolerances required to minimize rework and maximize patient function and longevity of the joint.

As mentioned previously, sensor **100** can be used for other joint surgeries; it is not limited to knee replacement implant or implants. Moreover, sensor **100** is not limited to trial measurements. Sensor **100** can be incorporated into the final joint system to provide data post-operatively to determine if the

implanted joint is functioning correctly. Early determination of a problem using sensor **100** can reduce catastrophic failure of the joint by bringing awareness to a problem that the patient cannot detect. The problem can often be rectified with a minimal invasive procedure at lower cost and stress to the patient. Similarly, longer term monitoring of the joint can determine wear or misalignment that if detected early can be adjusted for optimal life or replacement of a wear surface with minimal surgery thereby extending the life of the implant. In general, sensor **100** can be shaped such that it can be placed or engaged or affixed to or within load bearing surfaces used in many orthopedic applications (or used in any orthopedic application) related to the musculoskeletal system, joints, and tools associated therewith. Sensor **100** can provide information on a combination of one or more performance parameters of interest such as wear, stress, kinematics, kinetics, fixation strength, ligament balance, anatomical fit and balance.

FIG. **2** is a block diagram of a zero-crossing receiver **200** in accordance with one embodiment. In a first embodiment, the zero-crossing receiver **200** is provided to detect transition states of energy waves, such as the transition of each energy wave through a mid-point of a symmetrical or cyclical waveform. This enables capturing of parameters including, but not limited to, transit time, phase, or frequency of the energy waves. The receiver rapidly responds to a signal transition and outputs a digital pulse that is consistent with the energy wave transition characteristics and with minimal delay. The zero-crossing receiver **200** further discriminates between noise and the energy waves of interest, including very low level waves by way of adjustable levels of noise reduction. A noise reduction section **218** comprises a filtering stage and an offset adjustment stage to perform noise suppression accurately over a wide range of amplitudes including low level waves.

In a second embodiment, a zero-crossing receiver is provided to convert an incoming symmetrical, cyclical, or sine wave to a square or rectangular digital pulse sequence with superior performance for very low level input signals. The digital pulse sequence represents pulse timing intervals that are consistent with the energy wave transition times. The zero-crossing receiver is coupled with a sensing assembly to generate the digital pulse sequence responsive to evaluating transitions of the incoming sine wave. This digital pulse sequence conveys timing information related to parameters of interest, such as applied forces, associated with the physical changes in the sensing assembly.

In a third embodiment, the integrated zero-crossing receiver is incorporated within a propagation tuned oscillator (PTO) to maintain positive closed-loop feedback when operating in a continuous wave mode or pulse-loop mode. The integrated edge zero-crossing receiver is electrically integrated with the PTO by multiplexing input and output circuitry to achieve ultra low-power and small compact size. Electrical components of the PTO are integrated with components of the zero-crossing receiver to assure adequate sensitivity to low-level signals.

In one embodiment, low power zero-crossing receiver **200** can be integrated with other circuitry of the propagation tuned oscillator to further improve performance at low signal levels. The zero-crossing receiver **200** comprises a preamplifier **206**, a filter **208**, an offset adjustment circuitry **210**, a comparator **212**, and a digital pulse circuit **214**. The filter **208** and offset adjustment circuitry **210** constitute a noise reduction section **218** as will be explained ahead. The zero-crossing receiver **200** can be implemented in discrete analog components, digital components or combination thereof. The integrated zero-crossing receiver **200** practices measurement methods that detect the midpoint of energy waves at specified locations, and under specified conditions, to enable capturing parameters including, but not limited to, transit time, phase, or frequency of energy waves. A brief description of the method of operation is as follows.

An incoming energy wave **202** is coupled from an electrical connection, antenna, or transducer to an input **204** of zero-crossing receiver **200**. Input **204** of zero-crossing receiver **200** is coupled to pre-amplifier **206** to amplify the incoming energy wave **202**. The amplified signal is filtered by filter **208**. Filter **208** is coupled to an output of pre-amplifier **206** and an input of offset adjustment circuitry **210**. In one configuration, filter **208** is a low-pass filter to remove high frequency components above the incoming energy wave **202** bandwidth. In another arrangement, the filter is a band-pass filter with a pass-band corresponding to the bandwidth of the incoming energy wave **202**. It is not however limited to either arrangement. The offset of the filtered amplified wave is adjusted by offset adjustment circuitry **210**. An input of comparator **212** is coupled to an output of offset adjustment circuitry **210**. Comparator **212** monitors the amplified waveforms and triggers digital pulse circuitry **214** whenever the preset trigger level is detected. Digital pulse circuit **214** has an input coupled to the output of comparator **212** and an output for providing digital pulse **216**. The digital pulse **216** can be further coupled to signal processing circuitry, as will be explained ahead.

In a preferred embodiment, the electronic components are operatively coupled together as blocks of integrated circuits. As will be shown ahead, this integrated arrangement performs its specific functions efficiently with a minimum number of components. This is because the circuit components are partitioned between structures within an integrated circuit and discrete components, as well as innovative partitioning of analog and digital functions, to achieve the required performance with a minimum number of components and minimum power consumption.

FIG. **3** illustrates a block diagram of the integrated zero-crossing receiver **200** coupled to a sensing assembly **300** in accordance with an exemplary embodiment. The pre-amplifier **206** and the digital pulse circuit **214** are shown for reference and discussion. In one embodiment, sensing assembly **300** comprises a transmitter transducer **302**, an energy propagating structure (or medium) **304**, and a receiver transducer **306**. As will be explained further hereinbelow, the sensing assembly **300** in one embodiment is part of a sensory device that measures a parameter such as force, pressure, or load. In a non-limiting example, an external parameter such as an applied force **308** affects the sensing assembly **200**. As shown, applied force **308** modifies propagating structure **304** dimensionally. In general, the sensing assembly **300** conveys one or more parameters of interest such as distance, force, weight, strain, pressure, wear, vibration, viscosity, density, direction, and displacement related to a change in energy propagating structure **304**. An example is measuring loading applied by a joint of the muscular-skeletal system as disclosed above using sensing assembly **300** between the bones of the joint.

A transducer driver circuit (not shown) drives the transmitter transducer **302** of the sensing assembly **300** to produce energy waves **310** that are directed into the energy propagating structure **304**. Changes in the energy propagating medium **304** due to an applied parameter such as applied forces **308** change the frequency, phase, and transit time of energy waves **310** (or pulses). In one embodiment, applied forces **308** affect the length of propagating structure **304** in a direction of a path of propagation of energy waves **310**. The zero-crossing receiver **200** is coupled to the receiver transducer **306** to detect zero-crossings of the reproduced energy wave **202**.

Upon detecting a zero-crossing digital pulse circuit **214** is triggered to output a pulse **216**. The timing of the digital pulse **216** conveys the parameters of interest (e.g., distance, force weight, strain, pressure, wear, vibration, viscosity, density, direction, displacement, etc.).

Measurement methods that rely on such propagation of energy waves **310** or pulses of energy waves are required to achieve highly accurate and controlled detection of energy waves or pulses. Moreover, pulses of energy waves may contain multiple energy waves with complex waveforms therein leading to potential ambiguity of detection. In particular, directing energy waves **310** into the energy propagating structure **304** can generate interference patterns caused by nulls and resonances of the waveguide, as well as characteristics of the generated energy waves **310**. These interference patterns can multiply excited waveforms that result in distortion of the edges of the original energy wave.

Briefly referring back to FIG. **2**, to reliably detect the arrival of a pulse of energy waves, the zero-crossing receiver **200** leverages noise reduction section **218** that incorporates two forms of noise reduction. Frequencies above the operating frequencies for physical measurements of the parameters of interest are attenuated with the filter **208**. In addition, the offset level of the incoming waveform is adjusted by the offset adjustment **210** to optimize the voltage level at which the comparator **212** triggers an output pulse. This is more reliable than amplifying the incoming waveform because it does not add additional amplification of noise present on the input. The combination of rapid response to the arrival of incoming symmetrical, cyclical, or sine waves with adjustable levels of noise reduction achieves reliable zero-crossing detection by way of the ultra low power zero-crossing receiver **200** with superior performance for very low level signals.

There are a wide range of applications for compact measurement modules or devices having ultra low power circuitry that enables the design and construction of highly performing measurement modules or devices that can be tailored to fit a wide range of nonmedical and medical applications. Applications for highly compact measurement modules or devices may include, but are not limited to, disposable modules or devices as well as reusable modules or devices and modules or devices for long term use. In addition to nonmedical applications, examples of a wide range of potential medical applications may include, but are not limited to, implantable devices, modules within implantable devices, intra-operative implants or modules within intra-operative implants or trial inserts, modules within inserted or ingested devices, modules within wearable devices, modules within handheld devices, modules within instruments, appliances, equipment, or accessories of all of these, or disposables within implants, trial inserts, inserted or ingested devices, wearable devices, handheld devices, instruments, appliances, equipment, or accessories to these devices, instruments, appliances, or equipment.

FIG. **4** is an exemplary block diagram **400** of a propagation tuned oscillator (PTO) **404** to maintain positive closed-loop feedback in accordance with an exemplary embodiment. The measurement system includes a sensing assemblage **401** and propagation tuned oscillator (PTO) **404** that detects energy waves **402** in one or more waveguides **403** of the sensing assemblage **401**. In one embodiment, energy waves **402** are ultrasound waves. A pulse **411** is generated in response to the detection of energy waves **402** to initiate a propagation of a new energy wave in waveguide **403**. It should be noted that ultrasound energy pulses or waves, the emission of ultrasound pulses or waves by ultrasound resonators or transducers, transmitted through ultrasound waveguides, and detected by ultrasound resonators or transducers are used merely as examples of energy pulses, waves, and propagation structures and media. Other embodiments herein contemplated can utilize other wave forms, such as, light.

The sensing assemblage **401** comprises transducer **405**, transducer **406**, and a waveguide **403** (or energy propagating structure). In a non-limiting example, sensing assemblage **401** is affixed to load bearing or contacting surfaces **408**. External forces applied to the contacting surfaces **408** compress the waveguide **403** and change the length of the waveguide **403**. Under compression, transducers **405** and **406** will also be move closer together. The change in distance affects the transit time **407** of energy waves **402** transmitted and received between transducers **405** and **406**. The propagation tuned oscillator **404** in response to these physical changes will detect each energy wave sooner (e.g. shorter transit time) and initiate the propagation of new energy waves associated with the shorter transit time. As will be explained below, this is accomplished by way of PTO **404** in conjunction with the pulse generator **410**, the mode control **412**, and the phase detector **414**.

Notably, changes in the waveguide **403** (energy propagating structure or structures) alter the propagation properties of the medium of propagation (e.g. transit time **407**). The energy wave can be a continuous wave or a pulsed energy wave. A pulsed energy wave approach reduces power dissipation allowing for a temporary power source such as a battery or capacitor to power the system during the course of operation. In at least one exemplary embodiment, a continuous wave energy wave or a pulsed energy wave is provided by transducer **405** to a first surface of waveguide **403**. Transducer **405** generates energy waves **402** that are coupled into waveguide **403**. In a non-limiting example, transducer **405** is a piezoelectric device capable of transmitting and receiving acoustic signals in the ultrasonic frequency range.

Transducer **406** is coupled to a second surface of waveguide **403** to receive the propagated pulsed signal and generates a corresponding electrical signal. The electrical signal output by transducer **406** is coupled to phase detector **414**. In general, phase detector **414** is a detection circuit that compares the timing of a selected point on the waveform of the detected energy wave with respect to the timing of the same point on the waveform of other propagated energy waves. In a first embodiment, phase detector **414** can be a zero-crossing receiver. In a second embodiment, phase detector **414** can be an edge-detect receiver. In a third embodiment, phase detector **414** can be a phase locked loop. In the example where sensing assemblage **401** is compressed, the detection of the propagated energy waves **402** occurs earlier (due to the length/distance reduction of waveguide **403**) than a signal prior to external forces being applied to contacting surfaces. Pulse generator **410** generates a new pulse in response to detection of the propagated energy waves **402** by phase detector **414**. The new pulse is provided to transducer **405** to initiate a new energy wave sequence. Thus, each energy wave sequence is an individual event of energy wave propagation, energy wave detection, and energy wave emission that maintains energy waves **402** propagating in waveguide **403**.

The transit time **407** of a propagated energy wave is the time it takes an energy wave to propagate from the first surface of waveguide **403** to the second surface. There is delay associated with each circuit described above. Typically, the total delay of the circuitry is significantly less than the propagation time of an energy wave through waveguide **403**. In addition, under equilibrium conditions variations in circuit delay are minimal. Multiple pulse to pulse timings can be used to generate an average time period when change in

external forces occur relatively slowly in relation to the pulsed signal propagation time such as in a physiologic or mechanical system. The digital counter **420** in conjunction with electronic components counts the number of propagated energy waves to determine a corresponding change in the length of the waveguide **403**. These changes in length change in direct proportion to the external force thus enabling the conversion of changes in parameter or parameters of interest into electrical signals.

The block diagram **400** further includes counting and timing circuitry. More specifically, the timing, counting, and clock circuitry comprises a digital timer **420**, a digital timer **422**, a digital clock **426**, and a data register **424**. The digital clock **426** provides a clock signal to digital counter **420** and digital timer **422** during a measurement sequence. The digital counter **420** is coupled to the propagation tuned oscillator **404**. Digital timer **422** is coupled to data register **424**. Digital timer **420**, digital timer, **422**, digital clock **426** and data register **424** capture transit time **407** of energy waves **402** emitted by ultrasound resonator or transducer **405**, propagated through waveguide **403**, and detected by or ultrasound resonator or transducer **405** or **406** depending on the mode of the measurement of the physical parameters of interest applied to surfaces **408**. The operation of the timing and counting circuitry is disclosed in more detail hereinbelow.

The measurement data can be analyzed to achieve accurate, repeatable, high precision and high resolution measurements. This method enables the setting of the level of precision or resolution of captured data to optimize trade-offs between measurement resolution versus frequency, including the bandwidth of the sensing and data processing operations, thus enabling a sensing module or device to operate at its optimal operating point without compromising resolution of the measurements. This is achieved by the accumulation of multiple cycles of excitation and transit time instead of averaging transit time of multiple individual excitation and transit cycles. The result is accurate, repeatable, high precision and high resolution measurements of parameters of interest in physical systems.

In at least one exemplary embodiment, propagation tuned oscillator **404** in conjunction with one or more sensing assemblages **401** are used to take measurements on a muscular-skeletal system. In a non-limiting example, sensing assemblage **401** is placed between a femoral prosthetic component and tibial prosthetic component to provide measured load information that aids in the installation of an artificial knee joint. Sensing assemblage **401** can also be a permanent component or a muscular-skeletal joint or artificial muscular-skeletal joint to monitor joint function. The measurements can be made in extension and in flexion. In the example, assemblage **401** is used to measure the condyle loading to determine if it falls within a predetermined range and location. Based on the measurement, the surgeon can select the thickness of the insert such that the measured loading and incidence with the final insert in place will fall within the predetermined range. Soft tissue tensioning can be used by a surgeon to further optimize the force or pressure. Similarly, two assemblages **401** can be used to measure both condyles simultaneously or multiplexed. The difference in loading (e.g. balance) between condyles can be measured. Soft tissue tensioning can be used to reduce the force on the condyle having the higher measured loading to reduce the measured pressure difference between condyles.

One method of operation holds the number of energy waves propagating through waveguide **403** as a constant integer number. A time period of an energy wave corresponds to energy wave periodicity. A stable time period is one in which the time period changes very little over a number of energy waves. This occurs when conditions that affect sensing assemblage **401** stay consistent or constant. Holding the number of energy waves propagating through waveguide **403** to an integer number is a constraint that forces a change in the time between pulses when the length of waveguide **403** changes. The resulting change in time period of each energy wave corresponds to a change in aggregate energy wave time period that is captured using digital counter **420** as a measurement of changes in external forces or conditions applied to contacting surfaces **408**.

A further method of operation according to one embodiment is described hereinbelow for energy waves **402** propagating from transducer **405** and received by transducer **406**. In at least one exemplary embodiment, energy waves **402** are an ultrasonic energy wave. Transducers **405** and **406** are piezoelectric resonator transducers. Although not described, wave propagation can occur in the opposite direction being initiated by transducer **406** and received by transducer **405**. Furthermore, detecting ultrasound resonator transducer **406** can be a separate ultrasound resonator as shown or transducer **405** can be used solely depending on the selected mode of propagation (e.g. reflective sensing). Changes in external forces or conditions applied to contacting surfaces **408** affect the propagation characteristics of waveguide **403** and alter transit time **407**. As mentioned previously, propagation tuned oscillator **404** holds constant an integer number of energy waves **402** propagating through waveguide **403** (e.g. an integer number of pulsed energy wave time periods) thereby controlling the repetition rate. As noted above, once PTO **404** stabilizes, the digital counter **420** digitizes the repetition rate of pulsed energy waves, for example, by way of edge-detection, as will be explained hereinbelow in more detail.

In an alternate embodiment, the repetition rate of pulsed energy waves **402** emitted by transducer **405** can be controlled by pulse generator **410**. The operation remains similar where the parameter to be measured corresponds to the measurement of the transit time **407** of pulsed energy waves **402** within waveguide **403**. It should be noted that an individual ultrasonic pulse can comprise one or more energy waves with a damping wave shape. The energy wave shape is determined by the electrical and mechanical parameters of pulse generator **410**, interface material or materials, where required, and ultrasound resonator or transducer **405**. The frequency of the energy waves within individual pulses is determined by the response of the emitting ultrasound resonator **404** to excitation by an electrical pulse **411**. The mode of the propagation of the pulsed energy waves **402** through waveguide **403** is controlled by mode control circuitry **412** (e.g., reflectance or uni-directional). The detecting ultrasound resonator or transducer may either be a separate ultrasound resonator or transducer **406** or the emitting resonator or transducer **405** depending on the selected mode of propagation (reflectance or unidirectional).

In general, accurate measurement of physical parameters is achieved at an equilibrium point having the property that an integer number of pulses are propagating through the energy propagating structure at any point in time. Measurement of changes in the "time-of-flight" or transit time of ultrasound energy waves within a waveguide of known length can be achieved by modulating the repetition rate of the ultrasound energy waves as a function of changes in distance or velocity through the medium of propagation, or a combination of changes in distance and velocity, caused by changes in the parameter or parameters of interest.

Measurement methods that rely on the propagation of energy waves, or energy waves within energy pulses, may

require the detection of a specific point of energy waves at specified locations, or under specified conditions, to enable capturing parameters including, but not limited to, transit time, phase, or frequency of the energy waves. Measurement of the changes in the physical length of individual ultrasound waveguides may be made in several modes. Each assemblage of one or two ultrasound resonators or transducers combined with an ultrasound waveguide may be controlled to operate in six different modes. This includes two wave shape modes: continuous wave or pulsed waves, and three propagation modes: reflectance, unidirectional, and bi-directional propagation of the ultrasound wave. The resolution of these measurements can be further enhanced by advanced processing of the measurement data to enable optimization of the trade-offs between measurement resolution versus length of the waveguide, frequency of the ultrasound waves, and the bandwidth of the sensing and data capture operations, thus achieving an optimal operating point for a sensing module or device.

Measurement by propagation tuned oscillator **404** and sensing assemblage **401** enables high sensitivity and high signal-to-noise ratio. The time-based measurements are largely insensitive to most sources of error that may influence voltage or current driven sensing methods and devices. The resulting changes in the transit time of operation correspond to frequency, which can be measured rapidly, and with high resolution. This achieves the required measurement accuracy and precision thus capturing changes in the physical parameters of interest and enabling analysis of their dynamic and static behavior.

These measurements may be implemented with an integrated wireless sensing module or device having an encapsulating structure that supports sensors and load bearing or contacting surfaces and an electronic assemblage that integrates a power supply, sensing elements, energy transducer or transducers and elastic energy propagating structure or structures, biasing spring or springs or other form of elastic members, an accelerometer, antennas and electronic circuitry that processes measurement data as well as controls all operations of ultrasound generation, propagation, and detection and wireless communications. The electronics assemblage also supports testability and calibration features that assure the quality, accuracy, and reliability of the completed wireless sensing module or device.

The level of accuracy and resolution achieved by the integration of energy transducers and an energy propagating structure or structures coupled with the electronic components of the propagation tuned oscillator enables the construction of, but is not limited to, compact ultra low power modules or devices for monitoring or measuring the parameters of interest. The flexibility to construct sensing modules or devices over a wide range of sizes enables sensing modules to be tailored to fit a wide range of applications such that the sensing module or device may be engaged with, or placed, attached, or affixed to, on, or within a body, instrument, appliance, vehicle, equipment, or other physical system and monitor or collect data on physical parameters of interest without disturbing the operation of the body, instrument, appliance, vehicle, equipment, or physical system.

Referring to FIG. **17**, a simplified flow chart **1700** of method steps for high precision processing and measurement data is shown in accordance with an exemplary embodiment. The method **1700** can be practiced with more or less than the steps shown, and is not limited to the order of steps shown. The method steps correspond to FIG. **4** to be practiced with the aforementioned components or any other components suitable for such processing, for example, electrical circuitry to control the emission of energy pulses or waves and to capture the repetition rate of the energy pulses or frequency of the energy waves propagating through the elastic energy propagating structure or medium.

In a step **1702**, the process initiates a measurement operation. In a step **1704**, a known state is established by resetting digital timer **422** and data register **424**. In a step **1706**, digital counter **420** is preset to the number of measurement cycles over which measurements will be taken and collected. In a step **1708**, the measurement cycle is initiated and a clock output of digital clock **426** is enabled. A clock signal from digital clock **426** is provided to both digital counter **420** and digital timer **422**. An elapsed time is counted by digital timer **420** based on the frequency of the clock signal output by digital clock **426**. In a step **1710**, digital timer **422** begins tracking the elapsed time. Simultaneously, digital counter **420** starts decrementing a count after each measurement sequence. In one embodiment, digital counter **420** is decremented as each energy wave propagates through waveguide **403** and is detected by transducer **406**. Digital counter **420** counts down until the preset number of measurement cycles has been completed. In a step **1712**, energy wave propagation is sustained by propagation tuned oscillator **404**, as digital counter **420** is decremented by the detection of a propagated energy wave. In a step **1714**, energy wave detection, emission, and propagation continue while the count in digital counter **420** is greater than zero. In a step **1716**, the clock input of digital timer **422** is disabled upon reaching a zero count on digital counter **420** thus preventing digital counter **420** and digital timer **422** from being clocked. In one embodiment, the preset number of measurement cycles provided to digital counter **420** is divided by the elapsed time measured by digital timer **422** to calculate a frequency of propagated energy waves. Conversely, the number can be calculated as a transit time by dividing the elapsed time from digital timer **422** by the preset number of measurement cycles. Finally, in a step **1718**, the resulting value is transferred to register **424**. The number in data register **424** can be wirelessly transmitted to a display and database. The data from data register **424** can be correlated to a parameter being measured. The parameter such as a force or load is applied to the propagation medium (e.g. waveguide **403**) such that parameter changes also change the frequency or transit time calculation of the measurement. A relationship between the material characteristics of the propagation medium and the parameter is used with the measurement value (e.g. frequency, transit time, phase) to calculate a parameter value.

The method **1700** practiced by the example assemblage of FIG. **4**, and by way of the digital counter **420**, digital timer **422**, digital clock **426** and associated electronic circuitry analyzes the digitized measurement data according to operating point conditions. In particular, these components accumulate multiple digitized data values to improve the level of resolution of measurement of changes in length or other aspect of an elastic energy propagating structure or medium that can alter the transit time of energy pulses or waves propagating within the elastic energy propagating structure or medium. The digitized data is summed by controlling the digital counter **420** to run through multiple measurement cycles, each cycle having excitation and transit phases such that there is not lag between successive measurement cycles, and capturing the total elapsed time. The counter is sized to count the total elapsed time of as many measurement cycles as required to achieve the required resolution without overflowing its accumulation capacity and without compromising the resolution of the least significant bit of the counter. The digitized measurement of the total elapsed transit time is subsequently divided by the number of measurement cycles to estimate the time of the

individual measurement cycles and thus the transit time of individual cycles of excitation, propagation through the elastic energy propagating structure or medium, and detection of energy pulses or waves. Accurate estimates of changes in the transit time of the energy pulses or waves through the elastic energy propagating structure or medium are captured as elapsed times for excitation and detection of the energy pulses or waves are fixed.

Summing individual measurements before dividing to estimate the average measurement value data values produces superior results to averaging the same number of samples. The resolution of count data collected from a digital counter is limited by the resolution of the least-significant-bit in the counter. Capturing a series of counts and averaging them does not produce greater precision than this least-significant-bit, that is the precision of a single count. Averaging does reduce the randomness of the final estimate if there is random variation between individual measurements. Summing the counts of a large number of measurement cycles to obtain a cumulative count then calculating the average over the entire measurement period improves the precision of the measurement by interpolating the component of the measurement that is less than the least significant bit of the counter. The precision gained by this procedure is on the order of the resolution of the least-significant-bit of the counter divided by the number of measurement cycles summed.

The size of the digital counter and the number of measurement cycles accumulated may be greater than the required level of resolution. This not only assures performance that achieves the level of resolution required, but also averages random component within individual counts producing highly repeatable measurements that reliably meet the required level of resolution.

The number of measurement cycles is greater than the required level of resolution. This not only assures performance that achieves the level of resolution required, but also averages any random component within individual counts producing highly repeatable measurements that reliably meet the required level of resolution.

FIG. **5** is a sensor interface diagram incorporating the zero-crossing receiver **200** in a continuous wave multiplexing arrangement for maintaining positive closed-loop feedback in accordance with one embodiment. The positive closed-loop feedback is illustrated by the bold line path. Initially, multiplexer (mux) **502** receives as input a clock signal **504**, which is passed to the transducer driver **506** to produce the drive line signal **508**. Analog multiplexer (mux) **510** receives drive line signal **508**, which is passed to the transmitter transducer **512** to generate energy waves **514**. Transducer **512** is located at a first location of an energy propagating medium. The emitted energy waves **514** propagate through the energy propagating medium. Receiver transducer **516** is located at a second location of the energy propagating medium. Receiver transducer **516** captures the energy waves **514**, which are fed to analog mux **520** and passed to the zero-crossing receiver **200**. The captured energy waves by transducer **516** are indicated by electrical waves **518** provided to mux **520**. Zero-crossing receiver **200** outputs a pulse corresponding to each zero crossing detected from captured electrical waves **518**. The zero crossings are counted and used to determine changes in the phase and frequency of the energy waves propagating through the energy propagating medium. In a non-limiting example, a parameter such as applied force is measured by relating the measured phase and frequency to a known relationship between the parameter (e.g. force) and the material properties of the energy propagating medium. In general, pulse sequence **522** corresponds to the detected signal frequency. The zero-crossing receiver **200** is in a feedback path of the propagation tuned oscillator. The pulse sequence **522** is coupled through mux **502** in a positive closed-loop feedback path. The pulse sequence **522** disables the clock signal **504** such that the path providing pulse sequence **522** is coupled to driver **506** to continue emission of energy waves into the energy propagating medium and the path of clock signal **504** to driver **506** is disabled.

FIG. **6** is an exemplary block diagram of a propagation tuned oscillator (PTO) incorporating the zero-crossing receiver **640** for operation in continuous wave mode. In particular, with respect to FIG. **4**, it illustrates closed loop measurement of the transit time **412** of ultrasound waves **414** within the waveguide **408** by the operation of the propagation tuned oscillator **416**. This example is for operation in continuous wave mode. The system can also be operated in pulse mode and a pulse-echo mode. Pulse mode and pulsed echo-mode use a pulsed energy wave. Pulse-echo mode uses reflection to direct an energy wave within the energy propagation medium. Briefly, the digital logic circuit **646** digitizes the frequency of operation of the propagation tuned oscillator.

In continuous wave mode of operation a sensor comprising transducer **604**, propagating structure **602**, and transducer **606** is used to measure the parameter. In general, the parameter to be measured affects the properties of the propagating medium. For example, an external force or condition **612** is applied to propagating structure **602** that changes the length of the waveguide in a path of a propagating energy wave. A change in length corresponds to a change in transit time **608** of the propagating wave. Similarly, the length of propagating structure **602** corresponds to the applied force **612**. A length reduction corresponds to a higher force being applied to the propagating structure **602**. Conversely, a length increase corresponds to a lowering of the applied force **612** to the propagating structure **602**. The length of propagating structure **602** is measured and is converted to force by way of a known length to force relationship.

Transducer **604** is an emitting device in continuous wave mode. The sensor for measuring a parameter comprises transducer **604** coupled to propagating structure **602** at a first location. A transducer **606** is coupled to propagating structure **602** at a second location. Transducer **606** is a receiving transducer for capturing propagating energy waves. In one embodiment, the captured propagated energy waves are electrical sine waves **634** that are output by transducer **606**.

A measurement sequence is initiated when control circuitry **618** closes switch **620** coupling oscillator output **624** of oscillator **622** to the input of amplifier **626**. One or more pulses provided to amplifier **626** initiates an action to propagate energy waves **610** having simple or complex waveforms through energy propagating structure or medium **602**. Amplifier **626** comprises a digital driver **628** and matching network **630**. In one embodiment, amplifier **626** transforms the oscillator output of oscillator **622** into sine waves of electrical waves **632** having the same repetition rate as oscillator output **624** and sufficient amplitude to excite transducer **604**.

Emitting transducer **604** converts the sine waves **632** into energy waves **610** of the same frequency and emits them at the first location into energy propagating structure or medium **602**. The energy waves **610** propagate through energy propagating structure or medium **602**. Upon reaching transducer **606** at the second location, energy waves **610** are captured, sensed, or detected. The captured energy waves are converted by transducer **606** into sine waves **634** that are electrical waves having the same frequency.

Amplifier **636** comprises a pre-amplifier **634** and zero-cross receiver **640**. Amplifier **636** converts the sine waves **634**

into digital pulses **642** of sufficient duration to sustain the behavior of the closed loop circuit. Control circuitry **618** responds to digital pulses **642** from amplifier **636** by opening switch **620** and closing switch **644**. Opening switch **620** decouples oscillator output **624** from the input of amplifier **626**. Closing switch **644** creates a closed loop circuit coupling the output of amplifier **636** to the input of amplifier **626** and sustaining the emission, propagation, and detection of energy waves through energy propagating structure or medium **602**.

An equilibrium state is attained by maintaining unity gain around this closed loop circuit wherein sine waves **632** input into transducer **604** and sine waves **634** output by transducer **606** are in phase with a small but constant offset. Transducer **606** as disclosed above, outputs the sine waves **634** upon detecting energy waves propagating to the second location. In the equilibrium state, an integer number of energy waves **610** propagate through energy propagating structure or medium **602**.

Movement or changes in the physical properties of energy propagating structure or medium **602** change a transit time **608** of energy waves **610**. The transit time **608** comprises the time for an energy wave to propagate from the first location to the second location of propagating structure **602**. Thus, the change in the physical property of propagating structure **602** results in a corresponding time period change of the energy waves **610** within energy propagating structure or medium **602**. These changes in the time period of the energy waves **610** alter the equilibrium point of the closed loop circuit and frequency of operation of the closed loop circuit. The closed loop circuit adjusts such that sine waves **632** and **634** correspond to the new equilibrium point. The frequency of energy waves **610** and changes to the frequency correlate to changes in the physical attributes of energy propagating structure or medium **602**.

The physical changes may be imposed on energy propagating structure **602** by external forces or conditions **612** thus translating the levels and changes of the parameter or parameters of interest into signals that may be digitized for subsequent processing, storage, and display. Translation of the operating frequency into digital binary numbers facilitates communication, additional processing, storage, and display of information about the level and changes in physical parameters of interest. Similarly, the frequency of energy waves **610** during the operation of the closed loop circuit, and changes in this frequency, may be used to measure movement or changes in physical attributes of energy propagating structure or medium **602**.

Prior to measurement of the frequency or operation of the propagation tuned oscillator, control logic **618** loads the loop count into digital counter **650** that is stored in count register **648**. The first digital pulses **642** initiates closed loop operation within the propagation tuned oscillator and signals control circuit **618** to start measurement operations. At the start of closed loop operation, control logic **618** enables digital counter **650** and digital timer **652**. In one embodiment, digital counter **650** decrements its value on the rising edge of each digital pulse output by zero-crossing receiver **640**. Digital timer **652** increments its value on each rising edge of clock pulses **656**. When the number of digital pulses **642** has decremented, the value within digital counter **650** to zero a stop signal is output from digital counter **650**. The stop signal disables digital timer **652** and triggers control circuit **618** to output a load command to data register **654**. Data register **654** loads a binary number from digital timer **652** that is equal to the period of the energy waves or pulses times the value in counter **648** divided by clock period **656**. With a constant clock period **656**, the value in data register **654** is directly proportional to the aggregate period of the energy waves or pulses accumulated during the measurement operation. Duration of the measurement operation and the resolution of measurements may be adjusted by increasing or decreasing the value preset in the count register **648**.

FIG. **7** is a sensor interface diagram incorporating the integrated zero-crossing receiver **200** in a pulse multiplexing arrangement for maintaining positive closed-loop feedback in accordance with one embodiment. In one embodiment, the circuitry other than the sensor is integrated on an application specific integrated circuit (ASIC). The positive closed-loop feedback is illustrated by the bold line path. Initially, mux **702** is enabled to couple one or more digital pulses **704** to the transducer driver **706**. Transducer driver **706** generates a pulse sequence **708** corresponding to digital pulses **704**. Analog mux **710** is enabled to couple pulse sequence **708** to the transmitter transducer **712**. Transducer **712** is coupled to a medium at a first location. Transducer **712** responds to pulse sequence **708** and generates corresponding energy pulses **714** that are emitted into the medium at the first location. The energy pulses **714** propagate through the medium. A receiver transducer **716** is located at a second location on the medium. Receiver transducer **716** captures the energy pulses **714** and generates a corresponding signal of electrical pulses **718**. Transducer **716** is coupled to a mux **720**. Mux **720** is enabled to couple to zero-cross receiver **200**. Electrical pulses **718** from transducer **716** are coupled to zero-cross receiver **200**. Zero-cross receiver **200** counts zero crossings of electrical pulses **718** to determine changes in phase and frequency of the energy pulses responsive to an applied force, as previously explained. Zero-cross receiver **200** outputs a pulse sequence **722** corresponding to the detected signal frequency. Pulse sequence **722** is coupled to mux **702**. Mux **702** is decoupled from coupling digital pulses **704** to driver **706** upon detection of pulses **722**. Conversely, mux **702** is enabled to couple pulses **722** to driver **706** upon detection of pulses **722** thereby creating a positive closed-loop feedback path. Thus, in pulse mode, zero-cross receiver **200** is part of the closed-loop feedback path that continues emission of energy pulses into the medium at the first location and detection at the second location to measure a transit time and changes in transit time of pulses through the medium.

FIG. **8** is an exemplary block diagram of a propagation tuned oscillator (PTO) incorporating the zero-crossing receiver **640** for operation in pulse mode. In particular, with respect to FIG. **4**, it illustrates closed loop measurement of the transit time **412** of ultrasound waves **414** within the waveguide **408** by the operation of the propagation tuned oscillator **416**. This example is for operation in pulse mode. The system can also be operated in continuous wave mode and a pulse-echo mode. Continuous wave mode uses a continuous wave signal. Pulse-echo mode uses reflection to direct an energy wave within the energy propagation medium. Briefly, the digital logic circuit **646** digitizes the frequency of operation of the propagation tuned oscillator.

In pulse mode of operation, a sensor comprising transducer **604**, propagating structure **602**, and transducer **606** is used to measure the parameter. In general, the parameter to be measured affects the properties of the propagating medium. For example, an external force or condition **612** is applied to propagating structure **602** that changes the length of the waveguide in a path of a propagating energy wave. A change in length corresponds to a change in transit time **608** of the propagating wave. The length of propagating structure **602** is measured and is converted to force by way of a known length to force relationship. One benefit of pulse mode operation is the use of a high magnitude pulsed energy wave. In one

embodiment, the magnitude of the energy wave decays as it propagates through the medium. The use of a high magnitude pulse is a power efficient method to produce a detectable signal if the energy wave has to traverse a substantial distance or is subject to a reduction in magnitude as it propagated due to the medium.

A measurement sequence is initiated when control circuitry **618** closes switch **620** coupling oscillator output **624** of oscillator **622** to the input of amplifier **626**. One or more pulses provided to amplifier **626** initiates an action to propagate energy waves **610** having simple or complex waveforms through energy propagating structure or medium **602**. Amplifier **626** comprises a digital driver **628** and matching network **630**. In one embodiment, amplifier **626** transforms the oscillator output of oscillator **622** into analog pulses of electrical waves **832** having the same repetition rate as oscillator output **624** and sufficient amplitude to excite transducer **604**.

Emitting transducer **604** converts the analog pulses **832** into energy waves **610** of the same frequency and emits them at a first location into energy propagating structure or medium **602**. The energy waves **610** propagate through energy propagating structure or medium **602**. Upon reaching transducer **606** at the second location, energy waves **610** are captured, sensed, or detected. The captured energy waves are converted by transducer **606** into analog pulses **834** that are electrical waves having the same frequency.

Amplifier **636** comprises a pre-amplifier **638** and zero-cross receiver **640**. Amplifier **636** converts the analog pulses **834** into digital pulses **642** of sufficient duration to sustain the behavior of the closed loop circuit. Control circuitry **618** responds to digital pulses **642** from amplifier **636** by opening switch **620** and closing switch **644**. Opening switch **620** decouples oscillator output **624** from the input of amplifier **626**. Closing switch **644** creates a closed loop circuit coupling the output of amplifier **636** to the input of amplifier **626** and sustaining the emission, propagation, and detection of energy waves through energy propagating structure or medium **602**.

An equilibrium state is attained by maintaining unity gain around this closed loop circuit wherein pulses **832** input into transducer **604** and pulses **834** output by transducer **606** are in phase with a small but constant offset. Transducer **606** as disclosed above, outputs the pulses **834** upon detecting energy waves propagating to the second location. In the equilibrium state, an integer number of energy waves **610** propagate through energy propagating structure or medium **602**.

Movement or changes in the physical properties of energy propagating structure or medium **602** change a transit time **608** of energy waves **610**. The transit time **608** comprises the time for an energy wave to propagate from the first location to the second location of propagating structure **602**. Thus, the change in the physical property of propagating structure **602** results in a corresponding time period change of the energy waves **610** within energy propagating structure or medium **602**. These changes in the time period of the energy waves **610** alter the equilibrium point of the closed loop circuit and frequency of operation of the closed loop circuit. The closed loop circuit adjusts such that pulses **832** and **834** correspond to the new equilibrium point. The frequency of energy waves **610** and changes to the frequency correlate to changes in the physical attributes of energy propagating structure or medium **602**.

The physical changes may be imposed on energy propagating structure **602** by external forces or conditions **612** thus translating the levels and changes of the parameter or parameters of interest into signals that may be digitized for subsequent processing, storage, and display. Translation of the operating frequency into digital binary numbers facilitates communication, additional processing, storage, and display of information about the level and changes in physical parameters of interest as disclosed in more detail hereinabove. Similarly, the frequency of energy waves **610** during the operation of the closed loop circuit, and changes in this frequency, may be used to measure movement or changes in physical attributes of energy propagating structure or medium **602**.

FIG. **9** illustrates a block diagram of an edge-detect receiver circuit **900** in accordance with an exemplary embodiment. In a first embodiment, edge-detect receiver **900** is provided to detect wave fronts of pulses of energy waves. This enables capturing of parameters including, but not limited to, transit time, phase, or frequency of the energy waves. Circuitry of the integrated edge-detect receiver **900** provides rapid on-set detection and quickly responds to the arrival of an energy pulse. It reliably triggers thereafter a digital output pulse at a same point on the initial wave front of each captured energy pulse or pulsed energy wave. The digital pulse can be optimally configured to output with minimal and constant delay. The edge-detect receiver **900** can isolate and precisely detect the specified point on the initial energy wave or the wave front in the presence of interference and distortion signals thereby overcoming problems commonly associated with detecting one of multiple generated complex signals in energy propagating mediums. The edge-detect receiver **900** performs these functions accurately over a wide range of amplitudes including very low-level energy pulses.

In a second embodiment, the edge-detect receiver **900** is incorporated within a propagation tuned oscillator (PTO) to maintain positive closed-loop feedback when operating in a pulse or pulse-echo mode. The edge-detect receiver **900** can be integrated with other circuitry of the PTO by multiplexing input and output circuitry to achieve ultra low-power and small compact size. Integration of the circuitry of the PTO with the edge-detect receiver provides the benefit of increasing sensitivity to low-level signals.

The block diagram illustrates one embodiment of a low power edge-detect receiver circuit **900** with superior performance at low signal levels. The edge-detect receiver **900** comprises a preamplifier **912**, a differentiator **914**, a digital pulse circuit **916** and a deblank circuit **918**. The edge-detect receiver circuit **900** can be implemented in discrete analog components, digital components or combination thereof. In one embodiment, edge-detect receiver **900** is integrated into an ASIC as part of a sensor system described hereinbelow. The edge-detect receiver circuit **900** practices measurement methods that detect energy pulses or pulsed energy waves at specified locations and under specified conditions to enable capturing parameters including, but not limited to, transit time, phase, frequency, or amplitude of energy pulses. A brief description of the method of operation is as follows. In a non-limiting example, a pre-amplifier triggers a comparator circuit responsive to small changes in the slope of an input signal. The comparator and other edge-detect circuitry responds rapidly with minimum delay. Detection of small changes in the input signal assures rapid detection of the arrival of a pulse of energy waves. The minimum phase design reduces extraneous delay thereby introducing less variation into the measurement of the transit time, phase, frequency, or amplitude of the incoming energy pulses.

An input **920** of edge-detect receiver **900** is coupled to pre-amplifier **912**. As an example, the incoming wave **910** to the edge-detect receiver circuit **900** can be received from an electrical connection, antenna, or transducer. The incoming wave **910** is amplified by pre-amplifier **912**, which assures adequate sensitivity to small signals. Differentiator circuitry **914** monitors the output of pre-amplifier **912** and triggers

digital pulse circuitry **916** whenever a signal change corresponding to a pulsed energy wave is detected. For example, a signal change that identifies the pulsed energy wave is the initial wave front or the leading edge of the pulsed energy wave. In one arrangement, differentiator **914** detects current flow, and more specifically changes in the slope of the energy wave **910** by detecting small changes in current flow instead of measuring changes in voltage level to achieve rapid detection of slope. Alternatively, differentiator **914** can be implemented to trigger on changes in voltage. Together, preamplifier **912** and differentiator **916** monitor the quiescent input currents for the arrival of wave front of energy wave(s) **910**. Preamplifier **912** and differentiator **916** detect the arrival of low level pulses of energy waves as well as larger pulses of energy waves. This detection methodology achieves superior performance for very low level signals. Differentiator circuitry **912** triggers digital pulse circuitry **916** whenever current flow driven by the initial signal ramp of the incoming wave **910** is detected. The digital pulse is coupled to deblank circuit **918** that desensitizes pre-amplifier **912**. For example, the desensitization of pre-amplifier **912** can comprise a reduction in gain, decoupling of input **920** from energy wave **910**, or changing the frequency response. The deblank circuit **918** also disregards voltage or current levels for a specified or predetermined duration of time to effectively skip over the interference sections or distorted portions of the energy wave **910**. In general, energy wave **910** can comprise more than one change in slope and is typically a damped wave form. Additional signals or waves of the pulsed energy wave on the input **920** of pre-amplifier **912** are not processed during the preset blanking period. In this example, the digital output pulse **928** can then be coupled to signal processing circuitry as explained hereinbelow. In one embodiment, the electronic components are operatively coupled as blocks within an integrated circuit. As will be shown ahead, this integration arrangement performs its specific functions efficiently with a minimum number of components. This is because the circuit components are partitioned between structures within an integrated circuit and discrete components, as well as innovative partitioning of analog and digital functions, to achieve the required performance with a minimum number of components and minimum power consumption.

FIG. **10** illustrates a block diagram of the edge-detect receiver circuit **900** coupled to a sensing assembly **1000**. The pre-amplifier **912** and the digital pulse circuit **916** are shown for reference and discussion. The sensing assembly **1000** comprises a transmitter transducer **1002**, an energy propagating medium **1004**, and a receiver transducer **1006**. The transmitter transducer **1002** is coupled to propagating medium **1004** at a first location. The receiver transducer **1006** is coupled to energy propagating medium **1004** at a second location. Alternatively, a reflecting surface can replace receiver transducer **1006**. The reflecting surface reflects an energy wave back towards the first location. Transducer **1006** can be enabled to be a transmitting transducer and a receiving transducer thereby saving the cost of a transducer. As will be explained ahead in further detail, the sensing assembly **1000** in one embodiment is part of a sensory device that assess loading, in particular, the externally applied forces **1008** on the sensing assembly **1000**. A transducer driver circuit (not shown) drives the transmitter transducer **1002** of the sensing assembly **1000** to produce energy waves **1010** that are directed into the energy propagating medium **1004**. In the non-limiting example, changes in the energy propagating medium **1004** due to the externally applied forces **1008** change the frequency, phase, and transit time **1012** of energy waves **1010** propagating from the first location to the second location of energy propagating medium **1004**. The integrated edge-detect receiver circuit **900** is coupled to the receiver transducer **1006** to detect edges of the reproduced energy wave **910** and trigger the digital pulse **928**. In general, the timing of the digital pulse **928** conveys the parameters of interest (e.g., distance, force weight, strain, pressure, wear, vibration, viscosity, density, direction, displacement, etc.) related to the change in energy propagating structure **1004** due to an external parameter. For example, sensing assembly **1000** placed in a knee joint as described hereinabove.

Measurement methods that rely on the propagation of energy pulses require the detection of energy pulses at specified locations or under specified conditions to enable capturing parameters including, but not limited to, transit time, phase, frequency, or amplitude of the energy pulses. Measurement methods that rely on such propagation of energy waves **1010** or pulses of energy waves are required to achieve highly accurate and controlled detection of energy waves or pulses. Moreover, pulses of energy waves may contain multiple energy waves with complex waveforms therein leading to potential ambiguity of detection. In particular, directing energy waves **1010** into the energy propagating structure **1004** can generate interference patterns caused by nulls and resonances of the waveguide, as well as characteristics of the generated energy wave **1010**. These interference patterns can generate multiply excited waveforms that result in distortion of the edges of the original energy wave. To reliably detect the arrival of a pulse of energy waves, the edge-detect receiver **900** only responds to the leading edge of the first energy wave within each pulse. This is achieved in part by blanking the edge-detect circuitry **900** for the duration of each energy pulse. As an example, the deblank circuit **918** disregards voltage or current levels for a specified duration of time to effectively skip over the interference sections or distorted portions of the waveform.

FIG. **11** is a sensor interface diagram incorporating the edge-detect receiver circuit **900** in a pulse-echo multiplexing arrangement for maintaining positive closed-loop feedback in accordance with one embodiment. The positive closed-loop feedback is illustrated by the bold line path. Initially, multiplexer (mux) **1102** receives as input a digital pulse **1104**, which is passed to the transducer driver **1106** to produce the pulse sequence **1108**. Analog multiplexer (mux) **1110** receives pulse sequence **1108**, which is passed to the transducer **1112** to generate energy pulses **1114**. Energy pulses **1114** are emitted into a first location of a medium and propagate through the medium. In the pulse-echo example, energy pulses **1114** are reflected off a surface **1116** at a second location of the medium, for example, the end of a waveguide or reflector, and echoed back to the transducer **1112**. The transducer **1112** proceeds to then capture the reflected pulse echo. In pulsed echo mode, the transducer **1112** performs as both a transmitter and a receiver. As disclosed above, transducer **1112** toggles back and forth between emitting and receiving energy waves. Transducer **1112** captures the reflected echo pulses, which are coupled to analog mux **1110** and directed to the edge-detect receiver **900**. The captured reflected echo pulses is indicated by electrical waves **1120**. Edge-detect receiver **900** locks on pulse edges corresponding to the wave front of a propagated energy wave to determine changes in phase and frequency of the energy pulses **1114** responsive to an applied force, as previously explained. Among other parameters, it generates a pulse sequence **1118** corresponding to the detected signal frequency. The pulse sequence **1118** is coupled to mux **1102** and directed to driver **1106** to initiate one or more energy waves being emitted into the medium by transducer **1112**. Pulse **1104** is decoupled

from being provided to driver **1106**. Thus, a positive closed loop feedback is formed that repeatably emits energy waves into the medium until mux **1102** prevents a signal from being provided to driver **1106**. The edge-detect receiver **900** is coupled to a second location of the medium and is in the feedback path. The edge-detect receiver **900** initiates a pulsed energy wave being provided at the first location of the medium upon detecting a wave front at the second location when the feedback path is closed.

FIG. **12** is an exemplary block diagram of a propagation tuned oscillator (PTO) incorporating the edge-detect receiver circuit **900** for operation in pulse echo mode. In particular, with respect to FIG. **4**, it illustrates closed loop measurement of the transit time **412** of ultrasound waves **414** within the waveguide **408** by the operation of the propagation tuned oscillator **416**. This example is for operation in a pulse echo mode. The system can also be operated in pulse mode and a continuous wave mode. Pulse mode does not use a reflected signal. Continuous wave mode uses a continuous signal. Briefly, the digital logic circuit **1246** digitizes the frequency of operation of the propagation tuned oscillator.

In pulse-echo mode of operation a sensor comprising transducer **1204**, propagating structure **1202**, and reflecting surface **1206** is used to measure the parameter. In general, the parameter to be measured affects the properties of the propagating medium. For example, an external force or condition **1212** is applied to propagating structure **1202** that changes the length of the waveguide in a path of a propagating energy wave. A change in length corresponds to a change in transit time of the propagating wave. Similarly, the length of propagating structure **1202** corresponds to the applied force **1212**. A length reduction corresponds to a higher force being applied to the propagating structure **1202**. Conversely, a length increase corresponds to a lowering of the applied force **1212** to the propagating structure **1202**. The length of propagating structure **1202** is measured and is converted to force by way of a known length to force relationship.

Transducer **1204** is both an emitting device and a receiving device in pulse-echo mode. The sensor for measuring a parameter comprises transducer **1204** coupled to propagating structure **1202** at a first location. A reflecting surface is coupled to propagating structure **1202** at a second location. Transducer **1204** has two modes of operation comprising an emitting mode and receiving mode. Transducer **1204** emits an energy wave into the propagating structure **1202** at the first location in the emitting mode. The energy wave propagates to a second location and is reflected by reflecting surface **1206**. The reflected energy wave is reflected towards the first location and transducer **1204** subsequently generates a signal in the receiving mode corresponding to the reflected energy wave.

A measurement sequence in pulse echo mode is initiated when control circuitry **1218** closes switch **1220** coupling digital output **1224** of oscillator **1222** to the input of amplifier **1226**. One or more pulses provided to amplifier **1226** starts a process to emit one or more energy waves **1210** having simple or complex waveforms into energy propagating structure or medium **1202**. Amplifier **1226** comprises a digital driver **1228** and matching network **1230**. In one embodiment, amplifier **1226** transforms the digital output of oscillator **1222** into pulses of electrical waves **1232** having the same repetition rate as digital output **1224** and sufficient amplitude to excite transducer **1204**.

Transducer **1204** converts the pulses of electrical waves **1232** into pulses of energy waves **1210** of the same repetition rate and emits them into energy propagating structure or medium **1202**. The pulses of energy waves **1210** propagate through energy propagating structure or medium **1202** as shown by arrow **1214** towards reflecting surface **1206**. Upon reaching reflecting surface **1206**, energy waves **1210** are reflected by reflecting surface **1206**. Reflected energy waves propagate towards transducer **1204** as shown by arrow **1216**. The reflected energy waves are detected by transducer **1204** and converted into pulses of electrical waves **1234** having the same repetition rate.

Amplifier **1236** comprises a pre-amplifier **1234** and edge-detect receiver **1240**. Amplifier **1236** converts the pulses of electrical waves **1234** into digital pulses **1242** of sufficient duration to sustain the pulse behavior of the closed loop circuit. Control circuitry **1218** responds to digital output pulses **1242** from amplifier **1236** by opening switch **1220** and closing switch **1244**. Opening switch **1220** decouples oscillator output **1224** from the input of amplifier **1226**. Closing switch **1244** creates a closed loop circuit coupling the output of amplifier **1236** to the input of amplifier **1226** and sustaining the emission, propagation, and detection of energy pulses through energy propagating structure or medium **1202**.

An equilibrium state is attained by maintaining unity gain around this closed loop circuit wherein electrical waves **1232** input into transducer **1204** and electrical waves **1234** output by transducer **1204** are in phase with a small but constant offset. Transducer **1204** as disclosed above, outputs the electrical waves **1234** upon detecting reflected energy waves reflected from reflecting surface **1206**. In the equilibrium state, an integer number of pulses of energy waves **1210** propagate through energy propagating structure or medium **1202**.

Movement or changes in the physical properties of energy propagating structure or medium **1202** change a transit time **1208** of energy waves **1210**. The transit time **1208** comprises the time for an energy wave to propagate from the first location to the second location of propagating structure **1202** and the time for the reflected energy wave to propagate from the second location to the first location of propagating structure **1202**. Thus, the change in the physical property of propagating structure **1202** results in a corresponding time period change of the energy waves **1210** within energy propagating structure or medium **1202**. These changes in the time period of the repetition rate of the energy pulses **1210** alter the equilibrium point of the closed loop circuit and repetition rate of operation of the closed loop circuit. The closed loop circuit adjusts such that electrical waves **1232** and **1234** correspond to the new equilibrium point. The repetition rate of energy waves **1210** and changes to the repetition rate correlate to changes in the physical attributes of energy propagating structure or medium **1202**.

The physical changes may be imposed on energy propagating structure **1202** by external forces or conditions **1212** thus translating the levels and changes of the parameter or parameters of interest into signals that may be digitized for subsequent processing, storage, and display. Translation of the operating frequency into digital binary numbers facilitates communication, additional processing, storage, and display of information about the level and changes in physical parameters of interest. Similarly, the frequency of energy waves **1210** during the operation of the closed loop circuit, and changes in this frequency, may be used to measure movement or changes in physical attributes of energy propagating structure or medium **1202**.

Prior to measurement of the frequency or operation of the propagation tuned oscillator, control logic **1218** loads the loop count into digital counter **1250** that is stored in count register **1248**. The first digital pulses **1242** initiates closed loop operation within the propagation tuned oscillator and

signals control circuit **1218** to start measurement operations. At the start of closed loop operation, control logic **1218** enables digital counter **1250** and digital timer **1252**. In one embodiment, digital counter **1250** decrements its value on the rising edge of each digital pulse output by edge-detect receiver **1240**. Digital timer **1252** increments its value on each rising edge of clock pulses **1256**. When the number of digital pulses **1242** has decremented, the value within digital counter **1250** to zero a stop signal is output from digital counter **1250**. The stop signal disables digital timer **1252** and triggers control circuit **1218** to output a load command to data register **1254**. Data register **1254** loads a binary number from digital timer **1252** that is equal to the period of the energy waves or pulses times the value in counter **1248** divided by clock period **1256**. With a constant clock period **1256**, the value in data register **1254** is directly proportional to the aggregate period of the energy waves or pulses accumulated during the measurement operation. Duration of the measurement operation and the resolution of measurements may be adjusted by increasing or decreasing the value preset in the count register **1248**.

FIG. **13** is a simplified cross-sectional view of a sensing module **1301** in accordance with an exemplary embodiment. The sensing module (or assemblage) is an electro-mechanical assembly comprising electrical components and mechanical components that when configured and operated in accordance with a sensing mode performs as a positive feedback closed-loop measurement system. The measurement system can precisely measure applied forces, such as loading, on the electro-mechanical assembly. The sensing mode can be a continuous mode, a pulse mode, or a pulse echo-mode.

In one embodiment, the electrical components can include ultrasound resonators or transducers **405** and **406**, ultrasound waveguides **403**, and signal processing electronics **1310**, but are not limited to these. The mechanical components can include biasing springs **1332**, spring retainers and posts, and load platforms **1306**, but are not limited to these. The electrical components and mechanical components can be inter-assembled (or integrated) onto a printed circuit board **1336** to operate as a coherent ultrasonic measurement system within sensing module **1301** and according to the sensing mode. As will be explained ahead in more detail, the signal processing electronics incorporate a propagation tuned oscillator (PTO) or a phase locked loop (PLL) to control the operating frequency of the ultrasound resonators or transducers for providing high precision sensing. Furthermore, the signal processing electronics incorporate detect circuitry that consistently detects an energy wave after it has propagated through a medium. The detection initiates the generation of a new energy wave by an ultrasound resonator or transducer that is coupled to the medium for propagation therethrough. A change in transit time of an energy wave through the medium is measured and correlates to a change in material property of the medium due to one or more parameters applied thereto.

Sensing module **1301** comprises one or more assemblages **401** each comprised one or more ultrasound resonators **405** and **406**. As illustrated, waveguide **403** is coupled between transducers (**405**, **406**) and affixed to load bearing or contacting surfaces **408**. In one exemplary embodiment, an ultrasound signal is coupled for propagation through waveguide **403**. The sensing module **1301** is placed, attached to, or affixed to, or within a body, instrument, or other physical system **1318** having a member or members **1316** in contact with the load bearing or contacting surfaces **408** of the sensing module **401**. This arrangement facilitates translating the parameters of interest into changes in the length or compression or extension of the waveguide or waveguides **403** within the sensing module **1301** and converting these changes in length into electrical signals. This facilitates capturing data, measuring parameters of interest and digitizing that data, and then subsequently communicating that data through antenna **1334** to external equipment with minimal disturbance to the operation of the body, instrument, appliance, vehicle, equipment, or physical system **1318** for a wide range of applications.

The sensing module **401** supports three modes of operation of energy wave propagation and measurement: reflectance, unidirectional, and bi-directional. These modes can be used as appropriate for each individual application. In unidirectional and bi-directional modes, a chosen ultrasound resonator or transducer is controlled to emit pulses of ultrasound waves into the ultrasound waveguide and one or more other ultrasound resonators or transducers are controlled to detect the propagation of the pulses of ultrasound waves at a specified location or locations within the ultrasound waveguide. In reflectance or pulse-echo mode, a single ultrasound or transducer emits pulses of ultrasound waves into waveguide **403** and subsequently detects pulses of echo waves after reflection from a selected feature or termination of the waveguide. In pulse-echo mode, echoes of the pulses can be detected by controlling the actions of the emitting ultrasound resonator or transducer to alternate between emitting and detecting modes of operation. Pulse and pulse-echo modes of operation may require operation with more than one pulsed energy wave propagating within the waveguide at equilibrium.

Many parameters of interest within physical systems or bodies can be measured by evaluating changes in the transit time of energy pulses. The frequency, as defined by the reciprocal of the average period of a continuous or discontinuous signal, and type of the energy pulse is determined by factors such as distance of measurement, medium in which the signal travels, accuracy required by the measurement, precision required by the measurement, form factor of that will function with the system, power constraints, and cost. The physical parameter or parameters of interest can include, but are not limited to, measurement of load, force, pressure, displacement, density, viscosity, localized temperature. These parameters can be evaluated by measuring changes in the propagation time of energy pulses or waves relative to orientation, alignment, direction, or position as well as movement, rotation, or acceleration along an axis or combination of axes by wireless sensing modules or devices positioned on or within a body, instrument, appliance, vehicle, equipment, or other physical system.

In the non-limiting example, pulses of ultrasound energy provide accurate markers for measuring transit time of the pulses within waveguide **403**. In general, an ultrasonic signal is an acoustic signal having a frequency above the human hearing range (e.g. >20 KHz) including frequencies well into the megahertz range. In one embodiment, a change in transit time of an ultrasonic energy pulse corresponds to a difference in the physical dimension of the waveguide from a previous state. For example, a force or pressure applied across the knee joint compresses waveguide **403** to a new length and changes the transit time of the energy pulse When integrated as a sensing module and inserted or coupled to a physical system or body, these changes are directly correlated to the physical changes on the system or body and can be readily measured as a pressure or a force.

FIG. **14** is an exemplary assemblage **1400** for illustrating reflectance and unidirectional modes of operation in accordance with an exemplary embodiment. It comprises one or more transducers **1402**, **1404**, and **1406**, one or more waveguides **1414**, and one or more optional reflecting sur-

faces **1416**. The assemblage **1400** illustrates propagation of ultrasound waves **1418** within the waveguide **1414** in the reflectance and unidirectional modes of operation. Either ultrasound resonator or transducer **1402** and **1404** in combination with interfacing material or materials **1408** and **1410**, if required, can be selected to emit ultrasound waves **1418** into the waveguide **1414**.

In unidirectional mode, either of the ultrasound resonators or transducers for example **1402** can be enabled to emit ultrasound waves **1418** into the waveguide **1414**. The non-emitting ultrasound resonator or transducer **1404** is enabled to detect the ultrasound waves **1418** emitted by the ultrasound resonator or transducer **1402**.

In reflectance mode, the ultrasound waves **1418** are detected by the emitting ultrasound resonator or transducer **1402** after reflecting from a surface, interface, or body at the opposite end of the waveguide **1414**. In this mode, either of the ultrasound resonators or transducers **1402** or **1404** can be selected to emit and detect ultrasound waves. Additional reflection features **1416** can be added within the waveguide structure to reflect ultrasound waves. This can support operation in a combination of unidirectional and reflectance modes. In this mode of operation, one of the ultrasound resonators, for example resonator **1402** is controlled to emit ultrasound waves **1418** into the waveguide **1414**. Another ultrasound resonator or transducer **1406** is controlled to detect the ultrasound waves **1418** emitted by the emitting ultrasound resonator **1402** (or transducer) subsequent to their reflection by reflecting feature **1416**.

FIG. **15** is an exemplary assemblage **1500** that illustrates propagation of ultrasound waves **1510** within the waveguide **1506** in the bi-directional mode of operation of this assemblage. In this mode, the selection of the roles of the two individual ultrasound resonators (**1502**, **1504**) or transducers affixed to interfacing material **1520** and **1522**, if required, are periodically reversed. In the bi-directional mode the transit time of ultrasound waves propagating in either direction within the waveguide **1506** can be measured. This can enable adjustment for Doppler effects in applications where the sensing module **1508** is operating while in motion **1516**. Furthermore, this mode of operation helps assure accurate measurement of the applied load, force, pressure, or displacement by capturing data for computing adjustments to offset this external motion **1516**. An advantage is provided in situations wherein the body, instrument, appliance, vehicle, equipment, or other physical system **1514**, is itself operating or moving during sensing of load, pressure, or displacement. Similarly, the capability can also correct in situation where the body, instrument, appliance, vehicle, equipment, or other physical system, is causing the portion **1512** of the body, instrument, appliance, vehicle, equipment, or other physical system being measured to be in motion **1516** during sensing of load, force, pressure, or displacement. Other adjustments to the measurement for physical changes to system **1514** are contemplated and can be compensated for in a similar fashion. For example, temperature of system **1514** can be measured and a lookup table or equation having a relationship of temperature versus transit time can be used to normalize measurements. Differential measurement techniques can also be used to cancel many types of common factors as is known in the art.

The use of waveguide **1506** enables the construction of low cost sensing modules and devices over a wide range of sizes, including highly compact sensing modules, disposable modules for bio-medical applications, and devices, using standard components and manufacturing processes. The flexibility to construct sensing modules and devices with very high levels of measurement accuracy, repeatability, and resolution that can scale over a wide range of sizes enables sensing modules and devices to the tailored to fit and collect data on the physical parameter or parameters of interest for a wide range of medical and non-medical applications.

For example, sensing modules or devices may be placed on or within, or attached or affixed to or within, a wide range of physical systems including, but not limited to instruments, appliances, vehicles, equipments, or other physical systems as well as animal and human bodies, for sensing the parameter or parameters of interest in real time without disturbing the operation of the body, instrument, appliance, vehicle, equipment, or physical system.

In addition to non-medical applications, examples of a wide range of potential medical applications may include, but are not limited to, implantable devices, modules within implantable devices, modules or devices within intra-operative implants or trial inserts, modules within inserted or ingested devices, modules within wearable devices, modules within handheld devices, modules within instruments, appliances, equipment, or accessories of all of these, or disposables within implants, trial inserts, inserted or ingested devices, wearable devices, handheld devices, instruments, appliances, equipment, or accessories to these devices, instruments, appliances, or equipment. Many physiological parameters within animal or human bodies may be measured including, but not limited to, loading within individual joints, bone density, movement, various parameters of interstitial fluids including, but not limited to, viscosity, pressure, and localized temperature with applications throughout the vascular, lymph, respiratory, and digestive systems, as well as within or affecting muscles, bones, joints, and soft tissue areas. For example, orthopedic applications may include, but are not limited to, load bearing prosthetic components, or provisional or trial prosthetic components for, but not limited to, surgical procedures for knees, hips, shoulders, elbows, wrists, ankles, and spines; any other orthopedic or musculoskeletal implant, or any combination of these.

FIG. **16** is an exemplary cross-sectional view of a sensor element **1600** to illustrate changes in the propagation of ultrasound waves **1614** with changes in the length of a waveguide **1606**. In general, the measurement of a parameter is achieved by relating displacement to the parameter. In one embodiment, the displacement required over the entire measurement range is measured in microns. For example, an external force **1608** compresses waveguide **1606** thereby changing the length of waveguide **1606**. Sensing circuitry (not shown) measures propagation characteristics of ultrasonic signals in the waveguide **1606** to determine the change in the length of the waveguide **1606**. These changes in length change in direct proportion to the parameters of interest thus enabling the conversion of changes in the parameter or parameters of interest into electrical signals.

As illustrated, external force **1608** compresses waveguide **1606** and moves the transducers **1602** and **1604** closer to one another by a distance **1610**. This changes the length of waveguide **1606** by distance **1612** of the waveguide propagation path between transducers **1602** and **1604**. Depending on the operating mode, the sensing circuitry measures the change in length of the waveguide **1606** by analyzing characteristics of the propagation of ultrasound waves within the waveguide.

One interpretation of FIG. **16** illustrates waves emitting from transducer **1602** at one end of waveguide **1606** and propagating to transducer **1604** at the other end of the waveguide **1606**. The interpretation includes the effect of movement of waveguide **1606** and thus the velocity of waves propagating within waveguide **1606** (without changing shape

or width of individual waves) and therefore the transit time between transducers **1602** and **1604** at each end of the waveguide. The interpretation further includes the opposite effect on waves propagating in the opposite direction and is evaluated to estimate the velocity of the waveguide and remove it by averaging the transit time of waves propagating in both directions.

Changes in the parameter or parameters of interest are measured by measuring changes in the transit time of energy pulses or waves within the propagating medium. Closed loop measurement of changes in the parameter or parameters of interest is achieved by modulating the repetition rate of energy pulses or the frequency of energy waves as a function of the propagation characteristics of the elastic energy propagating structure.

In a continuous wave mode of operation, a phase detector (not shown) evaluates the frequency and changes in the frequency of resonant ultrasonic waves in the waveguide **1606**. As will be described below, positive feedback closed-loop circuit operation in continuous wave (CW) mode adjusts the frequency of ultrasonic waves **1614** in the waveguide **1606** to maintain a same number or integer number of periods of ultrasonic waves in the waveguide **1606**. The CW operation persists as long as the rate of change of the length of the waveguide is not so rapid that changes of more than a quarter wavelength occur before the frequency of the Propagation Tuned Oscillator (PTO) can respond. This restriction exemplifies one advantageous difference between the performance of a PTO and a Phase Locked Loop (PLL). Assuming the transducers are producing ultrasonic waves, for example, at 2.4 MHz, the wavelength in air, assuming a velocity of 343 microns per microsecond, is about 143μ, although the wavelength within a waveguide may be longer than in unrestricted air.

In a pulse mode of operation, the phase detector measures a time of flight (TOF) between when an ultrasonic pulse is transmitted by transducer **1602** and received at transducer **1604**. The time of flight determines the length of the waveguide propagating path, and accordingly reveals the change in length of the waveguide **1606**. In another arrangement, differential time of flight measurements (or phase differences) can be used to determine the change in length of the waveguide **1606**. A pulse consists of a pulse of one or more waves. The waves may have equal amplitude and frequency (square wave pulse) or they may have different amplitudes, for example, decaying amplitude (trapezoidal pulse) or some other complex waveform. The PTO is holding the phase of the leading edge of the pulses propagating through the waveguide constant. In pulse mode operation the PTO detects the leading edge of the first wave of each pulse with an edge-detect receiver rather than a zero-crossing receiver circuitry as used in CW mode.

FIG. **18** illustrates a block diagram of a medical sensing system **1800** in accordance with an example embodiment. The medical sensing system operates similar to the systems described in FIG. **4**, FIG. **6**, FIG. **8**, and FIG. **12** to measure a medical parameter. The sensor of system **1800** is capacitor **1802**. Capacitor **1802** is a variable capacitor that varies with the medical parameter being measured. A capacitance value of capacitor **1802** correlates to a value of the parameter. In a first example, the parameter being measured is temperature. The capacitance of capacitor **1802** is coupled to the temperature to be measured. The capacitance of capacitor **1802** at "temperature" can be accurately measured by system **1800** and correlated back to a temperature value. Another example of a parameter is a force, pressure, or load. In one embodiment, the force, pressure, or load can be applied to capacitor **1802**. The capacitance of capacitor **1802** at the "force, pressure, or load" is measured by system **1800** and correlated back to a force, pressure, or load value. In either example, the capacitance will change by a known manner over the parameter measurement range. In general, the change in capacitance over the parameter measurement range occurs in a regular manner. Irregularities in capacitance change within the parameter System **1800** can be calibrated over the parameter measurement range to account for any irregularities in capacitance change or to further refine measurement accuracy.

System **1800** comprises a capacitor **1802**, a signal generator **1804**, a digital clock **1806**, a digital counter **1808**, a digital timer **1810**, a counter register **1812**, and a data register **1814**. Signal generator **1804** is coupled to capacitor **1802** and has an output for providing a signal. Signal generator **1804** generates a signal **1816** or waveform that corresponds to the capacitance of capacitor **1802**. The signal **1816** changes as the capacitance of capacitor **1802** changes. For example, a time period of a measurement cycle of signal **1816** can relate to the capacitance of capacitor **1802**.

In one embodiment, signal generator **1804** is an oscillator. A digital clock **1806** is coupled to digital counter **1808** and digital timer **1810**. Digital clock **1806** provides a clock signal to digital counter **1808** and digital timer **1810** during a measurement sequence. Digital counter **1808** couples to counter register **1812** and couples to the output of signal generator **1804**. Counter register **1812** provides a predetermined count corresponding to the measurement sequence. In general, measurement accuracy can be increased by raising the predetermined count. Digital counter **1808** receives the predetermined count from counter register **1812**. After initiating the measurement sequence the digital counter compares the number of measurement cycles at the output of signal generator **1804** to the predetermined count. The measurement sequence ends when the count of measurement cycles equals the predetermined count. In one embodiment, each measurement cycle output by signal generator **1804** decrements digital counter **1808** until a zero count is reached which signifies an end of the measurement sequence. Digital timer **1810** measures a time period of the measurement sequence. In other words, digital timer **1810** measures an elapsed time required for signal generator **1804** to output the predetermined count of measurement cycles. Data register **1814** couples to digital timer **1810** and stores a value corresponding to the time period or elapsed time of the measurement sequence. The elapsed time of the measurement sequence corresponds to a statistically large number of measurements of capacitor **1802**. The elapsed time corresponds to an aggregate of the predetermined count of measurement cycles or capacitance measurements. The value stored in data register **1814** can be a translation of the elapsed time to a force, pressure, or load value. The parameter being measured should produce a stable capacitance value during the time period of the measurement sequence.

FIG. **19** illustrates an oscillator **1900** generating a signal corresponding to a capacitor **1802** in accordance with an example embodiment. Oscillator **1900** corresponds to signal generator **1804** of FIG. **18**. Oscillator **1900** is an example of a circuit used to generate signal **1816** of FIG. **18**. Oscillator **1900** comprises a current source **1902**, a current source **1904**, a comparator **1906**, a switch **1908**, a switch **1910**, and a switch control **1912**. Capacitor **1802** is coupled to current sources **1902** and **1904**. Current sources **1902** and **1904** respectively source and sink current from capacitor **1802**. Current source **1902** sources a current I. Current source **1904** sinks a current 2I or twice the current provided by current

source **1902**. Switch **1910** enables current source **1904** to sink current when coupled to ground. Comparator **1906** includes a positive input coupled to capacitor **1802**, a negative input coupled to switch **1908**, and an output. The output of comparator **1906** couples to switch control **1912**. Switch control **1912** couples to switches **1908** and **1910** to control switch position. The output of comparator **1906** is a control signal to switch control **1912**.

In general, current sources **1902** and **1904** respectively charge and discharge capacitor **1802**. Capacitor **1802** is charged by current source **1902** when the output of comparator **1906** is in a low state. Switch control **1912** opens switch **1910** and a reference voltage Vref is coupled to the negative input of comparator **1906** by switch **1908** when the output of comparator **1906** transitions to the low state. The voltage on capacitor **1802** rises as the current I from current source **1902** charges the capacitance. The slew rate of the change in voltage on the capacitor is related to the capacitance of capacitor **1802** and the current I. The output of comparator **1906** transitions from a low state to a high state when the voltage on capacitor **1802** is greater than or equal to the reference voltage Vref. Switch control **1912** closes switch **1910** and a reference voltage Vref/2 is coupled to the negative input of comparator **1906** by switch **1908** when the output of comparator **1906** transitions to the high state. The sink current of current source **1904** is 2I or twice as large as the current sourced by current source **1902**. Current source **1904** sinks a current I from capacitor **1802** and an equal current from current source **1902**. The voltage on capacitor **1802** falls as charge is removed. The output of comparator changes from the high state to a low state when the voltage on the capacitor is less than or equal to the reference voltage Vref/2. In the example, voltage on capacitor **1802** will transition between the reference voltages Vref and Vref/2. The slew rate of the rising edge and falling edge of the capacitor voltage is symmetrical. A repeating saw tooth pattern is generated by oscillator **1900** until the sequence is stopped. A measurement cycle corresponds to the time to generate a single triangle shaped waveform. The triangle shaped waveform constitutes the time to transition the voltage on capacitor **1802** from Vref/2 to Vref and from Vref to Vref/2. It should be noted that the measurement cycle relates to the capacitance of capacitor **1802**. Increasing the capacitance of capacitor **1802** correspondingly increases the measurement cycle. Conversely, decreasing the capacitance of capacitor **1802** correspondingly decreases the measurement cycle. The signal at the output of the comparator **1906** also corresponds to signal **1816**. Thus, a relation is established by the signal output by oscillator **1900** to the capacitance of capacitor **1802**.

Referring briefly to FIG. **1**, a sensor **100** is coupled to the muscular-skeletal system. In the example, a prosthetic knee joint is illustrated and the sensor **100** is coupled to the knee region. Sensor **100** can be capacitor **1802** coupled to the muscular-skeletal system. Capacitor **1802** can be coupled to an articular surface of the prosthetic knee joint to measure a force, pressure, or load. In one embodiment, the force, pressure, or load applied to the articular surface is coupled to capacitor **1802** whereby the capacitance varies with the force, pressure, or load applied thereto. Although a knee joint is shown, capacitor **1802** and system **1800** of FIG. **18** can be used in medical devices, tools, equipment, and prosthetic components to measure parameters that affect capacitance of capacitor **1802**. Similarly, although a knee joint is described as an example, capacitor **1802** can be integrated into muscular-skeletal medical devices, tools, equipment, and prosthetic components to measure an applied force, pressure, or load. Moreover, capacitor **1802** and system **1800** of FIG. **18** is not limited to the knee but can be integrated into prosthetic components for parameter measurement such as bone, tissue, shoulder, ankle, hip, knee, spine, elbow, hand, and foot.

Referring back to FIGS. **18** and **19**, signal generator **1804** outputs a repeating waveform that corresponds to the capacitance of capacitor **1802**. Oscillator **1900** is an implementation of signal generator **1804** that oscillates or generates a repeating waveform. In the example, oscillator **1900** outputs a repeating sawtooth waveform that has symmetrical rising and falling edges. The measurement cycle of the waveform is the time required to transition from Vref/2 to Vref and transition back to Vref/2. The time of the measurement cycle corresponds to the capacitance of the capacitor. The time of each measurement cycle will be substantially equal if the capacitance of capacitor **1802** remains constant during the measurement sequence. In one embodiment, counter register **1812** is loaded with a predetermined count. The measurement sequence can be initiated at a predetermined point of the waveform. For example, a voltage Vref/2 can be detected to start on the waveform to start the measurement sequence. Each subsequent time the voltage Vref/2 is detected the digital counter **1808** is decremented. The measurement sequence ends when digital counter decrements to zero. Digital timer **1810** measures the elapsed time of the measurement sequence corresponding to the predetermined count of measurement cycles of the sawtooth waveform. Alternatively, the output of comparator **1906** can be used as the oscillating or repeating waveform. A rising or falling edge of the output of comparator **1906** can be used to initiate and decrement digital counter **1808**. The measurement sequence is configured to be initiated during a period when the parameter to be measured and by relation the capacitance of capacitor **1802** is substantially constant. The process measures the capacitance **1802** a number of times equal to the predetermined count. Variations in the measurement can be averaged out by having a large predetermined count. The process also allows for very small changes in capacitance to be measured very accurately. The accuracy of the measurement can be increased by raising the predetermined count of the measurement cycles. In one embodiment, the measured capacitance is an average determined by the measured elapsed time and the predetermined count of measurement cycles. The measured capacitance can be translated to the parameter being measured such as a force, pressure, or load. Data register **1814** can be configured to store the parameter measurement or a number corresponding to the parameter measurement.

FIG. **20** discloses a method **2000** for measuring a force, pressure, or load. The method description relates to and can reference FIGS. **1**, **4**, **6**, **8**, **12**, **13**, and **19**. The example disclosed herein uses a prosthetic component implementation but method **2000** can be practiced in any other suitable system or device. The steps of method **2000** are not limited to the order disclosed. Moreover, method **2000** can also have a greater number of steps or a fewer number of steps than shown.

At a step **2002**, a force, pressure, or load is applied to a capacitor. Changes in the force, pressure, or load produce a corresponding change in a capacitance of the capacitor. At a step **2004**, a repeating signal is generated. A time period of a single waveform of the repeating signal is a measurement cycle. The time period of the measurement cycle corresponds to the capacitance of the capacitor. At a step **2006**, the waveform or signal is repeated a predetermined number of times. A measurement sequence comprises the repeated waveform for the predetermined number of times. At a step **2008**, an elapsed time of the measurement sequence is measured. The elapsed time is the time required to generate the predetermined num-

ber of waveforms. At a step **2010**, the force, pressure, or load is maintained during the measurement sequence. In general, the force, pressure, or load coupled to the capacitor should be constant during the measurement sequence. At a step **2012**, the measured elapsed time is correlated to the force, pressure, or load measurement. Typically, a measurement range is known for the force, pressure, or load being applied to the capacitor. The capacitor or capacitor type being used can be characterized using known force, pressure, and loads throughout the measurement range prior to use. Thus, a correlation between capacitance and force, pressure, or load is known. For example, the relationship between capacitance and force, pressure, or load can be stored in a look up table or by a mathematical expression. In one embodiment, the capacitor responds approximately linear throughout the measurement range. The average capacitance of the capacitor can be calculated using the measured elapsed time to generate the predetermined number of waveforms during the measurement sequence. The force, pressure, or load can then be determined from the previous characterization. Further refinement can be achieved by using calibration techniques during final testing of the capacitor. The calibration data on the capacitor can be used in the calculation of the force, pressure, or load to further reduce measurement error. At a step **2014**, the predetermined number of waveforms can be increased to raise measurement accuracy. The measurement resolution can be increased by this technique if the force, pressure, or load is substantially constant over the increased number of predetermined number waveforms. Moreover, the resolution supports measurement where the capacitance changes are relatively small over the force, pressure, or load measurement range.

FIG. **21** illustrates a capacitor **2100** in accordance with an example embodiment. In general, a sensor for use in a medical environment is accurate, reliable, low cost, and have a form factor suitable for the application. Sensors that produce an electrical signal require a wired or wireless interconnect to electronic circuitry to receive, analyze, and provide the measurement data. Capacitor **2100** meets the above listed requirements. Capacitor **2100** can be used in medical devices, tools, and equipment for measurement of different medical parameters. In the example, capacitor **2100** can be integrated into devices, tools, equipment, and prosthetic components for measuring parameters of the muscular-skeletal system. Capacitor **2100** is suitable for intra-operative and implantable prosthetic components that support installation and long-term measurement of the installed structures.

Capacitor **2100** comprises a dielectric layer **2102**, a dielectric layer **2104**, and a dielectric layer **2106**. Capacitor **2100** comprises more than two capacitors in series mechanically. In one embodiment, capacitor **2100** comprises 3 capacitors in mechanical series. Referring briefly to FIG. **22**, capacitor **2100** of FIG. **21** comprises capacitors **2206**, **2204**, and **2208**. Capacitors **2206**, **2204**, and **2208** are coupled mechanically in series. A compressive force, pressure, or load **2202** is applied to the series coupled capacitors **2206**, **2204**, and **2208**. Referring back to FIG. **21**, a first capacitor comprises a conductive region **2108**, dielectric layer **2102**, and conductive region **2110**. The first capacitor corresponds to capacitor **2204** of FIG. **22**. Conductive regions **2108** and **2110** have a predetermined area such that the predetermined area, dielectric constant of dielectric layer **2102**, and the thickness of dielectric layer **2102** determine the capacitance of capacitor **2204**. In one embodiment, conductive layer **2108** overlies, has substantially equal area, and is aligned to conductive layer **2110**.

A second capacitor comprises conductive region **2108**, dielectric layer **2104**, and a conductive region **2112**. The second capacitor corresponds to capacitor **2206** of FIG. **22**. In one embodiment, conductive region **2112** overlies, has approximately equal area, and is aligned to conductive region **2108**. A load pad **2114** is formed overlying conductive region **2112**. Load pad **2114** protects and prevents damage to conductive layer **2112** due to a force, pressure or load applied to capacitor **2100**.

A third capacitor comprises conductive region **2110**, dielectric layer **2106**, and a conductive layer **2116**. The third capacitor corresponds to capacitor **2208** of FIG. **22**. In one embodiment, conductive region **2116** overlies, has approximately equal area, and is aligned to conductive region **2110**. A load pad **2118** is formed overlying conductive region **2116**. Load pad **2118** protects and prevents damage to conductive layer **2116** due to a force, pressure or load applied to capacitor **2100**. In general, load pads **2114** and **2118** comprise a non-compressible material. Load pads **2114** and **2218** can comprise metal, composite material, or a polymer.

Capacitor **2100** couples to electronic circuitry as disclosed in FIG. **18**. Capacitor **2100** can comprise more than one capacitor in parallel. In one embodiment, conductive regions **2108** and **2110** can be coupled in common. In the example, conductive regions **2108** and **2110** are coupled in common by conductive via **2120**. Conductive regions **2112** and **2116** are also coupled in common or to a common voltage potential. In one embodiment, conductive regions **2112** and **2116** are coupled to ground forming a shield. Referring briefly to FIG. **23**, capacitor **2100** comprises capacitors **2206** and **2208**. Capacitors **2206** and **2208** are coupled electrically in parallel having a terminal coupled to ground and a terminal comprising conductive regions **2108** and **2110** coupled in common. Capacitor **2204** is not shown in the electrical equivalent circuit of capacitor **2100** because the conductive regions of capacitor **2204** are shorted together. Referring back to FIG. **21**, capacitor **2206** and capacitor **2208** can be formed having substantially equal capacitance. Thus, capacitor **2100** comprises more than one capacitor that are mechanically in series and comprises more than one capacitor that are coupled electrically in parallel.

In the example, capacitor **2100** can be used as a force, pressure, or load sensor for the muscular-skeletal system. Capacitor **2100** can be integrated into a prosthetic component to measure the force, pressure, or load applied by the muscular-skeletal system. The measurement has supports the installation of prosthetic components and can be used for long-term data collection on the implanted system. The size and shape of capacitor **2100** is beneficial to biological sensing applications. The form factor of capacitor **2100** can be made very small. Moreover, capacitor **2100** can be made very thin which supports integration and placement in regions of the body that could not be achieved with conventional sensors. A thickness of less 2.5 millimeters and typically less than 1 millimeter for capacitor **2100** can be manufactured.

In one embodiment, a multi-layered interconnect can be used to form capacitor **2100**. Multi-layer interconnect comprises alternating conductive layers and dielectric layers. The conductive layers can be patterned to form conductive regions and interconnect. Applying a force, pressure, or load to multi-layer interconnect can deform the dielectric layers. It has been found that for small deformations the dielectric layers of interconnect will rebound elastically when the stimulus is removed. Deformation of the dielectric layer changes the dielectric thickness of capacitor **2100** and the capacitance value thereof. System **1800** of FIG. **18** supports high resolution of small changes in capacitance that makes the use of capacitor **2100** viable.

In general, the dielectric material for the interconnect can comprise a polymer, polyester, an aramid, an adhesive, sili-

con, glass, or composite material. Capacitor **2100** includes at least one dielectric layer comprising polyimide. In one example, dielectric layers **2102**, **2104**, and **2106** comprise polyimide. Alternatively, layer **2102** can be an adhesive layer that couples capacitors **2206** and **2208** together. Under testing, polyimide has been shown to compress elastically under load values typical for prosthetic component load measurement. In general, capacitor **2100** compresses less than 20% of thickness of each capacitor to maintain operation in an elastic region of the dielectric. In one embodiment, the dielectric of capacitor **2100** is compressed less than 10% of the dielectric thickness over the operating range. For example, the polyimide layer can be approximately 0.0254 millimeters thick. Compression of the polyimide can be less than 0.0022 millimeters over the entire load measurement range for a prosthetic knee application. The interconnect can be flexible allowing placement on non-planar regions. Moreover, capacitor **2100** can be conformal to different surface shapes if required. Alternatively, capacitor **2100** can be formed as a compressible structure that does not flex or conform.

As mentioned previously, capacitor **2100** is coupled to electronic circuitry such as that disclosed in FIG. **18**. Using interconnect to form capacitor **2100** provides the further benefit of being able to integrate capacitor **2100** with the interconnect that couples to the electronic circuitry. This eliminates a connection between the sensor and the interconnect as they are formed as a single structure. The integrated capacitor and interconnect also increases sensor reliability, lowers cost, and simplifies assembly.

Referring briefly to FIG. **24**, a top view illustrates conductive region **2112** formed overlying dielectric layer **2104**. In general, the force, pressure, or load is applied uniformly on the conductive regions of the sensor capacitor. The load pad can support the distribution of the force, pressure, or load across the entire conductive region. The area of the conductive region is of sufficient size to maintain elastic compression of the dielectric material over the entire force, pressure, or load range of the application. The area of the conductive regions can be increased to reduce the force, pressure, or load per unit area thereby lowering dielectric compression over the measurement range for improved reliability. In the knee prosthetic component example, conductive region **2112** can have a circular shape. The area of conductive region **2112** is a function of the force, pressure, or load range being measured. The diameter of conductive region **2112** is approximately 2.0 millimeters for a sensor for a knee application. The dashed line indicates a periphery of conductive region **2108** that underlies conductive region **2112**. In the example, conductive region **2108** has a diameter of approximately 2.2 millimeters. More than one of the sensors can fit within a prosthetic component of the knee. An interconnect **2124** is coupled to conductive region **2112**. Interconnect **2124** can be formed on the same layer as conductive region **2112**. Referring back to FIG. **21**, conductive region **2116** can have a similar circular shape as conductive region **2112**. The diameter of conductive region **2116** is approximately 2.0 millimeters for a sensor for a knee application. The conductive region **2110** that overlies conductive region **2112** is approximately 2.2 millimeters in diameter. An interconnect **2126** can be formed overlying the polyimide layer **2106** and couple to conductive region **2116**.

In the example, a force, pressure, or load is applied by the muscular-skeletal system to load pads **2114** and **2118**. The force, pressure, or load compresses capacitors **2206**, **2204**, and **2208**

that are mechanically in series that comprise capacitor **2100**. Dielectric layers **2202**, **2204**, and **2206** compress under the force, pressure, or load. The plates of capacitor **2204** are coupled in common and do not contribute to a capacitance of capacitor **2100**. The structure of capacitor **2100** minimizes the effect of parasitic capacitance. Conductive regions **2112** and **2116** are coupled to ground. Conductive regions **2112** and **2116** respectively overlie and underlie conductive regions **2108** and **2110** thereby acting as a ground shield. The shield minimizes or blocks external capacitive interaction that could occur with conductive regions **2112** and **2116** that can effect measurement accuracy.

Referring briefly to FIG. **25**, a cross-sectional view of interconnect **2122**, **2124**, and **2126** in an example embodiment is provided. As described hereinabove, conductive regions **2108** and **2110** are coupled in common by via **2120**. An interconnect **2122** couples to conductive regions **2108** and **2110**. Interconnect **2122**, **2124**, and **2126** can couple capacitor **2100** to system **1800** of FIG. **18**. Interconnect **2124** and **2126** are coupled to ground. Interconnect **2124** and **2126** overlie and underlie interconnect **2122** thereby acting as a shield. In one embodiment, interconnect **2122** has a width less than interconnects **2124** and **2126**. Interconnects **2124** and **2126** shield and block potential capacitive interaction with interconnect **2122** as it is routed and coupled to system **1800** of FIG. **18**.

Referring back to FIG. **21**, parasitic capacitance related to capacitor **2100** remains substantially constant throughout the parameter measurement range. A first parasitic capacitance comprises interconnect **2124**, dielectric layer **2104**, and interconnect **2122**. A second parasitic capacitance comprises interconnect **2126**, dielectric layer **2106**, and interconnect **2122**. The first and second parasitic capacitances add together to increase the capacitance of capacitor **2100**. The force, pressure, or load is not applied to first and second parasitic capacitances thereby remaining constant during measurement. Thus, the change in capacitance of capacitor **2100** can be measured by system **1800** over the force, pressure, or load range using the method disclosed herein with secondary affects due to changes in parasitic capacitance being minimized.

FIG. **26** discloses a method **2600** for measuring a force, pressure, or load. The method description relates to and can reference FIGS. **1**, **4**, **6**, **8**, **12**, **13**, **19**, and **21-25**. The steps of method **2600** are not limited to the order disclosed. Moreover, method **2600** can also have a greater number of steps or a fewer number of steps than shown. At a step **2602**, more than one capacitor in series is compressed. A sensor capacitor can comprise more than one capacitor coupled in series. The force, pressure, or load is applied across the series coupled capacitors. At a step **2604**, a capacitance of more than one capacitor in parallel is measured. The sensor capacitor can comprise more than one capacitor electrically coupled in parallel.

At a step **2606**, a repeating signal is generated having a measurement cycle corresponding to capacitance of the more than one capacitor in parallel. In one embodiment, the more than one capacitor in parallel is coupled to a signal generator circuit. The signal generator circuit coupled to the more than one capacitor in parallel is configured to oscillate. The repeating signal comprises a repeating measurement cycle. A time period of each measurement cycle generated by the signal generator corresponds to the capacitance of the more than one capacitor in parallel.

At a step **2608**, an elapsed time is measured of the repeating signal. In one embodiment, the repeating signal is repeated a predetermined number of times. In other words, the measurement cycle is repeated the predetermined number of times and the elapsed time of the predetermined number of measurement cycles is measured. At a step **2610**, the elapsed time is

correlated to the capacitance of the more than one capacitor in parallel. As disclosed herein, the capacitance of the more than one capacitor in parallel corresponds to the applied force, pressure, or load. Measuring a large number of measurement cycles while the applied force, pressure, or load is substantially constant supports an accurate correlation between capacitance and the force, pressure, or load.

FIG. **27** illustrates a medical device having a plurality of sensors in accordance with an example embodiment. In general, embodiments of the invention are broadly directed to the measurement of physical parameters. The medical device includes an electro-mechanical system that is configured to measure medical parameters and in the example related to the measurement of the muscular-skeletal system. Many physical parameters of interest within physical systems or bodies are currently not measured due to size, cost, time, or measurement precision. For example, joint implants such as knee, hip, spine, shoulder, and ankle implants would benefit substantially from in-situ measurements taken during surgery to aid the surgeon in the installation and fine-tuning of a prosthetic system. Measurements can supplement the subjective feedback of the surgeon to ensure optimal installation. Permanent sensors in the final prosthetic components can provide periodic data related to the status of the implant in use. Data collected intra-operatively and long term can be used to determine parameter ranges for surgical installation and to improve future prosthetic components.

The physical parameter or parameters of interest can include, but are not limited to, measurement of load, force, pressure, position, displacement, density, viscosity, pH, spurious accelerations, and localized temperature. Often, a measured parameter is used in conjunction with another measured parameter to make a qualitative assessment. In joint reconstruction, portions of the muscular-skeletal system are prepared to receive prosthetic components. Preparation includes bone cuts or bone shaping to mate with one or more prosthesis. Parameters can be evaluated relative to orientation, alignment, direction, displacement, or position as well as movement, rotation, or acceleration along an axis or combination of axes by wireless sensing modules or devices positioned on or within a body, instrument, appliance, vehicle, equipment, or other physical system.

In the present invention parameters are measured with an integrated wireless sensing module or device comprising an i) encapsulating structure that supports sensors and contacting surfaces and ii) an electronic assemblage that integrates a power supply, sensing elements, an accelerometer, antennas, electronic circuitry that controls and processes a measurement sequence, and wireless communication circuitry. The wireless sensing module or device can be positioned on or within, or engaged with, or attached or affixed to or within, a wide range of physical systems including, but not limited to instruments, equipment, devices, appliances, vehicles, equipment, or other physical systems as well as animal and human bodies, for sensing and communicating parameters of interest in real time.

Sensors are disclosed that can indirectly measure the parameter such as a capacitor having a capacitance that varies with the parameter. The capacitance or related factor (e.g. time) is measured and then converted to the parameter. The measurement system has a form factor, power usage, and material that is compatible with human body dynamics. The physical parameter or parameters of interest can include, but are not limited to, measurement of load, force, pressure, displacement, density, viscosity, pH, distance, volume, pain, infection, spurious acceleration, and localized temperature to name a few. These parameters can be evaluated by sensor measurement, alignment, direction, or position as well as movement, rotation, or acceleration along an axis or combination of axes by wireless sensing modules or devices positioned on or within a body, instrument, appliance, vehicle, equipment, or other physical system.

In the example, an insert **2700** illustrates a device having a medical sensor for measuring a parameter of the muscular-skeletal system. Prosthetic insert **2700** is a component of a joint replacement system that allows articulation of the muscular-skeletal system. The prosthetic insert **2700** is a wear component of the joint replacement system. The prosthetic insert **2700** has one or more articular surfaces that allow joint articulation. In a joint replacement, a prosthetic component has a surface that couples to the articular surface of the insert **2700**. The articular surface is low friction and can absorb loading that occurs naturally based on situation or position. The contact area between surfaces of the articulating joint can vary over the range of motion. The articular surface of insert **2700** will wear over time due to friction produced by the prosthetic component surface contacting the articular surface during movement of the joint. Ligaments, muscle, and tendons hold the joint together and motivate the joint throughout the range of motion.

Insert **2700** is an active device having a power source **2702**, electronic circuitry **2704**, load pads **2722**, transmit capability, and sensors within the body of the prosthetic component. Electronic circuitry **2704** includes the circuitry of FIG. **18** and FIG. **19**. In the example, sensors underlie load pads **2722**. The sensors are capacitors formed in an interconnect **2718** that couples to electronic circuitry **2704**. Interconnect **2718** can be flexible and conformal to non-planar shapes. In one embodiment, insert **2700** is used intra-operatively to measure parameters of the muscular-skeletal system to aid in the installation of one or more prosthetic components. As will be disclosed hereinbelow, operation of insert **2700** is shown as a knee insert to illustrate operation and measurement of a parameter such as load and balance. Referring briefly to FIG. **1**, a typical knee joint replacement system comprises an insert, femoral prosthetic component **104**, and tibial prosthetic component **106**. Although housed in the insert, sensor capacitors can also be housed within or coupled to femoral prosthetic component **104** or tibial prosthetic component **106**. Referring back to FIG. **27**, insert **2700** can be adapted for use in other prosthetic joints having articular surfaces such as the hip, spine, shoulder, ankle, and others. Alternatively, insert **2700** can be a permanent active device that can be used to take parameter measurements over the life of the implant. The sensing system is not limited to the prosthetic component example. The system can also be implemented in medical tools, devices, and equipment.

Insert **2700** is substantially equal in dimensions to a passive final prosthetic insert. The substantially equal dimensions correspond to a size and shape that allow insert **2700** to fit substantially equal to the passive final prosthetic insert in a tibial prosthetic component. In the intra-operative example, the measured load and balance using insert **2700** as a trial insert would be substantially equal to the loading and balance seen by a final passive insert under equal conditions. It should be noted that insert **2700** for intra-operative measurement could be dissimilar in shape or have missing features that do not benefit the trial during operation. Insert **2700** should be positionally stable throughout the range of motion equal to that of the final insert.

The exterior structure of insert **2700** comprises two components. In the embodiment shown, insert **2700** comprises a support structure **2706** and a support structure **2708**. Support structures **2706** and **2708** have major support surfaces that are

loaded by the muscular-skeletal system. As previously mentioned, insert **2700** is shown as a knee insert to illustrate general concepts and is not limited to this configuration. Support structure **2706** has an articular surface **2710** and an articular surface **2712**. Condyles of a femoral prosthetic component articulate with surfaces **2710** and **2712**. Loading on the prosthetic knee joint is distributed over a contact area of the articular surfaces **2710** and **2712**. Support structure **2708** has a load-bearing surface **2724**. The load-bearing surface **2724** couples to the tibial prosthetic component. The loading on load-bearing surface **2724** is much lower than that applied to the articular surfaces due to the larger surface area for distributing a force, pressure, or load.

A region **2714** of the support structure **2706** is unloaded or is lightly loaded over the range of motion. Region **2714** is located between the articular surfaces **2710** and **2712**. It should be noted that there is a minimum area of contact on articular surfaces **2710** and **2712** to minimize wear while maintaining joint performance. The contact location and contact area size can vary depending on the position of the muscular-skeletal system. Problems may occur if the contact area falls outside a predetermined area range within articular surfaces **2710** and **2712** over the range of motion. In one embodiment, the location where the load is applied on articular surfaces **2710** and **2712** can be determined by the sensing system. This is beneficial because the surgeon now has quantitative information where the loading is applied. The surgeon can then make adjustments that move the location of the applied load within the predetermined area using real-time feedback from the sensing system to track the result of each correction.

The support structure **2708** can be formed to support the sensors and electronic circuitry **2704** that measure loading on each articular surface of insert **2700**. A load plate **2716** underlies articular surface **2710**. Similarly, a load plate **2720** underlies articular surface **2712**. Interconnect **2718** underlies load plate **2720**. Capacitor sensors underlie load pads **2722** in the vertices of the triangular shaped interconnect **2718** in support structure **2708**. In one embodiment, the capacitor sensors are formed in the interconnect **2718**. Interconnect **2718** couples the sensors to electronic circuitry **2704**. A shield is formed in interconnect **2718** that minimizes parasitic capacitance and coupling to ensure accuracy over the measurement range. Load plate **2720** couples to the capacitor sensors through load pads **2722**. Load plate **2720** distributes the load applied to articular surface **2712** to the capacitor sensors at predetermined locations within insert **2700**. The measurements from the three sensors underlying articular surface **2712** can be used to determine the location of the applied load to insert **2700**. Load plate **2716** operates similarly underlying articular surface **2710**. Although the surface of load plates **2716** and **2720** as illustrated are planar they can be non-planar with the sensors conforming to the non-planar surface. Similarly, the capacitor sensors can formed having a non-planar shape.

A force, pressure, or load applied by the muscular-skeletal system is coupled to the articular surfaces **2710** and **2712** of prosthetic component insert **2700**, which respectively couples to plates **2716** and **2720**. In one embodiment, each capacitor elastically compresses due to the force, pressure, or load. Electronic circuitry **2704** is operatively coupled to the capacitor sensors underlying load plates **2716** and **2720**. A signal is generated that corresponds to the capacitance of the capacitor being measured. The signal is repeated a predetermined number of times or for a predetermined count. The elapsed time of the predetermined count is measured. The elapsed time corresponds to the capacitance of the capacitor. The relationship between capacitance and force, pressure, or load is known and used to determine the measurement value. Furthermore, the measurement data can be processed and transmitted to a receiver external to insert **2700** for display and analysis.

In one embodiment, the physical location of the sensors and electronic circuitry **2704** is housed in insert **2700** thereby protecting the active components from an external environment. Electronic circuitry **2704** can be located between articular surfaces **2710** and **2712** underlying region **2714** of support structure **2700**. A cavity for housing the electronic circuitry **2704** can underlie region **2714**. Support structure **2708** has a surface within the cavity having retaining features extending therefrom to locate and retain electronic circuitry **2704** within the cavity. Region **2714** is an unloaded or a lightly loaded region of insert **2700** thereby reducing the potential of damaging the electronic circuitry **2704** due to a high compressive force during surgery or as the joint is used by the patient. In one embodiment, a temporary power source such as a battery, capacitor, inductor, or other storage medium is located within insert **2700** to power the sensors and electronic circuitry **2704**.

Support structure **2706** attaches to support structure **2708** to form an insert casing or housing. In one embodiment, internal surfaces of support structures **2706** and **2708** mate together. Moreover, the internal surfaces of support structures **2706** and **2708** can have cavities or extrusions to house and retain components of the sensing system. Externally, support structures **2706** and **2708** provide load bearing and articular surfaces that interface to the other prosthetic components of the joint. The load-bearing surface **2724** of support structure **2708** couples to the tibial prosthetic component. Load-bearing surface **2724** can have one or more features or a shape that supports coupling to the tibial prosthetic component.

The support structures **2706** and **2708** can be temporarily or permanently coupled, attached, or fastened together. As shown, insert **2700** can be taken apart to separate support structures **2706** and **2708**. A seal can be located peripherally on an interior surface of support structure **2708**. In one embodiment, the seal can be an O-ring that comprises a compliant and compressible material. The O-ring compresses and forms a seal against the interior surface of support structures **2706** and **2708** when attached together. Support structures **2706** and **2708** form a housing whereby the cavities or recesses within a boundary of the seal are isolated from an external environment. In one embodiment support structures **2706** and **2708** are coupled together when the O-ring is compressed sufficiently to interlock fastening elements. Support structures **2706** and **2708** are held together by the fastening elements under force or pressure provided by the O-ring or other means such as a spring.

In one embodiment, support structure **2700** comprises material commonly used for passive inserts. For example, ultra high molecular weight polyethylene can be used. The material can be molded, formed, or machined to provide the appropriate support and articular surface thickness for a final insert. Alternatively, support structures **2706** and **2708** can be made of metal, plastic, or polymer material of sufficient strength for a trial application. In an intra-operative example, support structures **2706** and **2708** can be formed of polycarbonate. It should be noted that the long-term wear of the articular surfaces is a lesser issue for the short duration of the joint installation. The joint moves similarly to a final insert when moved throughout the range of motion with a polycarbonate articular surface. Support structures **2706** and **2708** can be a formed as a composite where a bearing material such as ultra high molecular weight polyethylene is part of the

composite material that allows the sensing system to be used both intra-operatively and as a final insert.

FIG. **28** illustrates one or more prosthetic components having sensors coupled to and conforming with non-planar surfaces in accordance with an example embodiment. Hip joint prosthetic components are used as an example to illustrate non-planar sensors. The hip joint prosthesis comprises an acetabular cup **2806**, an insert **2808**, and a femoral prosthetic component **2810**. The acetabular cup **2806** couples to a pelvis. Cup **2806** can be cemented to pelvis **2802** thereby fastening the prosthetic component in a permanent spatial orientation for receiving femoral prosthetic component **2810**. Insert **2808** is inserted into acetabular cup **2806** having an exposed articular surface. A femoral head of femoral prosthetic component **2810** can be placed into insert **2808**. Insert **2808** retains the femoral head. The articular surface of insert **2808** couples to the femoral head of femoral prosthetic component **2810** allowing rotation of the joint. The loading is distributed over an area of the articular surface of insert **2808** that varies depending on the leg position. A shaft of femoral prosthetic component **2810** is coupled to a femur **2804**. Cement can be used to fasten the shaft of femoral prosthetic component **2810** to femur **2804**. Tissue such as tendons, ligaments, and muscle couple to pelvis **2802** and femur **2804** to retain and support movement of the hip joint. The sensors and electronic circuitry disclosed herein are not limited to prosthetic hip components and can be applied similarly to other parts of the anatomy including but not limited to the muscular-skeletal system, bone, organs, skull, knee, shoulder, spine, ankle, elbow, hands, and feet.

In one embodiment, femoral prosthetic component **2810** can house electronic circuitry **2812** thereby protecting the active components from an external environment. The electronic circuitry **2812** can include the circuitry disclosed in FIG. **18** and FIG. **19** to measure capacitance of a capacitor sensor. The electronic circuitry **2812** can further include a power source, power management circuitry, conversion circuitry, digital logic, processors, multiple input/output circuitry, and communication circuitry. The electronic circuitry **2812** can be a module having a form factor that can fit within a prosthetic component. Similarly, electronic circuitry **2812** can be integrated into a tool, device, or equipment. Alternatively, electronic circuitry **2812** can be a separate component that couples through a wired or wireless connection to sensors.

The femoral head of the prosthetic component **2810** is spherical in shape. Capacitors **2814** are sensors that conform and couple to the curved surface of the femoral head. In first embodiment, capacitors **2814** can underlie an external surface of the femoral head. A force, pressure, or load applied to the femoral head couples to and can elastically compress capacitors **2814**. Capacitors **2814** and electronic circuitry **2812** are protected from an external environment such that the prosthetic component is suitable for long term monitoring of the joint. In a second embodiment, capacitors **2814** can be exposed on portions of the surface conforming to a spherical shape of the femoral head. In a third embodiment, capacitors **2814** can be formed having the non-planar shape. Capacitors **2814** can be in a trial prosthetic component that is disposed of after a single use. As disclosed herein, capacitors **2814** can be formed in interconnect as disclosed in FIGS. **21-25**. The interconnect can be flexible and can conform to non-planar surfaces. In the example, capacitors **2814** are formed in interconnect that couples to electronic circuitry **2812** to receive and process measurement data. The interconnect and more specifically capacitors **2814** are positioned within and coupled to the spherical femoral head surface whereby force, pressure, or loads can be measured at predetermined locations. Thus, the sensor system can be housed entirely within a prosthetic component. Similarly, the sensors can be placed on, within or between acetabular cup **2806** and insert **2808**. As an example, capacitors **2816** are shown placed between acetabular cup **2806** and insert **2808**. Capacitors **2816** can also underlie or comprise a portion of the articular surface of insert **2808**. Similarly, capacitors **2816** can underlie or comprise a portion of the curved surface of acetabular cup **2806**. Capacitors **2816** can be configured to measure force, pressure, or load applied to different regions of the articular surface of insert **2808**. Electronic circuitry coupled to capacitors **2816** can be in proximity to or housed in acetabular cup **2806**, insert **2808**. Force, pressure, or load measurements on bone can be supported by the system. Capacitors **2822** can be embedded in bone such as pelvis **2802** to measure forces applied thereto.

In the example, capacitors **2814** are located at predetermined locations of the femoral head of femoral prosthetic component **2810**. The capacitance of capacitors **2814** relate to the force, pressure, or load applied to the femoral head by the muscular-skeletal system thereby providing measurement data at the different locations of the femoral head. In one embodiment, measurement data from capacitors **2814** can be wirelessly transmitted to a remote system **2818** in real-time. Remote system **2818** includes a display **2820** configured to display the measurement data. Remote system **2818** can be a computer that further processes the measurement data. The measurement data can be provided in an audible, visual, or haptic format that allows the user to rapidly assess the information. Rotating and moving the leg over the range of motion can provide quantitative data on how the loading varies over the range of motion of the hip joint for the installation. The leg movement couples capacitors **2814** to different areas of the articular surface of insert **2808**. Capacitors **2814** move in an arc when the leg is moved in a constant plane. The measurements data can indicate variations in loading that can require modification to the joint installation. The installation can be done in workflow steps that are supported by remote system **2818**. Moreover, clinical evidence from quantitative measurements over a statistically significant number of patients as target values or ranges for an optimal fit. The surgeon can further fine-tune the installation based on the actual measured quantitative data and subjective feedback from the patient installation.

FIG. **29** illustrates a tool having one or more shielded sensors coupled to a non-planar surface in accordance with an example embodiment. A reamer **2902** is used as an example of a medical device, tool, equipment, or component having one or more sensors. Reamer **2902** can be used in a hip prosthetic joint replacement surgery for removing bone in a pelvis **2908** to accept a prosthetic component such as an acetabular cup. Reamer **2902** has spherical shaped surface **2904** having cutting blades or abrasives for removing bone in an acetabular region **2910** to form a spherical shaped bone region. The cutting head of reamer **2902** is sized to cut acetabular region **2910** region substantial equal in dimensions to the acetabular cup to be fitted therein.

In one embodiment, more than one sensor can be coupled to the cutting head of reamer **2902**. In a non-limiting example, the sensors can be used to measure a force, pressure, or load. More specifically, the sensors can be positioned corresponding to locations on surface **2904** of the cutting head. The sensors are coupled to surface **2904** but are internal to the cutting head of reamer **2902**. The force, pressure, or load is coupled from surface **2904** to the sensors. The sensors provide quantitative data on the force, pressure, or load applied to

the different locations of surface **2904**. The quantitative data can be used as feedback to the material removal process for optimal fit of the acetabular cup. For example, placing too much force in one direction can result in too much material being removed in a location thereby affecting the shape of the bone cut.

Capacitors **2906** are an example of sensors for measuring a force, pressure, or load. Capacitors **2906** are elastically compressible over the measurable range of reamer **2902**. More specifically, the dielectric material comprising capacitors **2906** compresses under an applied force, pressure, or load. The capacitance of a capacitor increases as the dielectric material decreases in thickness due to the force, pressure, or load. Conversely, the dielectric material increases in thickness as the force, pressure, or load applied to the capacitor is reduced thereby decreasing a capacitance value. Capacitors **2906** are coupled to different locations of surface **2904** of the cutting head of reamer **2902**. The capacitors **2906** are distributed across surface **2904** to provide force, pressure, or load magnitudes and differential force, pressure, or load magnitudes for different surface regions during a material removal process. The surface regions being measured by capacitors **2906** will change with the trajectory of reamer **2902**. The measurement data can be used to support a bone reaming process for optimal prosthetic component fit.

In one embodiment, capacitors **2906** are formed within an interconnect as disclosed in FIGS. **21-25**. The interconnect can include one or more dielectric layers or substrates comprising polyimide. The polyimide layers are flexible, can conform to a non-planar surface, or be formed having a predetermined shape. Capacitors **2906** include one or more shields to reduce capacitive coupling to the device. A shield can be coupled to ground and be physically between a conductive region of capacitors **2906** and an external environment of the interconnect. The shield can be a conductive region of the capacitor. In one embodiment, a first shield is formed overlying a conductive region of a capacitor and a second shield is formed underlying the conductive region of the capacitor. The shield minimizes parasitic capacitances that can change a capacitance value of capacitors **2906**.

Interconnect can be formed on the one or more polyimide layers that couples to the conductive regions of capacitors **2906**. The interconnect can couple capacitors **2906** to electronic circuitry (not shown) for generating a signal corresponding to a capacitance of each capacitor. Capacitors **2906** couple to surface **2904** of the cutting head of reamer **2902**. In the example, capacitors **2906** conform to a curved or non-planar surface corresponding to a shape of surface **2904**. In one embodiment, the interconnect and capacitors **2906** are internal to the cutting head thereby isolated from an external environment. The interconnect couples to electronic circuitry for measuring capacitance of capacitors **2906**. The electronic circuitry can be housed in the cutting head or the handle of reamer **2902**. The electronic circuitry can include a power source such as a battery, inductive power source, super capacitor, or other storage medium. As mentioned previously, the capacitance of capacitors **2906** can be related to a force, pressure, or load applied thereto. In the example, the electronic circuitry generates a signal for each capacitor of capacitors **2906** that relates to a capacitance value. The electronic circuitry can include transmit and receive circuitry for sending measurement data from capacitors **2906**. In one embodiment, the measured data is transmitted to a remote system **2818**. Remote system **2818** can include a display **2820** for presenting the measurement data. Data processing can be performed by remote system **2818** to convert the measurement data to a force, pressure, or load. Trajectory data and force, pressure, or load measurements can be provided in a visual format that allows rapid assessment of the information. Audible feedback can be provided to supplement display **2820** when the user requires direct viewing of an operational area. Remote system **2818** can analyze the quantitative measurement data and transmit information to reamer **2902** that provides haptic or other types of feedback to the device that affects trajectory or force, pressure, or load as directed by the user. Quantitative data provided by reamer **2902** is provided in real-time allowing the user to see how the changes affect bone removal on pelvis **2908** on display **2820**.

FIG. **30** discloses a method **3000** for measuring a force, pressure, or load. The method description relates to and can reference FIGS. **1**, **4**, **6**, **8**, **12**, **13**, **19**, **21-25**, and **27-29**. The steps of method **3000** are not limited to the order disclosed. Moreover, method **3000** can also have a greater number of steps or a fewer number of steps than shown. At a step **3002**, a force, pressure, or load is applied to a capacitor. Changes in the force, pressure, or load produce a corresponding change in a capacitance of the capacitor. In one embodiment, the capacitor is formed on or in an interconnect. The dielectric material of the capacitor can be elastically compressible. In a step **3004**, at least one conductive region of the capacitor is shielded to reduce capacitive coupling. In one embodiment, the shield can comprise a conductive region of the capacitor that is a plate of the capacitor. Alternatively, the shield can be a separate structure. The shield can be grounded to minimize parasitic capacitance or coupling to the capacitor. The shield can be between an external environment of the capacitor and the active conductive region or plate of the capacitor being shielded. Furthermore, the shield reduces variable parasitic capacitance that can affect measurement accuracy. The grounded conductive region can be between the active conductive region and the external environment. In a step **3006**, interconnect coupling the capacitor to electronic circuitry is shielded to further reduce capacitive coupling. The shield can be an interconnect of the capacitor. For example, a grounded interconnect can be placed between the interconnect carrying a signal and an external environment to prevent capacitive coupling from circuitry in the external environment. Alternatively, the shield can be a separate structure. Shielding for the capacitor and the interconnect supports the measurement of very small capacitive values. The change in measured capacitance can be small in comparison to the total capacitance. Shielding prevents the total capacitance from changing thereby allowing a capacitance change of less than 10 picofarads to be measured.

Thus, a system is provided herein for measuring small capacitive values and small changes in capacitance. The system further supports a small form factor, high reliability, measurement accuracy, and low cost. Capacitors for force, pressure, and load measurement can be formed in interconnect used to couple the capacitors to electronic circuitry. The capacitors are operated within a substantially elastically compressible region of the dielectric material. Forming the capacitors in the interconnect reduces system complexity, improves reliability, product consistency, and reduces assembly steps.

A signal is generated corresponding to a capacitance of the capacitor under a force, pressure, or load. The signal is repeated for a predetermined count. Measuring an elapsed time of a large number of measurement cycles can be used to generate an average time period of a measurement cycle when change in the parameter being measured occurs slowly in relation to physiological changes such as occurs in the muscular-skeletal system. The measurement data can be analyzed to achieve accurate, repeatable, high precision and high-reso-

lution measurements. The system disclosed herein enables the setting of the level of precision or resolution of captured data to optimize trade-offs between measurement resolution versus frequency, including the bandwidth of the sensing and data processing operations, thus enabling a sensing module or device to operate at its optimal operating point without compromising resolution of the measurements. This is achieved by the accumulation of multiple cycles of excitation and transit time instead of averaging transit time of multiple individual excitation and transit cycles. The result is accurate, repeatable, high precision and high-resolution measurements of parameters of interest in physical systems.

Measurement using elastically compressible capacitors enables high sensitivity and high signal-to-noise ratio. The time-based measurements are largely insensitive to most sources of error that may influence voltage or current driven sensing methods and devices. The resulting changes in the transit time of operation correspond to frequency, which can be measured rapidly, and with high resolution. This achieves the required measurement accuracy and precision thus capturing changes in the physical parameters of interest and enabling analysis of their dynamic and static behavior.

Furthermore, summing individual capacitive measurements before dividing to estimate the average measurement value data values produces superior results to averaging the same number of samples. The resolution of count data collected from a digital counter is limited by the resolution of the least significant bit in the counter. Capturing a series of counts and averaging them does not produce greater precision than this least significant bit that is the precision of a single count. Averaging does reduce the randomness of the final estimate if there is random variation between individual measurements. Summing the counts of a large number of measurement cycles to obtain a cumulative count then calculating the average over the entire measurement period improves the precision of the measurement by interpolating the component of the measurement that is less than the least significant bit of the counter. The precision gained by this procedure is on the order of the resolution of the least significant bit of the counter divided by the number of measurement cycles summed.

FIG. **31** illustrates a prosthetic component **3100** having a plurality of sensors in accordance with an example embodiment. In general, there is need for short-term intra-operative sensored prosthetic components that support the installation of a prosthetic joint and prosthetic components. Similarly, there is a need for the prosthetic joint to include sensors to monitor the joint long-term. Prosthetic component **3100** can be used as a trial prosthetic component or as a permanent prosthetic component for long-term use in the body. Prosthetic component **3100** is illustrated as a tibial prosthetic component in the example. Prosthetic component **3100** can be adapted for use in hip, knee, shoulder, spine, ankle, elbow, toe, hand, or bone implants. Prosthetic component **3100** comprises a structure **3102**, a structure **3104**, interconnect **3106**, load pads **3108**, and electronic circuitry **3110**.

Prosthetic component **3100** typically comprises a metal such as titanium, titanium alloy, cobalt, cobalt alloy, steel, or a steel alloy. The material is suitable for handling the loading produced by the muscular-skeletal system on the joint. Alternatively, the prosthetic component **3100** can be formed of a polymer material. One such suitable material is PEEK (polyether ether ketone). PEEK is a semi-crystalline thermoplastic that has high tensile strength and is resistant to thermal, aqueous, or biological degradation. PEEK can be molded to form the complex shapes required for a prosthetic component. PEEK is light-weight and can be fastened to bone by gluing. PEEK components can be welded together to form a hermetic seal. PEEK has a further benefit that it is transmissive to signals used for communication or for sensor detection.

Structure **3102** includes at least one support surface. As shown structure **3102** includes a support surface **3112** and a support surface **3114**. The support surfaces **3112** and **3114** receive an insert **3116**. Insert **3116** includes an articular surface **3118** and an articular surface **3120** that support movement of the joint. Articular surfaces **3118** and **3120** respectively overlie support surfaces **3112** and **3114**. A force, pressure, or load applied to articular surfaces **3118** and **3120** apply a corresponding force, pressure, or load to support surfaces **3112** and **3114**. A lightly loaded region resides between support surface **3112** and **3114**. In one embodiment, a housing **3122** is formed in structure **3102** in the lightly load region. Housing **3122** includes a cavity for receiving electronic circuitry **3110** that controls measurement activity of prosthetic component **3100**.

Structure **3104** includes at least one feature that couples to bone. In the example, the proximal end of the tibia is prepared to receive structure **3104**. A stem **3124** can be inserted into the medullary canal of the tibia. The stem **3124** aligns and supports structure **3104** to the tibia. Structure **3104** can be glued to the tibia to securely fasten prosthetic component **3100** in place. Alternatively, structure **3104** comprising PEEK or a metallic structure can include points supporting bone growth. Structure **3104** would include features that anchor bone and provide bone growth hormone. Bone can grow into and around the prosthetic component fusing structure **3104** to the tibia. Utilizing bone growth for fastening can also be used in conjunction with glue or other bonding agent.

In one embodiment, three sensors comprise a sensor array. There is a sensor array for each knee compartment. Each sensor array is used to measure the load and position of load of a knee compartment. An articular surface **3118** of insert **3116** corresponds to a first knee compartment of prosthetic component **3100**. Similarly, an articular surface **3120** of insert **3116** corresponds to a second knee compartment of prosthetic component **3100**. A force, pressure, or load applied to articular surfaces **3118** and **3120** is respectively applied to a support surface **3112** and a support surface **3114** of structure **3102**. The support surfaces **3112** and **3114** transfer the force, pressure, or load to a corresponding sensor array. The load pads **3108** are at predetermined locations corresponding to articular surfaces **3118** and **3120**. Load pads **3108** transfer the force, pressure, or load at the predetermined location to the underlying sensors for measurement. Thus, the force, pressure, or load magnitude and the position of applied force, pressure, or load can be calculated from measurements by the three sensors in the first and second knee compartments. The position of load can be translated back to position on articular surfaces **3118** and **3120**. The sensors overlie a support surface **3126** and a support surface **3128** of structure **3104**. Support surfaces **3126** and **3128** respectively correspond to the first and second knee compartments. In one embodiment support surfaces **3126** and **3128** are rigid under loading.

Sensors for measuring load can be devices such as an ultrasonic waveguide, piezo-resistive sensor, mems sensor, strain gauge, polymer sensor, mechanical sensor, and capacitive sensor. In the example, the form factor of prosthetic component **3100** limits the height of the sensor. In a passive prosthetic component (e.g. having no sensors) the structure is formed as a single device. The thickness of the support surfaces is approximately 2 millimeters. In general, the combined thickness of support surfaces **3112** and **3114** coupled to support surfaces **3126** and **3128** can be maintained at 2 millimeters or less with the sensor therebetween. Thus, the sen-

sor requires a form factor that is substantially less than 2 millimeters thick. In one embodiment, the sensor is an elastically compressible capacitive sensor. The area of the sensor is determined by the load range to be measured and the compressible range where the sensor remains elastic. As disclosed hereinabove a measurement technique can be applied that is sensitive to small changes in capacitance that allows measurement accuracy, precision, and repeatability. In one embodiment, the elastically compressible capacitors are formed in the interconnect **3106**.

Electronic circuitry **3110** can be fitted in the cavity formed by housing **3122** of structure **3102**. In one embodiment, the cavity is formed in an unloaded or lightly loaded area of prosthetic component **3100**. The unloaded or lightly loaded region of housing **3122** is between the support surfaces **3112** and **3114**. Thus, electronic circuitry **3110** is protected from impact forces and loading that occurs under normal operation of the joint. Interconnect **3106** and the sensors therein couple to electronic circuitry **3110**. Interconnect **3106** include interconnect that couples the sensors to electronic circuitry **3110**. Cavities **3130** are formed on a surface of structure **3104**. Cavities **3130** support interconnect **3106** coupling from support surfaces **3126** and **3128** of structure **3104** to electronic circuitry **3110**. Cavities **3130** provide a pathway for interconnect **3106** into housing **3122**.

In general, structure **3102** couples to structure **3104** to form prosthetic component **3100**. In one embodiment, structures **3102** and **3104** are welded together around the periphery to form a hermetic seal. Electronic circuitry **3110**, sensors, and interconnect **3106** are housed within prosthetic component **3100** and hermetically sealed from an external environment. Alternatively, structure **3102** and **3104** can be glued or mechanically fastened together to maintain hermeticity. The structure **3102** and **3104** can further include a seal or O-ring that prevents the ingress or egress of gas, liquids, or solids.

Interconnect **3106** respectively couple to support surface **3126** and surface **3128** of structure **3104**. As mentioned previously, load pads **3108** couple each sensor to a respective location on support surface **3112** and support surface **3114**. In the example, load pads **3108** bound an area in each knee compartment that corresponds to articular surfaces **3118** and **3120** of insert **3116**. The force, pressure, or load applied to articular surface **3118** and **3120** is respectively transferred to surface **3112** and **3114** of structure **3102**. It should be noted that surface **3112** and surface **3114** are compliant and not rigid. Each surface has sufficient compliance that allows the underlying sensors to compress. In one embodiment, surface **3112** and surface **3114** is thinned or made thin to achieve compliance. The combined thickness of surfaces **3112** or **3114** of structure **3102** and surfaces **3126** or **3128** of structure **3104** can be approximately 2 millimeters. Surface **3112** and **3114** of structure **3102** can be less than 1 millimeter thick to be made compliant. Alternatively, support structures **3112** and **3114** can comprise a material that is compliant such as a polymer material.

In the example, the load applied to each sensor can be calculated. The load magnitude corresponds to the combination of the three individual measurements. The position of applied load can be calculated from the load magnitudes measured at the fixed positions of the sensors. Electronic circuitry **3110** includes multiple channels of input/output circuitry, timing circuitry, conversion circuitry, logic circuitry, power management circuitry, transmit and receive circuitry. Electronic circuitry **3110** can further include memory for storing software programs to operate or control a measurement process. In one embodiment, an ASIC is used to combine the analog and digital circuitry in a low power solution. The ASIC reduces the form factor of electronic circuitry **3110** allowing it to fit within the housing **3122** of structure **3102**. Electronic circuitry **3110** can include the circuitry described herein and the disclosures incorporated by reference. Electronic circuitry **3110** includes transmit circuitry and an antenna for transmitting data from the sensors to a remote system. Electronic circuitry **3110** can further include receive circuitry to receive information and programming instructions from the remote system. The remote system can be a portable device with a display for reporting the data. The remote system can transmit the data to a database for further review and analysis.

FIG. **32** illustrates a cross-sectional view of structure **3102** in accordance with an example embodiment. The cross-sectional view is of the lightly loaded area between the first and second knee compartments. The view includes a portion of housing **3122** overlying electronic circuitry **3110**. Housing **3122** protects and isolates electronic circuitry from an external environment.

FIG. **33** illustrates prosthetic component **3100** and insert **3116** in accordance with an example embodiment. Structure **3102** is coupled to structure **3104**. In one embodiment, a hermetic seal **3302** is formed that couples structures **3102** and **3104**. Structures **3102** and **3104** can have position and alignment features that support assembly. The periphery of structures **3102** and **3104** can be in proximity to one another around the entire perimeter. In one embodiment, structures **3102** and **3104** comprise an alloy of steel or titanium. A hermetic seal **3302** is formed by welding structure **3102** to structure **3104**. The weld is circumferential to prosthetic component **3100** sealing the sensors and electronic circuitry from an external environment. Welding joins the metals of structure **3102** to structure **3104** forming a contiguous structure. The sensors and electronic circuitry **3110** are isolated from an external environment completely enclosed within prosthetic component **3100**. The weld is formed whereby little or no pressure is applied to the sensors. Any offset due to coupling structures **3102** and **3104** can be compensated for during device calibration. Prosthetic component **3100** is suitable for use as a long-term implant for providing periodic data on joint status. A similar approach could be performed if the structures were formed of PEEK. Alternatively, other approaches using adhesives, mechanical coupling, and seals can be used to join structures **3102** and **3104** together to form a hermetic seal.

Insert **3116** fits into the tray of prosthetic component. The tray of prosthetic component **3100** can have one or more features for retaining insert **3116**. Insert **3116** typically comprises a polymer material such as ultra-high molecular weight polyethylene. Articular surfaces **3118** and **3120** interface with another prosthetic component (not shown) of the joint. In the example, articular surfaces **3118** and **3120** would interface with the condyle surfaces of a femoral prosthetic component. Muscles, tendons, and ligaments motivate the prosthetic joint whereby articular surfaces **3118** and **3120** allow movement of the components in relation to one another. Insert **3116** can be a passive component or include one or more sensors.

FIG. **34** illustrates electronic circuitry **3110** coupled to interconnect **3106** in accordance with an example embodiment. Electronic circuitry **3110** can include one or more connectors for coupling to interconnect **3106**. In one embodiment, the sensors are elastically compressible capacitive sensors. The capacitors are formed underlying load pads **3108** in interconnect **3106**. Referring briefly to FIGS. **21-25**, the sensor structure is described. Load pads **3108** can comprise a non-conductive material or a conductive material. In the example, load pads **3108** are rigid and non-compressible to

transfer the force, pressure, or load to the underlying capacitor. A non-conductive load pad can comprise a polymer material. In one embodiment, load pads **3108** comprise a conductive metal such as copper or copper alloy that is plated onto the surface of interconnect **3106**. The conductive load pads **3108** electrically couple to the underlying plate of the capacitor.

In one embodiment, the capacitors can be formed on or in a flexible polyimide substrate. The load pads, capacitors, and interconnect can be formed accurately and repeatably using lithographic techniques. The polyimide substrate can be made very thin suitable for fitting within a prosthetic component. The capacitor is operated within a range where it is elastically compressible. Each capacitor underlying load pads **3108** are similar to capacitor **2100** of FIG. **21**. Capacitor **2100** comprises 3 capacitors mechanically in series and 2 capacitors electrically in parallel. The force, pressure, or load is applied across capacitors **2204**, **2206**, and **2208**. In one embodiment, capacitor **2204** is not electrically in the circuit because both plates of capacitor **2204** are coupled in common. Electrically, the sensor capacitor comprises capacitors **2206** and **2208** that are electrically coupled in parallel. In one embodiment, a plate of capacitor **2206** and a plate of capacitor **2208** are coupled to ground. The grounded plates **2112** and **2116** are respectively between an external environment of the interconnect and plates **2108** and **2110**. Similarly, the interconnect from capacitor **2100** to the electronic circuitry has a similar topology. Grounded interconnects **2124** and **2126** are between the external environment and the signal carrying interconnect **2122** that couples to plates **2108** and **2110**. Thus, parasitic coupling is minimized by the shield. Furthermore, any parasitic capacitance is constant and not variable.

The capacitive magnitude and changes in magnitude can be accurately measured using the circuitry and method disclosed in FIGS. **18** and **19**. Referring briefly to FIGS. **33** and **34**, a force, pressure, or load is applied to articular surface **3118** and **3120**. The force, pressure, or load is transferred from articular surfaces **3118** and **3120** respectively to support surfaces **3112** and **3114**. As mentioned previously, support surfaces **3112** and **3114** are compliant such that the force, pressure, or load is transferred through load pads **3108** to the underlying sensors. The sensors are supported by support surfaces **3126** and **3128**, which are rigid and non-compliant. A force, pressure, or load applied to a sensor capacitor compresses the structure. The dielectric layer between the capacitor plate is compressed. The capacitance value of the sensor capacitor is related to the thickness of the dielectric layer. Thus, measuring the capacitance and changes in capacitance can be related to the force, pressure, or load applied thereto.

A repeating signal is applied to the sensor capacitor. In general, the sensor is charged and discharged between predetermined voltage levels within a time period. The time period of a single waveform of the repeating signal is a measurement cycle. The time period of the measurement cycle corresponds to the capacitance of the capacitor. The waveform or signal is repeated a predetermined number of times. A measurement sequence comprises the repeated waveform for the predetermined number of times. An elapsed time of the measurement sequence is measured. The elapsed time is the time required to generate the predetermined number of waveforms. The force, pressure, or load is maintained during the measurement sequence. The measured elapsed time of the sensor capacitor is correlated to the force, pressure, or load measurement. The relationship between capacitance and force, pressure, or load is known. In one embodiment, each capacitive sensor can be measured against known force, pressure, or load values after assembly of the prosthetic component. The measurements can be stored in memory that is part of the electronic circuitry housed in the prosthetic component. Further refinement can be achieved by using calibration techniques or algorithms during final testing of each capacitor that can take into account interpolation between measurements and non-linear compression of the dielectric. The measurement resolution can be increased by this technique if the force, pressure, or load is substantially constant over the increased number of predetermined number waveforms. Moreover, the resolution supports measurement where the capacitance changes are relatively small over the force, pressure, or load measurement range.

FIG. **35** illustrates an assembled prosthetic component **3100** in accordance with an example embodiment. Prosthetic component **3100** comprises structure **3102** coupled to structure **3104**. Prosthetic component **3100** houses electronic circuitry and sensors. A hermetic seal **3302** couples the structure **3102** to structure **3104**. In one embodiment, hermetic seal **3302** is a contiguous weld around the periphery. As mentioned, weld does not load or lightly loads the sensors underlying the support surfaces. In the example, prosthetic component **3100** is a tibial prosthetic component. Structure **3102** includes a tray for receiving an insert having at least one articular surface. The tibial prosthetic component can be a single or dual compartment device. Structure **3104** includes a stem **3124** for coupling to bone. In the example, stem **3124** couples to the tibia.

FIG. **36** illustrates a partial cross-sectional view of prosthetic component **3100** in accordance with an example embodiment. The cross-sectional view is in a region near the periphery where hermetic seal **3302** couples structures **3102** and **3104** together. In the example, a sensor **2100** is included. The sensor **2100** is formed in interconnect **3106**. A load pad **3108** is formed on sensor **2100**. Interconnect **3106** further illustrates shielding of the sensor to minimize signal coupling and parasitic capacitance.

The cross-section illustrates placement of sensor **2100** of prosthetic component **3100** for load sensing. Support surface **3128** of structure **3104** supports sensor **2100**. In the example, support surface **3128** is rigid. Conductive region **2116** is a plate of the capacitor formed in interconnect **3106**. Interconnect **2126** couples conductive region **2116** to the electronic circuitry **3110**. Conductive region **2116** and interconnect **2126** couples to support surface **3128**. In the example, conductive region **2116** and interconnect **2126** are coupled to ground. Conductive region **2116** acts as a shield to prevent signal or parasitic coupling to conductive regions **2110** and **2108** of sensor **2100**. Similarly, interconnect **2126** acts as a shield for interconnect **2124** to prevent signal or parasitic coupling. In one embodiment, support surface **3128** comprises a conductive material such as metal. Thus, structure **3104** is coupled to ground by way of conductive region **2116** and interconnect **2126**. Structure **3104** acts as a shield for preventing signal or parasitic coupling to the capacitive sensors.

Support surface **3114** of structure **3102** is supported by load pad **3108** and sensor **2100**. Load pad **3108** distributes the load to sensor **2100**. Support surface **3114** is compliant to loading placed thereon. In one embodiment, support surface **3114** made thin to allow flexing. In general, support surface **3114** deflects a short distance over the entire load range. Sensor **2100** can elastically compress approximately 20% of the total dielectric thickness. In one embodiment, compression of sensor **2100** is limited to 10% or less of the total dielectric thickness. For example, a capacitor as disclosed herein can compress approximately 0.00254 millimeters over the load range of a typical prosthetic component load sensor.

In one embodiment, a stack three capacitive sensors in series, lamination material, and insulating material would yield a total compression under maximum loading of approximately 0.0076 millimeters. Thus, support surfaces **3112** or **3114** do not flex significantly over the entire load range. Load pad **3108** couples to a known location on support surface **3114**. The known location also relates to a point on the articular surface of the insert. The known location of each of the sensors is used to determine where the load is coupled to the articular surface by comparing the measured load magnitudes. Although a single sensor is shown, the other sensors formed in interconnect **3106** are similarly coupled to structures **3102** and **3104**. Hermetic seal **3302** couples structures **3102** and **3104** together. Hermetic seal **3302** can be a weld that melts and joins the material of structures **3102** and **3104**.

Conductive region **2112** is a plate of the capacitor formed in interconnect **3106**. Interconnect **2124** couples conductive region **2112** to electronic circuitry **3110**. In the example, conductive region **2112** and interconnect **2124** are coupled to ground. Conductive region **2108** and conductive region **2110** are plates of the capacitor formed in the interconnect **3106**. Conductive regions **2108** and **2110** of sensor **2100** are coupled in common by via **2120**. Interconnect **2122** couples the conductive regions **2108** and **2110** to the electronic circuitry. Interconnect **2122** carries a signal from the electronic circuitry to sensor **2100** to measure the capacitor. Conductive region **2112** is separated from conductive region **2108** by dielectric layer **2104**. Similarly, conductive region **2116** is separated from conductive region **2110** by dielectric layer **2106**. Conductive regions **2108** and **2110** are separated by a dielectric layer **2102** but as mentioned previously are coupled in common. In one embodiment, dielectric layers **2102**, **2104**, and **2106** comprise polyimide. Other dielectrics such as silicon dioxide, silicon nitride, mylar, and other polymers can be used. Interconnect **3106** and sensor **2100** can be formed by deposition, plating, and lithographic techniques on the substrate.

The capacitor of sensor **2100** comprises three capacitors mechanically in series. A force, pressure, or load applied to support surface **3114** compresses the three capacitors. A first capacitor comprises conductive region **2112**, dielectric layer **2104**, and conductive region **2108**. A second capacitor comprises conductive region **2108**, dielectric layer **2102**, and conductive region **2110**. A third capacitor comprises conductive region **2108**, dielectric layer **2106**, and conductive region **2116**. Electrically, the capacitor of sensor **2100** comprises the first and third capacitors coupled in parallel. The first and third capacitors have conductive regions **2108** and **2110** coupled in common. Similarly, conductive regions **2112** and **2116** of the first and third capacitors are coupled to ground. Conductive region **2112** and **2116** respectively shield conductive region **2108** and **2110** from coupling and parasitic capacitance external to interconnect **3106**. Similarly, interconnect **2124** and **2126** shield interconnect **2122** from signal coupling and parasitic capacitance external to interconnect **3106**.

Structures **3102** and **3104** can comprise a conductive material. For example, titanium, cobalt, and steel alloys are conductive materials used to manufacture prosthetic component **3100**. Placing interconnect **3106** on support surface **3128** couples conductive region **2116** and interconnect **2126** to structure **3104**. Conductive region **2116** and support surface **3128** are coupled in common to ground. Similarly, load pad **3108** can comprise a conductive material. In one embodiment, a material such as copper or copper alloy can be deposited or plated to the surface of interconnect **3106**. Load pad **3108** is coupled to conductive region **2112** and interconnect **2124**. Support surface **3114** is coupled to conductive region **2112** and interconnect **2124** by load pad **3108**. As mentioned previously, conductive region **2112** and interconnect **2124** are coupled to ground. Thus, structure **3102** and **3104** are coupled to ground. Alternatively, structures **3102** and **3104** can be coupled to ground via an alternate path other than sensor **2100**. In one embodiment, the electronic circuitry and sensor **2100** are housed in prosthetic component **3100**. Structures **3102** and **3104** form a shield that isolates electronic circuitry **3110** and sensor **2100** from parasitic coupling and parasitic capacitance in the external environment. The design further incorporates the internal shields built into the capacitor that prevents or minimizes parasitic coupling and parasitic capacitance external to interconnect **3106**. Although a capacitive sensor is used in the example, the load sensor in prosthetic component **3100** can comprises one of a strain gauge, mems device, piezo-resistive sensor, mechanical sensor, polymer sensor, and ultrasonic sensor.

FIG. **37** illustrates structure **3102** in accordance with an example embodiment. Structure **3102** of prosthetic component **3100** when installed in a joint region of the patient includes at least one region having exposure external to the joint. The view shows housing **3122** of structure **3102** that includes a transmissive region **3702**. In one embodiment, transmissive region **3702** comprises glass, PEEK, plastic, or polymer. Transmissive region **3702** can be bonded to an opening in a wall of housing **3122** that comprises a steel alloy, titanium, cobalt, an alloy, or metal. In one embodiment, housing **3122** houses electronic circuitry. Alternatively, part of or all of structure **3102** can comprise a polymer such as PEEK, which is transmissive to some of the spectrum. In one embodiment, transmissive region **3702** is transmissive to sensor signals and communication signals. For example, signals can be blocked when structure **3102** comprises a conductive material and the conductive material is grounded. Prosthetic component **3100** can act as a shield to the electronic circuitry and sensors housed within the device. Transmissive region **3702** can be transmissive to signals such as acoustic, ultrasonic, radio frequency, infrared, and light. Transmissive region **3702** has exposure to regions around and in proximity to the joint region. In one embodiment, window **3702** can be used to monitor the synovial fluid that resides in and around the joint.

Sensors can also be located at or near transmissive region **3702**. The sensors can be mounted with electronic circuitry **3110**. Electronic circuitry **3110** can comprise one or more pc boards having interconnect and connectors. Integrated circuits, ASIC devices, a power source, communication circuitry, digital logic, converters, power management, and other systems can be coupled together in a small form factor. In one embodiment, an ASIC combines many of the features to minimize form factor and to lower power consumption. Sensors and communication circuitry are located on electronic circuitry **3110** in proximity to transmissive region **3122** allowing transmission and reception of signals. A directional antenna can be placed in proximity to transmissive region **3702** to send and receive information to a remote system.

In general, sensors can be used to monitor the synovial fluid that is in proximity to the joint region. Synovial fluid is a natural lubricant found in a muscular-skeletal joint. Synovial fluid is found in joints such as the elbow, knee, shoulder, hip and others. Synovial fluid comprises mucin, albumin, fat, epthelium, and leukocytes. The lubricant also nourishes the avascular articular cartilage. Synovial fluid cushions joint impact and reduces friction as bone and cartilage contact one another over the range of motion. Synovial fluid can also carry oxygen and other nutrients to cartilage and other areas

of the joint. Similarly, synovial fluid acts as transport to remove waste materials from the joint region. The synovial fluid remains in and around the joint. The synovial fluid can be retained by a synovial membrane that holds the lubricant in place.

There is a strong correlation between the health of a joint and the condition of the synovial fluid. Sensors that measure temperature, pH, color, turbidity, viscosity, glucose, and proteins can be used to analyze synovial fluid. The sensors can be used individually or in concert with one another to determine joint health. Prosthetic component **3100** includes one or more of the sensors for monitoring the joint. In the example, the joint is monitored for infection. Infection in a newly implanted joint is a critical problem. It is often difficult for a patient with a joint implant to determine if he or she has an infection. The surgery itself and joint rehabilitation can mask early signs of an infection. The prosthetic joint is an ideal place for an infection to grow without abatement. There are areas in the prosthetic joint that are isolated but have nutrients that can harbor bacteria and foster growth. Infection can lead to a substantial health risk, anti-biotic treatment, increased rehabilitation, long-term hospitalization, and substantial cost. If the infection is significant there is a scenario that requires the removal of the prosthetic joint. The patient is immobilized until the infection subsides and then a new prosthetic joint is implanted. The patient trauma under such circumstances can be significant. Prosthetic joint **3100** can detect infection local to the joint, notify a doctor or healthcare provider, or take appropriate action in a timely manner.

In one embodiment, temperature can be monitored. A temperature sensor **3704** can be mounted in proximity to transmissive region **3702**. Temperature sensor **3704** is coupled to electronic circuitry **3110** for receiving temperature data. In one embodiment, electronic circuitry **3110** has multiple I/O channels for coupling to sensors. Temperature sensor **3704** monitors the temperature of the joint. In one embodiment, temperature sensor **3704** measures the temperature of the synovial fluid. Measurements of the synovial fluid can occur periodically.

A temperature difference can be detected between a healthy knee and an infected knee. In the example, temperature sensor **3704** is calibrated to a normal temperature of the synovial fluid. The calibrations can occur periodically because the normal temperature will change depending on the patient condition. The absolute temperature and changes in temperature are monitored. A change in temperature from the norm can be an indication of an infection. In the example, temperature sensor can be a MEMS sensor, a thermocouple, thermistor or other temperature measuring device.

In one embodiment, pH can be monitored. A pH sensor **3706** can be mounted in proximity to transmissive region **3702** and coupled to electronic circuitry **3110** for receiving pH data. Similar to temperature, pH sensor **3706** can be initially calibrated to the normal pH and recalibrated periodically. A lower pH than the norm can indicate the presence of an infection. Measurement of absolute pH and differential pH over time can be used to detect an increase in bacteria. In general, a healthy knee has a pH of approximately 7.23. An infected knee has a pH of approximately 7.06. The device can be calibrated for specifics of an individual patient. The pH sensor can be a MEMS pH sensor, an implantable pH microsensor, electro-static pH sensor, or other pH measuring device.

In one embodiment, turbidity and color can be monitored. Turbidity is a measure of the cloudiness or haze due to the suspension of particles within a fluid. For example, synovial fluid becomes turbid as an infection grows. Bacteria, bacterial waste products, and white blood cells are but a few of the particulates that can be suspended in the synovial fluid. The turbidity increases as the infection worsens due to increased bacterial growth. Similarly, the color of the synovial fluid changes as an infection increases. For example, healthy synovial fluid is a relatively clear fluid. The synovial fluid changes color as the joint status changes from healthy to non-inflammatory, non-inflammatory to inflammatory, and inflammatory to septic. A non-inflammatory synovial fluid is a yellowish clear liquid that is indicative of joint related problems such as osteoarthritis. The synovial fluid will be viscous retaining its lubricating and damping properties. An inflammatory synovial fluid is yellowish in color. The inflammatory synovial fluid is hazy and not clear. It will also have lost some of its viscous properties having a watery consistency. The inflammatory synovial fluid can indicate problems such as rheumatoid arthritis or infection. Septic synovial fluid can be dark yellow to red in color. Moreover, septic synovial fluid is opaque. The synovial fluid can contain high counts of bacteria, fungus, white, and red blood cells. Measuring color, turbidity, or a combination of both can be used to determine joint health.

In the example, optical sensors such as a LED **3708** (light emitting diode) and photo-diode array **3710** can be used to measure color and turbidity. In one embodiment, the LED **3708** and photo-diode array **3710** are positioned behind transmissive region **3702**. LED **3708** and photo-diode array **3710** are housed within prosthetic component **3100** and can couple to or be part of electronic circuitry **3110**. As previously mentioned, transmissive region **3702** can be glass that is transmissive to light. LED **3708** can transmit white light directly to a photo-diode. The photo-diode can be part of photo-diode array **3710** or a separate device. The photo-diode can be used for calibration of LED **3708** and for detecting changes in the light or intensity output by the device. LED **3708** also illuminates a sample of synovial fluid. As shown, light emitted by LED **3708** is transmitted through transmissive region **3702** into the synovial fluid in proximity to prosthetic component **3100**. In one embodiment, three photo-diodes respectively having red, green, and blue optical filters detect light transmitted through the synovial fluid. Each photo-diode measures the relative contribution of red, green, and blue. The contribution can be ratiometrically compared with a calibration value corresponding to a measurement by the calibration photo-diode. The calibration value corresponds to the sum of red, green, and blue components of white light. More than one transmissive region can be used to send and receive light. Also, one or more barriers or transmissive regions can be used to direct the light into the synovial fluid and prevent direct light from LED **3708** from radiating onto photo-diode array **3710**.

Equations for the measurement can be as follows:

a) r=red, g=green, b=blue, c=calibration

b) Color=[r, g, b]/(r+g+b)

c) Turbidity=(r+g+b)/3c

The color measured by photo-diode array **3710** can be compared to known infection color data. Similarly, the turbidity measurements by photo-diode array **3710** can be compared against known turbidity color data. Both color and turbidity measurements can be taken by prosthetic component **3100**. Using both measurements in combination can provide data that allows further refinement of the prognosis thereby providing a better assessment and treatment methodology. Furthermore, taking periodic measurements and comparing the color and turbidity measurements can yield a rate of change. The rate of change can be used to determine if the infection is increasing or declining. Comparing measure-

ments over time can be used to determine if the infection treatment is successful. Placing sensors in the prosthetic component has substantial benefits in preventing infection. Statistically most infections occur shortly after the joint implant or within the first few months after surgery. Infection is less likely to occur after the surgical wound has healed and rehabilitation of the joint has taken place. Pain due to the surgery and during rehabilitation can also mask infection symptoms. If an infection occurs, it will start as a local infection in proximity to the joint. A first benefit is that prosthetic component **3100** can identify an infection that is local to the joint before it has spread throughout the body. A second benefit is that treatment of the infection can be local to the joint region. A third benefit is that prosthetic component **3100** can also include an antibiotic that could be released in proximity to the joint. A fourth benefit is that prosthetic component **3100** can be in communication with a remote system and a database. The remote system can be provide notification to the patient to see a doctor. The remote system can also provide data to the doctor for analysis and treatment.

A method of long-term joint monitoring is disclosed using prosthetic component **3100**. The method can be practiced with more or less than the steps shown, and is not limited to the order of steps shown. The method is not limited to the example tibial prosthetic component example but can be used for hip, shoulder, ankle, elbow, spine, hand, foot, and bone. In a first step, electronic circuitry and one or more sensors are housed in a prosthetic component. In a second step, characteristics of synovial fluid are periodically measured in proximity to the prosthetic component. The characteristic can be used to determine the presence of an infection or other problem. Examples of measured characteristics are temperature, pH, color, turbidity, viscosity, glucose levels, and proteins. In a third step, measurements are compared. In one embodiment, measurements compared against one another to determine if a change has occurred. Furthermore, multiple measurements made over time can indicate a trend. In another embodiment, the measured characteristics can be compared against known or predetermined values that relate to infection or other problem being identified.

In a fourth step, a color of the synovial fluid is measured. In a fifth step, the color of the synovial fluid is compared against a known color range. In a sixth step, it can be determined if an infection is present. In one embodiment, the comparison yields a color similar to a known synovial fluid color. For example, clear synovial fluid is normal. A clear yellow synovial fluid can indicate inflammation and other problems. A hazy yellow synovial fluid can indicate the presence of bacteria or other problems. A synovial fluid having a red tint can indicate sepsis and blood in the synovial fluid.

In a seventh step, the relative contributions of red, green, and blue colors are measured. In an eighth step, a contribution of each color is ratiometrically compared to a sum of the relative contributions. A color of the synovial fluid can be determined by assessing the contributions of red, green, and blue colors. In a ninth step, a rate of change in color is determined. The rate of change in color can be used to determine the status of an infection. For example, once an infection is detected the rate of change corresponds to a decrease or increase in the infection. It can also be used to determine the effectiveness of treatment. After treatment the rate of change should indicate a decrease in the infection.

A method of long-term joint monitoring is disclosed using prosthetic component **3100**. The method can be practiced with more or less than the steps shown, and is not limited to the order of steps shown. The method is not limited to the example tibial prosthetic component example but can be used for hip, shoulder, ankle, elbow, spine, hand, foot, and bone. In a first step, electronic circuitry and one or more sensors are housed in a prosthetic component. In a second step, a turbidity of synovial fluid is periodically measured in proximity to the prosthetic component. The turbidity can be used to determine the presence of an infection or other problem. Examples of other measured characteristics are temperature, pH, color, turbidity, viscosity, glucose levels, and proteins. In a third step, the turbidity measurements are compared to known turbidity measurements or a predetermined turbidity range. In one embodiment, comparing the periodic measurements determine if a change has occurred. Furthermore, multiple turbidity measurements taken over time can indicate a trend. In another embodiment, the measured characteristics can be compared against known or predetermined turbidity values that relate to infection or other problem being solved. In a fourth step, it can be determined if an infection is present. Turbidity is a measure of the cloudiness or haziness of a substance. For example, healthy synovial fluid is clear. Conversely, infected synovial fluid is hazy or cloudy due to the presence of bacteria. Moreover, the severity of the infection can be related to the number of particulates in the synovial fluid. The higher the number of particulates the worse the infection can be.

In a fifth step, the turbidity is compared against previous turbidity measurements. In a sixth step, a rate of change in turbidity is determined. In general, if the turbidity increases the infection or problem is worsening because healthy synovial fluid is clear. Alternatively, if treatment has been provided and the turbidity over time is decreasing than the patient health is improving. In a seventh step, data is wirelessly transmitted to a remote system. In one embodiment, the remote system is in proximity to the prosthetic component due to the limited range of transmission. The remote system can include a processor and graphic processor. In an eighth step, light is received through a transmissive region of the prosthetic component. Light is transmitted into the synovial fluid in proximity to the prosthetic component. The light illuminates the synovial fluid that is detected by a photo-diode array. Each diode of the photo-diode array can have a filter for filtering the incoming light through the transmissive region of the prosthetic component.

FIG. **38** illustrates prosthetic component **3100** and a remote system **3802** in accordance with an example embodiment. Remote system **3802** can be equipment, a tool, a computer, a note pad, a cell phone, a smartphone, or medical device. Data transmitted from prosthetic component **3100** is received by remote system **3802**. Similarly, remote system **3802** can transmit information to prosthetic component **3100** that supports operation and sensor measurement. Remote system **3802** can include logic circuitry, microprocessor, microcontroller, or digital signal processor. In the example, remote system **3802** is a laptop computer with a display. Remote system **3802** can include software for analyzing quantitative measurement data from prosthetic component **3100** and displaying the information for assessment. Remote system **3802** includes transmit circuitry, receive circuitry, or both for coupling to electronic circuitry **3110** of prosthetic component **3100**. Similarly, electronic circuitry **3110** includes transmit circuitry, receive circuitry, or both. In the example, electronic circuitry includes an ASIC having transmit and receive circuitry. In one embodiment, transmit and receive circuitry transmits through transmissive region **3702**. Alternatively, other transmissive regions can be added to prosthetic component **3100** for supporting antenna placement. Also, prosthetic component **3100** can be made from a polymer such as PEEK that allows transmission and reception of signals. In one

embodiment, transmission of data to remote system **3802** is short range. The transmission range is typically less than 10 meters. In an installed prosthetic component, the RF transmission is made through tissue. The short transmission distance reduces un-authorized reception of data. In one embodiment, the data transmission is encrypted for security. The data can be decrypted by remote system **3802**.

In the example, housing **3122** includes electronic circuitry **3110** and a window **3702**. Window **3702** can be transmissive to signals such as acoustic, ultrasonic, radio frequency, infrared, and light. Window **3702** can comprise glass that is bonded to the steel, titanium, cobalt, alloy, or metal of the prosthetic component. Alternatively, part of or all of structure **3102** can comprise a plastic or a polymer such as PEEK, which is transmissive to some of the spectrum. Window **3702** is not blocked by other components of the prosthetic joint and has exposure to regions around and in proximity to the joint region. In one embodiment, window **3702** can be used to monitor a region in proximity to the prosthetic joint. Similarly, sensors can be fastened to structure **3102** or **3104** and exposed to the region. Window **3702** can be used to measure one or more parameters that relate to the health of synovial fluid. In the example, optical sensors are used to measure color and turbidity. Electronic circuitry **3110** couples to each of the sensors. In one embodiment, a channel is assigned to each sensor. The channels can be operated serially or in parallel. Logic circuitry in electronic circuitry **3110** controls when measurements are taken. The measurement data can be stored in memory on electronic circuitry **3110** until transmitted. The measurement data can be converted to a digital format. The quantitative parameter measurements can be used individually or in combination to determine a health issue.

A method of long-term joint monitoring is disclosed using prosthetic component **3100**. The method can be practiced with more or less than the steps shown, and is not limited to the order of steps shown. The method is not limited to the example tibial prosthetic component example but can be used for hip, shoulder, ankle, elbow, spine, hand, foot, and bone. In a first step, electronic circuitry and one or more sensors are housed in a prosthetic component. In a second step, synovial fluid in proximity to the prosthetic component is monitored. In a third step, a characteristic of the synovial fluid is measured. Examples of characteristics being measured are temperature, pH, color, turbidity, viscosity, glucose levels, and proteins. In a fourth step, data is sent to a remote system. The data can be wirelessly transmitted from the prosthetic component to the remote system. The remote system can include digital logic, a processor, a digital signal processor, a graphic processor, communication circuitry, or analog circuitry. In one embodiment, the transmission can be less than 10 meters due to power constraints of the signal and the medium in which it travels. For example, the transmission has to be sent through the multiple layers of tissue between the prosthetic component and the external environment.

In a fourth step, the data sent by the prosthetic component can be analyzed. The data can be analyzed by the remote system. The data can also be sent to other equipment, devices, computers, or a database. The data can be combined with other information or data to create a clinical database related to a study of the joint or prosthetic system. In a fifth step, a report is generated. The report is based on quantitative data provided by the sensors in the prosthetic component. In a sixth step, the report is sent to at least one entity. In general, the report uses quantitative data generated by the sensors in the prosthetic component. In the example, the sensor data can be an analysis of the synovial fluid in proximity to the joint. The report can lead to an action being taken. For example, detecting an infection or a condition such as arthritis can lead to treatment. The sensors can be used to monitor progress of the treatment. In a seventh step, temperature of the synovial fluid can be measured. In an eighth step, pH of the synovial fluid can be measured. In a ninth step, the color or turbidity of the synovial fluid can be measured. The report can be as simple as a status update on the sensor data to the patient or a detailed listing of all the parameters measured, trends, and analysis of the data sent to a health care provider such as a doctor, surgeon, or hospital. The entity can be broadly interpreted as anything or anybody that has rights to use the information. The report can be encrypted to maintain privacy of the information. Similarly, the sensor data can also include the load and position of load data. This sensor data can be used to address kinematic issues regarding the joint and how the patient is adapting to the prosthesis.

FIG. **39** is an illustration of electronic circuitry **3110** and structure **3104** in accordance with an example embodiment. Structure **3104** is a component of prosthetic component **3100** disclosed herein. Structure **3104** can includes a cavity **3902** for housing electronic circuitry **3110**. Electronic circuitry **3110** is placed vertically into cavity **3902**. Cavity **3902** extends into stem **3124** of structure **3104**. In general, the electronic circuitry can be housed within structure **3102**, **3104**, or both.

FIG. **40** is an illustration of electronic circuitry **3110** and structure **3104** in accordance with an example embodiment. Structure **3104** can include a cavity **4002** for housing electronic circuitry **3110**. Electronic circuitry **3110** is placed horizontally into cavity **4002**. Cavity **4002** is centered between interconnect **3106** in a lightly loaded region of prosthetic component **3100**. Sensors such as temperature, pH, optical, glucose, and others can be mounted in housing **3122** and coupled to electronic circuitry **3110**. Cavity **4002** underlies housing **3122** and provides room to accommodate sensors for measuring in proximity to prosthetic component **3100**. Interconnect **3106** overlies support surface **3126** and **3128**. Each interconnect **3106** includes a sensor array and corresponds to a compartment of the knee. Sensors underlie load pad **3108** of interconnect **3106** for measuring a force, pressure, or load. Electronic circuitry **3110** can include accelerometers for providing positioning information of the joint.

FIG. **41** depicts an exemplary diagrammatic representation of a machine in the form of a system **4100** within which a set of instructions, when executed, may cause the machine to perform any one or more of the methodologies discussed above. In some embodiments, the machine operates as a standalone device. In some embodiments, the machine may be connected (e.g., using a network) to other machines. In a networked deployment, the machine may operate in the capacity of a server or a client user machine in server-client user network environment, or as a peer machine in a peer-to-peer (or distributed) network environment.

The machine may comprise a server computer, a client user computer, a personal computer (PC), a tablet PC, a laptop computer, a desktop computer, a control system, logic circuitry, a sensor system, an ASIC, an integrated circuit, a network router, switch or bridge, or any machine capable of executing a set of instructions (sequential or otherwise) that specify actions to be taken by that machine. It will be understood that a device of the present disclosure includes broadly any electronic device that provides voice, video or data communication. Further, while a single machine is illustrated, the term "machine" shall also be taken to include any collection of machines that individually or jointly execute a set (or

multiple sets) of instructions to perform any one or more of the methodologies discussed herein.

System **4100** may include a processor **4102** (e.g., a central processing unit (CPU), a graphics processing unit (GPU, or both), a main memory **4104** and a static memory **4106**, which communicate with each other via a bus **4108**. System **4100** may further include a video display unit **4110** (e.g., a liquid crystal display (LCD), a flat panel, a solid state display, or a cathode ray tube (CRT)). System **4100** may include an input device **4112** (e.g., a keyboard), a cursor control device **4114** (e.g., a mouse), a disk drive unit **4116**, a signal generation device **4118** (e.g., a speaker or remote control) and a network interface device **4120**.

The disk drive unit **4116** can be other types of memory such as flash memory and may include a machine-readable medium **4122** on which is stored one or more sets of instructions (e.g., software **4124**) embodying any one or more of the methodologies or functions described herein, including those methods illustrated above. Instructions **4124** may also reside, completely or at least partially, within the main memory **4104**, the static memory **4106**, and/or within the processor **4102** during execution thereof by the system **4100**. Main memory **4104** and the processor **4102** also may constitute machine-readable media.

Dedicated hardware implementations including, but not limited to, application specific integrated circuits, programmable logic arrays and other hardware devices can likewise be constructed to implement the methods described herein. Applications that may include the apparatus and systems of various embodiments broadly include a variety of electronic and computer systems. Some embodiments implement functions in two or more specific interconnected hardware modules or devices with related control and data signals communicated between and through the modules, or as portions of an application-specific integrated circuit. Thus, the example system is applicable to software, firmware, and hardware implementations.

In accordance with various embodiments of the present disclosure, the methods described herein are intended for operation as software programs running on a computer processor. Furthermore, software implementations can include, but not limited to, distributed processing or component/object distributed processing, parallel processing, or virtual machine processing can also be constructed to implement the methods described herein.

The present disclosure contemplates a machine readable medium containing instructions **4124**, or that which receives and executes instructions **4124** from a propagated signal so that a device connected to a network environment **4126** can send or receive voice, video or data, and to communicate over the network **4126** using the instructions **4124**. The instructions **4124** may further be transmitted or received over a network **4126** via the network interface device **4120**.

While the machine-readable medium **4122** is shown in an example embodiment to be a single medium, the term "machine-readable medium" should be taken to include a single medium or multiple media (e.g., a centralized or distributed database, and/or associated caches and servers) that store the one or more sets of instructions. The term "machine-readable medium" shall also be taken to include any medium that is capable of storing, encoding or carrying a set of instructions for execution by the machine and that cause the machine to perform any one or more of the methodologies of the present disclosure.

The term "machine-readable medium" shall accordingly be taken to include, but not be limited to: solid-state memories such as a memory card or other package that houses one or more read-only (non-volatile) memories, random access memories, or other re-writable (volatile) memories; magneto-optical or optical medium such as a disk or tape; and carrier wave signals such as a signal embodying computer instructions in a transmission medium; and/or a digital file attachment to e-mail or other self-contained information archive or set of archives is considered a distribution medium equivalent to a tangible storage medium. Accordingly, the disclosure is considered to include any one or more of a machine-readable medium or a distribution medium, as listed herein and including art-recognized equivalents and successor media, in which the software implementations herein are stored.

Although the present specification describes components and functions implemented in the embodiments with reference to particular standards and protocols, the disclosure is not limited to such standards and protocols. Each of the standards for Internet and other packet switched network transmission (e.g., TCP/IP, UDP/IP, HTML, HTTP) represent examples of the state of the art. Such standards are periodically superseded by faster or more efficient equivalents having essentially the same functions. Accordingly, replacement standards and protocols having the same functions are considered equivalents.

FIG. **42** is an illustration of a communication network **4200** for measurement and reporting in accordance with an exemplary embodiment. Briefly, the communication network **4200** expands broad data connectivity to other devices or services. As illustrated, the measurement and reporting system **4255** can be communicatively coupled to the communications network **4200** and any associated systems or services.

As one example, measurement system **4255** can share its parameters of interest (e.g., angles, load, balance, distance, alignment, displacement, movement, rotation, and acceleration) with remote services or providers, for instance, to analyze or report on surgical status or outcome. This data can be shared for example with a service provider to monitor progress or with plan administrators for surgical monitoring purposes or efficacy studies. The communication network **4200** can further be tied to an Electronic Medical Records (EMR) system to implement health information technology practices. In other embodiments, the communication network **4200** can be communicatively coupled to HIS Hospital Information System, HIT Hospital Information Technology and HIM Hospital Information Management, EHR Electronic Health Record, CPOE Computerized Physician Order Entry, and CDSS Computerized Decision Support Systems. This provides the ability of different information technology systems and software applications to communicate, to exchange data accurately, effectively, and consistently, and to use the exchanged data.

The communications network **4200** can provide wired or wireless connectivity over a Local Area Network (LAN) **4201**, a Wireless Local Area Network (WLAN) **4205**, a Cellular Network **4214**, and/or other radio frequency (RF) system (see FIG. **4**). The LAN **4201** and WLAN **4205** can be communicatively coupled to the Internet **4220**, for example, through a central office. The central office can house common network switching equipment for distributing telecommunication services. Telecommunication services can include traditional POTS (Plain Old Telephone Service) and broadband services such as cable, HDTV, DSL, VoIP (Voice over Internet Protocol), IPTV (Internet Protocol Television), Internet services, and so on.

The communication network **4200** can utilize common computing and communications technologies to support circuit-switched and/or packet-switched communications. Each

of the standards for Internet **4220** and other packet switched network transmission (e.g., TCP/IP, UDP/IP, HTML, HTTP, RTP, MMS, SMS) represent examples of the state of the art. Such standards are periodically superseded by faster or more efficient equivalents having essentially the same functions. Accordingly, replacement standards and protocols having the same functions are considered equivalent.

The cellular network **4214** can support voice and data services over a number of access technologies such as GSM-GPRS, EDGE, CDMA, UMTS, WiMAX, 2G, 3G, WAP, software defined radio (SDR), and other known technologies. The cellular network **4214** can be coupled to base receiver **4210** under a frequency-reuse plan for communicating with mobile devices **4202**.

The base receiver **4210**, in turn, can connect the mobile device **4202** to the Internet **4220** over a packet switched link. The internet **4220** can support application services and service layers for distributing data from the measurement system **4255** to the mobile device **4202**. Mobile device **4202** can also connect to other communication devices through the Internet **4220** using a wireless communication channel.

The mobile device **4202** can also connect to the Internet **4220** over the WLAN **4205**. Wireless Local Access Networks (WLANs) provide wireless access within a local geographical area. WLANs are typically composed of a cluster of Access Points (APs) **4204** also known as base stations. The measurement system **4255** can communicate with other WLAN stations such as laptop **4203** within the base station area. In typical WLAN implementations, the physical layer uses a variety of technologies such as 802.11b or 802.11g WLAN technologies. The physical layer may use infrared, frequency hopping spread spectrum in the 2.4 GHz Band, direct sequence spread spectrum in the 2.4 GHz Band, or other access technologies, for example, in the 5.8 GHz ISM band or higher ISM bands (e.g., 24 GHz, etcetera).

By way of the communication network **4200**, the measurement system **4255** can establish connections with a remote server **4230** on the network and with other mobile devices for exchanging data. The remote server **4230** can have access to a database **4240** that is stored locally or remotely and which can contain application specific data. The remote server **4230** can also host application services directly, or over the internet **4220**.

It should be noted that very little data exists on implanted orthopedic devices. Most of the data is empirically obtained by analyzing orthopedic devices that have been used in a human subject or simulated use. Wear patterns, material issues, and failure mechanisms are studied. Although, information can be garnered through this type of study it does yield substantive data about the initial installation, post-operative use, and long term use from a measurement perspective. Just as each person is different, each device installation is different having variations in initial loading, balance, and alignment. Having measured data and using the data to install an orthopedic device will greatly increase the consistency of the implant procedure thereby reducing rework and maximizing the life of the device. In at least one exemplary embodiment, the measured data can be collected to a database where it can be stored and analyzed. For example, once a relevant sample of the measured data is collected, it can be used to define optimal initial measured settings, geometries, and alignments for maximizing the life and usability of an implanted orthopedic device.

The present invention is applicable to a wide range of medical and nonmedical applications including, but not limited to, frequency compensation; control of, or alarms for, physical systems; or monitoring or measuring physical parameters of interest. The level of accuracy and repeatability attainable in a highly compact sensing module or device may be applicable to many medical applications monitoring or measuring physiological parameters throughout the human body including, not limited to, bone density, movement, viscosity, and pressure of various fluids, localized temperature, etc. with applications in the vascular, lymph, respiratory, digestive system, muscles, bones, and joints, other soft tissue areas, and interstitial fluids.

While the present invention has been described with reference to particular embodiments, those skilled in the art will recognize that many changes may be made thereto without departing from the spirit and scope of the present invention. Each of these embodiments and obvious variations thereof is contemplated as falling within the spirit and scope of the invention.

What is claimed is:

1. An orthopedic system comprising:

a sensor;

electronic circuitry coupled to the sensor where the electronic circuitry includes a transmitter and where the transmitter is configured to transmit measurement data; and

a light source configured to illuminate a region in proximity to the muscular-skeletal system where the electronic circuitry is in a housing and where the housing is coupled to the muscular-skeletal system.

2. The orthopedic system of claim **1** further including a remote system configured to receive and process the measurement data.

3. The orthopedic system of claim **1** where the housing has a transmissive region.

4. The orthopedic system of claim **3** where the transmissive region comprises glass.

5. The orthopedic system of claim **3** where the transmissive region comprises plastic.

6. The orthopedic system of claim **3** where the transmitter is configured to transmit through the transmissive region.

7. The orthopedic system of claim **3** where the sensor is an optical sensor and where the optical sensor is configured to detect through the transmissive region.

8. The orthopedic system of claim **1** where the sensor is an optical sensor and where the optical sensor measures color or turbidity.

9. The orthopedic system of claim **1** where the sensor is a temperature sensor or a pH sensor.

10. An orthopedic system comprising:

a sensor;

electronic circuitry coupled to the sensor where the electronic circuitry includes a transmitter and where the transmitter is configured to transmit measurement data; and

a light emitting diode configured to illuminate a region in proximity to the muscular-skeletal system where the electronic circuitry is in a housing and where the housing is coupled to the muscular-skeletal system.

11. The orthopedic system of claim **10** where the housing has a transmissive region.

12. The orthopedic system of claim **11** where the transmissive region comprises glass.

13. The orthopedic system of claim **11** where the transmissive region comprises plastic.

14. The orthopedic system of claim **11** where the transmitter is configured to transmit through the transmissive region.

15. The orthopedic system of claim **11** where the sensor is an optical sensor and where the optical sensor is configured to detect through the tranmissive region.

16. The orthopedic system of claim 15 further including a pH or temperature sensor.

17. The orthopedic system of claim 15 where the optical sensor is configured to detect color or turbidity.

18. An orthopedic system comprising:

a sensor;

electronic circuitry coupled to the sensor where the electronic circuitry includes a transmitter and where the transmitter is configured to transmit measurement data;

a light source configured to illuminate a region in proximity to the muscular-skeletal system where the electronic circuitry is in a prosthetic component configured to couple to the muscular-skeletal system.

19. The orthopedic system of claim 18 further including a remote system configured to receive and process the measurement data.

20. The orthopedic system of claim 18 where the prosthetic component has a transmissive region and where the sensor is configured to detect through the transmissive region.

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